











ADS1260, ADS1261

SBAS760B - MARCH 2018 - REVISED OCTOBER 2018

ADS126x Precision, 5-Channel and 10-Channel, 40-kSPS, 24-Bit, **Delta-Sigma ADCs With PGA and Monitors**

Features

24-Bit, High-Precision ADCs

 Offset Drift: 1 nV/°C Gain Drift: 0.5 ppm/°C

Noise: 30 nV_{RMS} (20 SPS, Gain = 128)

Linearity: 2 ppm

CMOS PGA Gain: 1 to 128

Wide Input Voltage Range: ±7 mV to ±5 V

Data Rate: 2.5 SPS to 40 kSPS

2.5-V Reference: 2 ppm/°C

Simultaneous 50-Hz and 60-Hz Rejection Mode

Single-Cycle Settling Mode

Signal and Reference Monitors

5-V or ±2.5-V Power Supply

Internal Temperature Sensor

Cyclic Redundancy Check (CRC)

Excitation Current Sources

Sensor Burn-Out Current Sources

Four General-Purpose Input/Outputs (ADS1261)

AC Excitation for Bridge Sensors (ADS1261)

5-mm x 5-mm QFN Package

Applications

- PLC Analog Input Modules
- Weigh Scales and Strain-Gauge Digitizers
- Temperature, Pressure Measurement
- Lab Instrumentation
- **Process Analytics**

3 Description

The ADS1260 and ADS1261 (ADS126x) precision, 40-kSPS, delta-sigma ($\Delta\Sigma$) analog-to-digital converters (ADCs) that include a programmable gain amplifier (PGA). The devices also include a precision voltage reference and internal fault monitors. The sensor-ready ADCs give a high-accuracy, single-chip solution for the most demanding measurements, for example, weigh scales and resistance temperature detectors (RTDs).

The ADCs contain an input signal multiplexer, a lownoise PGA (with gains from 1 to 128), a 24-bit $\Delta\Sigma$ modulator, a precision voltage reference, and a programmable digital filter.

The high-impedance PGA inputs (1 G Ω) decrease measurement error due to sensor loading. The ADS1260 supports three differential or five singleended inputs. The ADS1261 supports five differential or 10 single-ended inputs. The integrated current sources simplify the measurement of RTDs.

The flexible digital filter is programmable for singlesettled conversions. while cvcle supplying simultaneous 50-Hz and 60-Hz line cycle rejection. Signal and reference monitors, a temperature sensor, and CRC data verification make data reliability better.

The ADS126x are pin compatible devices given in a 5-mm × 5-mm QFN package and are specified across the -40°C to +125°C temperature range.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
ADS1260	\/OFN (22)	F 0 mm F 0 mm
ADS1261	VQFN (32)	5.0 mm × 5.0 mm

(1) For all available packages, see the package option addendum at the end of the data sheet.

Block Diagram

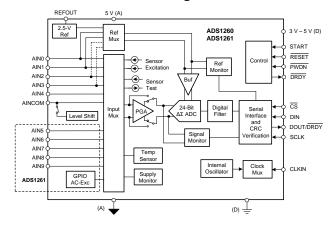




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4 Revision History

C	hanges from Revision A (May 2018) to Revision B	Page
•	Added ADS1261B device to data sheet	1
•	Changed ADS1260 device from preview to production data (active)	1
•	Added connection options to NC pins	5
•	Added differential input current specification for gain = 128 in Electrical Characteristics	8
•	Added no missing codes specification in Electrical Characteristics	8
•	Changed integral nonlinearity specification for gain 64 and 128 in Electrical Characteristics	8
•	Changed integral nonlinearity specification for 40 kSPS mode in <i>Electrical Characteristics</i>	8
•	Added offset voltage long-term drift in Electrical Characteristics	8
•	Added note for PSRR calculation in Electrical Characteristics	8
•	Changed voltage reference inputs specification in <i>Electrical Characteristics</i> based on updated characteristics	9
•	Added voltage reference initial error specification for ADS1260B and ADS1261B in Electrical Characteristics	9
•	Added voltage reference temperature drift specification for ADS1260B and ADS1261B in Electrical Characteristics	9
•	Added voltage reference long-term drift in Electrical Characteristics	9
•	Added voltage reference thermal hysteresis in <i>Electrical Characteristics</i>	9
•	Changed t _{h(SCDO2)} specification in Switching Characteristics	12
•	Changed t _{p(SCDO2)} specification in Switching Characteristics	12
•	Added Figure 14, Offset Voltage Long-Term Drift	15
•	Changed Figure 24, Conversion Data Histogram (gain = 4) to 8192 data points	16
•	Changed Figure 25, Conversion Data Histogram (gain = 128) to 8192 data points	16
•	Changed Figure 27, Integral Nonlinearity vs Temperature based on updated characteristics	17
•	Changed Figure 28, Integral Nonlinearity Distribution to add gain = 128	17
•	Changed Figure 29, Integral Nonlinearity vs Reference Voltage to add gain = 64 and 128	17

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Revision History (continued)

Changed ADS1261 device from advanced information to production data (active)	1
Changes from Original (March 2018) to Revision A	Page
Changed Table 2, Effective Resolution (Noise-Free Resolution) based on updated characterists.	stics24
Added text for Table 2, Effective Resolution (Noise-Free Resolution)	
Added Figure 40, PSRR vs Frequency	19
Added Figure 39, CMRR vs Frequency	19
Changed Figure 32, Reference Input Current vs Reference Voltage based on updated characteristics.	cteristics 17
Added Figure 31, Voltage Reference Long-Term Drift	17
Added Figure 30, Voltage Reference vs Temperature for ADS1260B, ADS1261B	17

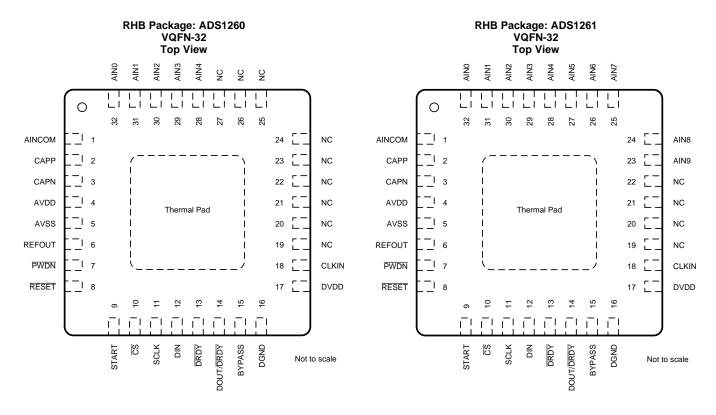


5 Device Comparison Table

PART	CHANNELS ⁽¹⁾		VOLTAGE REFERENCE GRADE	REFERENCE INPUTS	GPIO	
NUMBER SINGLE-ENDED DIFFERENTIAL		VOLTAGE REFERENCE GRADE	REFERENCE INPUTS	AC-EXCITATION		
ADS1260B ⁽²⁾	5	3	12 ppm/°C max	1	_	
ADS1261B	10	5	12 ppm/°C max	2	4	
ADS1261	10	5	40 ppm/°C max	2	4	

- (1) Reference inputs, GPIOs, and ac-excitation outputs are multiplexed with the analog input channels.
- (2) ADS1260 available in B grade only.

6 Pin Configuration and Functions





Pin Functions

	PIN			
NO.	ADS1260	ADS1261	TYPE	DESCRIPTION
1	AINCOM	AINCOM	Analog input/output	Analog input common, IDAC1, IDAC2, VBIAS
2	CAPP	CAPP	Analog output	PGA output P; connect a 4.7-nF C0G dielectric capacitor across CAPP and CAPN
3	CAPN	CAPN	Analog output	PGA output N; connect a 4.7-nF C0G dielectric capacitor across CAPP and CAPN
4	AVDD	AVDD	Analog	Positive analog power supply
5	AVSS	AVSS	Analog	Negative analog power supply
6	REFOUT	REFOUT	Analog output	Internal 2.5-V reference output; connect a 10-µF capacitor to AVSS
7	PWDN	PWDN	Digital input	Power down, active low
8	RESET	RESET	Digital input	Reset, active low
9	START	START	Digital input	Start conversion control, active high
10	CS	CS	Digital input	Serial interface chip select, active low
11	SCLK	SCLK	Digital Input	Serial interface shift clock
12	DIN	DIN	Digital Input	Serial interface data input
13	DRDY	DRDY	Digital output	Data ready indicator, active low
14	DOUT/DRDY	DOUT/DRDY	Digital output	Dual function serial interface data output and active-low data ready indicator
15	BYPASS	BYPASS	Analog output	Internal subregulator bypass; connect a 1-µF capacitor to DGND
16	DGND	DGND	Digital	Digital ground
17	DVDD	DVDD	Digital	Digital power supply
18	CLKIN	CLKIN	Digital input	Internal oscillator: connect to DGND External clock: connect clock input
19- 22	NC	NC	_	No connection. Electrically float or connect to DGND
23	NC	AIN9	Analog input/output	ADS1260: No connection. Electrically float or connect to DGND ADS1261: Analog input 9, IDAC1, IDAC2
24	NC	AIN8	Analog input/output	ADS1260: No connection. Electrically float or connect to DGND ADS1261: Analog input 8, IDAC1, IDAC2
25	NC	AIN7	Analog input/output	ADS1260: No connection. Electrically float or connect to DGND ADS1261: Analog input 7, IDAC1, IDAC2
26	NC	AIN6	Analog input/output	ADS1260: No connection. Electrically float or connect to DGND ADS1261: Analog input 6, IDAC1, IDAC2
27	NC	AIN5	Analog input/output	ADS1260: No connection. Electrically float or connect to DGND ADS1261: Analog input 5, IDAC1, IDAC2, GPIO3, ACX2
28	AIN4	AIN4	Analog input/output	ADS1260: Analog input 4, IDAC1, IDAC2 ADS1261: Analog input 4, IDAC1, IDAC2, GPIO2, ACX1
29	AIN3	AIN3	Analog input/output	ADS1260: Analog input 3, IDAC1, IDAC2 ADS1261: Analog input 3, IDAC1, IDAC2, REFN1, GPIO1, ACX2
30	AIN2	AIN2	Analog input/output	ADS1260: Analog input 2, IDAC1, IDAC2 ADS1261: Analog input 2, IDAC1, IDAC2, REFP1, GPIO0, ACX1
31	AIN1	AIN1	Analog input/output	Analog input 1, IDAC1, IDAC2, REFN0
32	AIN0	AIN0	Analog input/output	Analog input 0, IDAC1, IDAC2, REFP0
	Thermal P	ad ad	_	Exposed thermal pad; Connect to AVSS. Pad must be soldered for mechanical integrity.

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7 Specifications

7.1 Absolute Maximum Ratings⁽¹⁾

		MIN	MAX	UNIT
	AVDD to AVSS	-0.3	7	
Power supply voltage	AVSS to DGND	-3	0.3	V
	DVDD to DGND	-0.3	7	
Analog input voltage	AINx	AVSS - 0.3	AVDD + 0.3	V
Digital input voltage	CS, SCLK, DIN, DOUT/DRDY, DRDY, START, RESET, PWDN, CLKIN	DGND - 0.3	DVDD + 0.3	V
Input Current	Continuous, all pins except power-supply pins (2)	-10	10	mA
Tamparatura	Junction, T _J		150	°C
Temperature	Storage, T _{stg}	-60	150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
V	Floatroototic disabores	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±2000	V
V _(ESD)	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	±500	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

⁽²⁾ Input and output pins are diode-clamped to the internal power supplies. Limit the input current to 10 mA in the event the analog input voltage exceeds AVDD + 0.3 V or AVSS – 0.3 V, or if the digital input voltage exceeds DVDD + 0.3 V or DGND – 0.3 V.



7.3 Recommended Operating Conditions

			MIN	NOM	MAX	UNIT
POWER :	SUPPLY					
	Acatamananan	AVDD to AVSS	4.75	5	5.25	
	Analog power supply	AVSS to DGND	-2.6		0	V
	Digital power supply	DVDD to DGND	2.7		5.25	V
ANALOG	INPUTS				*	
.,		PGA mode	5	See Equation 5		
$V_{(AINx)}$	Absolute input voltage	PGA bypassed	AVSS - 0.1		AVDD + 0.1	V
V _{IN}	Differential input voltage	$V_{IN} = V_{AINp} - V_{AINn}$		±V _{REF} / Gain	See (1)	V
VOLTAG	E REFERENCE INPUTS				,	
V _{REF}	Differential reference voltage	$V_{REF} = V_{(REFPx)} - V_{(REFNx)}$	0.9	А	VDD – AVSS	V
V _(REFNx)	Negative reference voltage		AVSS - 0.05	,	V _(REFPx) – 0.9	V
V _(REFPx)	Positive reference voltage		$V_{(REFNx)} + 0.9$		AVDD + 0.05	V
	AL CLOCK				,	
,	F	2.5 SPS to 25.6 kSPS	1	7.3728	8	N 41 1-
f _{CLK}	Frequency	40 kSPS	1	10.24	10.75	MHz
	Duty cycle		40%		60%	
GENERA	L-PURPOSE INPUTS/OUTPUTS (GPIC	s)	1		•	
	Input voltage		AVSS		AVDD	٧
DIGITAL	INPUTS (other than GPIOs)				,	
	Input voltage		DGND		DVDD	V
TEMPER	ATURE	1	1			
T _A	Operating ambient temperature		-45		125	°C
			1			

⁽¹⁾ In PGA mode, the maximum differential input voltage is \pm (AVDD - AVSS - 0.6 V) / Gain, when operating with $V_{REF} \ge AVDD$ - AVSS - 0.6 V

7.4 Thermal Information

		ADS126x	
	THERMAL METRIC ⁽¹⁾	VQFN (RHB)	UNIT
		32 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	28.6	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	17.0	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	9.7	°C/W
ΨЈТ	Junction-to-top characterization parameter	0.2	°C/W
ΨЈВ	Junction-to-board characterization parameter	9.7	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	0.7	°C/W

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

Product Folder Links: ADS1260 ADS1261



7.5 Electrical Characteristics

Minimum and maximum specifications apply from $T_A = -40^{\circ}\text{C}$ to +125°C. Typical specifications are at $T_A = 25^{\circ}\text{C}$. All specifications are at AVDD = 5 V, AVSS = 0 V, DVDD = 3.3 V, $V_{REF} = 2.5$ V, $f_{CLK} = 7.3728$ MHz, PGA mode, gain = 1, and data rate = 20 SPS (unless otherwise noted).

	PARAMETER	TEST	CONDITIONS	MIN	TYP	MAX	UNIT
ANALOG	3 INPUTS						
		PGA mode, V _{(A}	_{INx)} = 2.5 V		4	6	
	Absolute input current	PGA bypass			200		nA
	Absolute input current drift				0.01		nA/°C
		PGA mode, V _{IN}	= 19 mV		±0.1		
	Differential input current	PGA mode, V _{IN}	PGA mode, V _{IN} = 2.5 V		±1	3	nA
		PGA mode, Cho	op mode ⁽¹⁾		±5		
		PGA bypass, Vi	_N = 2.5 V		±40		
	Differential input current drift				0.05		nA/°C
	Differential input impedance	PGA mode			1		GΩ
	Differential input impedance	PGA bypass			50		ΜΩ
	Crosstalk				0.1		μV/V
PGA				,			
	Gain settings			1, 2, 4	1, 8, 16, 32, 64, 1	128	V/V
	Antialias Filter Frequency	C _{CAPP, CAPN} = 4	.7 nF		60		kHz
PERFOR	RMANCE						
	Resolution	No missing cod	es	24			Bits
DR	Data rate			2.5		40000	SPS
	Noise performance				See Table 1		
	Integral nonlinearity	Gain = 1 to 16		-10	±2	10	ppm _{FSR}
INL		Gain = 32 to 128		-12	±3	12	
		Gain = 1 to 32 (40 kSPS)		-15	±5	15	
				-175 / Gain - 5	±50 / Gain	175 / Gain + 5	
V _{OS}	Offset voltage	T _A = 25°C	Chop mode	-0.5 / Gain - 0.05	±0.2 / Gain	0.5 / Gain + 0.05	μV
		After calibration	After calibration		on the level of noise		
		Gain = 1 to 8			100 / Gain	350 / Gain	
	Offset voltage drift	Gain = 16 to 12	Gain = 16 to 128		10 50		nV/°C
		Chop mode, ga	in = 1 to 128		1	5	
	Offset voltage long-term drift	Gain = 1, 1000	hr		±0.1		μV
CF.	Coin owner	T _A = 25°C, gain	= 1 to 128	-0.5%	±0.05%	0.5%	
GE	Gain error	After calibration		on	the level of noise)	
	Gain drift	Gain = 1 to 128			0.5	4	ppm/°C
NMRR	Normal-mode rejection ratio (2)				See Table 7		
CMDD	Common mode rejection ratio(3)	Data rate = 20 S	SPS		130		٩D
CMRR	Common-mode rejection ratio (3)	Data rate = 400	Data rate = 400 SPS		115		dB
Debb	Dower supply rejection retic(4)	AVDD and AVS	S	85	100		чD
PSRR	Power-supply rejection ratio ⁽⁴⁾	DVDD 100 120		dB			
INTERN	AL OSCILLATOR						
	F	2.5 SPS to 25.6	kSPS		7.3728		N41.1-
f _{CLK}	Frequency	40 kSPS			10.24		MHz
	Accuracy			-2%	±0.5%	2%	

¹⁾ Chop-mode input current scales with data rate.

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⁽²⁾ Normal-mode rejection ratio performance depends on the digital filter configuration.

⁽³⁾ Common-mode rejection ratio is specified at 60 Hz.

⁽⁴⁾ Power-supply rejection ratio specified at dc. PSRR (dB) = 20 Log (Δ power supply voltage / Δ offset voltage).



Electrical Characteristics (continued)

Minimum and maximum specifications apply from $T_A = -40^{\circ}\text{C}$ to +125°C. Typical specifications are at $T_A = 25^{\circ}\text{C}$. All specifications are at AVDD = 5 V, AVSS = 0 V, DVDD = 3.3 V, $V_{REF} = 2.5$ V, $f_{CLK} = 7.3728$ MHz, PGA mode, gain = 1, and data rate = 20 SPS (unless otherwise noted).

TEST CONDITIONS	MIN	TYP	MAX	UNIT
		±250		nA
		15		nA/V
		0.2		nA/°C
Differential		30		МΩ
		2.5		V
T _A = 25°C ADS1260B, ADS1261B		±0.1%	±0.2%	
T _A = 25°C ADS1261		±0.2%		
T _A = 0°C to +85°C ADS1260B, ADS1261B		2	9	
T _A = -40°C to +125°C ADS1260B, ADS1261B		4	12	ppm/°C
$T_A = -40$ °C to +125°C ADS1261		10	40	
1000 hr		±25		ppm
First temperature cycle		±70		nnm
Second temperature cycle		±20		ppm
	-10		10	mA
		50		μV/mA
Settling time to ±0.001% of final value		100		ms
			0	μΑ
	AVSS		AVDD – 1.1	V
	-4%	±0.7%	4%	
Same current magnitudes	-1%	±0.1%	1%	
Different current magnitudes		±1%		
Absolute		50		nnm/0C
Match drift, I _{IDAC1} = I _{IDAC2}		5	25	ppm/°C
	(AVDD -	+ AVSS) / 2		V
		100		Ω
Sink and source	0.05	5, 0.2, 1, 10		μA
0.05 μA range	0.025	0.05	0.075	μΑ
T _A = 25°C		122.4		mV
		420		μV/°C
Low High		AVSS + 0.2 AVDD - 0.2		V
	Differential T _A = 25°C ADS1260B, ADS1261B T _A = 25°C ADS1261 T _A = 0°C to +85°C ADS1260B, ADS1261B T _A = -40°C to +125°C ADS1260B, ADS1261B T _A = -40°C to +125°C ADS1261 1000 hr First temperature cycle Second temperature cycle Settling time to ±0.001% of final value Same current magnitudes Different current magnitudes Absolute Match drift, I _{IDAC1} = I _{IDAC2} Sink and source 0.05 μA range	Differential $T_A = 25^{\circ}C$ ADS1260B, ADS1261B $T_A = 25^{\circ}C$ ADS12611 $T_A = 0^{\circ}C \text{ to } +85^{\circ}C$ ADS1260B, ADS1261B $T_A = -40^{\circ}C \text{ to } +125^{\circ}C$ ADS1260B, ADS1261B $T_A = -40^{\circ}C \text{ to } +125^{\circ}C$ ADS12611 1000 hr First temperature cycle Second temperature cycle Second temperature cycle Settling time to $\pm 0.001\%$ of final value 1000 AVSS -4% Same current magnitudes Absolute Match drift, $I_{IDAC1} = I_{IDAC2}$ Sink and source 0.05 μ A range 0.025	### #################################	#250 15

⁽⁵⁾ Soldered to PCB using recommended PCB layout pattern and using reflow profile per JEDEC standard J-STD-020D.1

⁽⁶⁾ Voltage reference hysteresis measured by operating the device at 25°C cycling the device to 0°C and 105°C and returning the device to 25°C.



Electrical Characteristics (continued)

Minimum and maximum specifications apply from $T_A = -40^{\circ}\text{C}$ to +125°C. Typical specifications are at $T_A = 25^{\circ}\text{C}$. All specifications are at AVDD = 5 V, AVSS = 0 V, DVDD = 3.3 V, $V_{REF} = 2.5$ V, $f_{CLK} = 7.3728$ MHz, PGA mode, gain = 1, and data rate = 20 SPS (unless otherwise noted).

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
GENER	AL-PURPOSE INPUTS/OUTPUTS (GPIO	s) ⁽⁷⁾				
V _{OL}	Low-level output voltage	I _{OL} = -1 mA			0.2 · AVDD	V
V _{OH}	High-level output voltage	I _{OH} = 1 mA	0.8 · AVDD			V
V _{IL}	Low-level input voltage				0.3 · AVDD	V
V _{IH}	High-level input voltage		0.7 · AVDD			V
	Input hysteresis			0.5		V
DIGITA	L INPUTS/OUTPUTS (Other than GPIOs)				
.,	Laveland automorphism	I _{OL} = -1 mA			0.2 · DVDD	
V _{OL}	Low-level output voltage	$I_{OL} = -8 \text{ mA}$		0.2 · DVDD		V
V _{OH} High-leve	I limb lavial autoritivaltana	I _{OH} = 1 mA	0.8 · DVDD			V
	High-level output voltage	I _{OH} = 8 mA		0.75 · DVDD		v
V _{IL}	Low-level input voltage				0.3 · DVDD	V
V _{IH}	High-level input voltage		0.7 · DVDD			V
	Input hysteresis			0.1		V
	Input leakage	V _{IH} or V _{IL}	-10		10	μA
POWER	R SUPPLY					
		PGA bypass		2.7	4.5	
I _{AVDD}	Analog augusty august	PGA mode, gain = 1 to 32		3.8	6	mA
I _{AVSS}	Analog supply current	PGA mode, gain = 64 or 128		4.3	6.5	
		Power-down mode		2	8	μA
_		Voltage reference		0.2		A
I _{AVDD} I _{AVSS}	Analog supply current (by function)	40000 SPS mode		0.5		mA
AVSS		Current sources		As programmed		
		20 SPS		0.4	0.65	A
I_{DVDD}	Digital supply current	40000 SPS		0.6	0.85	mA
		Power-down mode ⁽⁸⁾		30	50	μA
n	Dawar discipation	PGA mode		20	32	ma\^/
P_D	Power dissipation	Power-down mode		0.1	0.2	mW

⁽⁷⁾ GPIO voltage with respect to AVSS.

⁽⁸⁾ CLKIN input stopped.



7.6 Timing Requirements

over operating ambient temperature range, DVDD = 2.7 V to 5.25 V, and DOUT/ \overline{DRDY} load: 20 pF || 100 k Ω to DGND (unless otherwise noted)

		MIN	MAX	UNIT
SERIAL IN	TERFACE			
t _{d(CSSC)}	Delay time, first SCLK rising edge after CS falling edge (1)	50		ns
t _{su(DI)}	Setup time, DIN valid before SCLK falling edge	25		ns
t _{h(DI)}	Hold time, DIN valid after SCLK falling edge	25		ns
$t_{c(SC)}$	SCLK period ⁽²⁾	97	10 ⁶	ns
t _{w(SCH),} t _{w(SCL)}	Pulse duration, SCLK high or low	40		ns
t _{d(SCCS)}	Delay time, last SCLK falling edge before CS rising edge	50		ns
w(CSH)	Pulse duration, CS high to reset interface	25		ns
t _{d(SCIR)}	Delay time, SCLK high or low to force interface auto-reset		65540	1/f _{CLK}
RESET				
t _{w(RSTL)}	Pulse duration, RESET low	4		1/f _{CLK}
CONVERSI	ON CONTROL			
t _{w(STH)}	Pulse duration, START high	4		1/f _{CLK}
t _{w(STL)}	Pulse duration, START low	4		1/f _{CLK}
t _{su(DRST)}	Setup time, START low or STOP command after DRDY low to stop next conversion (Continuous mode)		100	1/f _{CLK}
t _{h(DRSP)}	Hold time, START low or STOP command after DRDY low to continue next conversion (Continuous mode)	150		1/f _{CLK}

⁽¹⁾ $\overline{\text{CS}}$ can be tied low.

.

⁽²⁾ Serial interface time-out mode: minimum SCLK frequency = 1 kHz. Otherwise, no minimum SCLK frequency.



7.7 Switching Characteristics

over operating ambient temperature range, DVDD = 2.7 V to 5.25 V, and DOUT/ \overline{DRDY} load: 20 pF || 100 k Ω to DGND (unless otherwise noted)

	PARAMETER	MIN	TYP	MAX	UNIT
SERIAL INTE	RFACE				
t _{w(DRH)}	Pulse duration, DRDY high	16			1/f _{CLK}
t _{p(CSDO)}	Propagation delay time, CS falling edge to DOUT/DRDY driven	0		50	ns
t _{p(SCDO1)}	Propagation delay time, SCLK rising edge to valid DOUT/DRDY			40	ns
t _{h(SCDO1)}	Hold time, SCLK rising edge to invalid data on DOUT/DRDY	0			ns
t _{h(SCDO2)}	Hold time, last SCLK falling edge of operation to invalid data on DOUT/DRDY	15			ns
t _{p(SCDO2)}	Propagation delay time, last SCLK falling edge to valid data ready function on DOUT/DRDY			110	ns
t _{p(CSDOZ)}	Propagation delay time, CS rising edge to DOUT/DRDY high impedance			50	ns
RESET					
t _{p(RSCN)}	Propagation delay time, RESET rising edge or RESET command to start of conversion	512			1/f _{CLK}
t _{p(PRCM)}	Propagation delay time, power-on threshold voltage to ADC communication		2 ¹⁶		1/f _{CLK}
t _{p(CMCN)}	Propagation delay time, ADC communication to conversion start	512			1/f _{CLK}
AC EXCITAT	ION				
t _{d(ACX)}	Delay time, phase-to-phase blanking period		8		1/f _{CLK}
t _{c(ACX)}	ACX period	2			t _{STDR}
CONVERSIO	N CONTROL				
t _{p(STDR)}	Propagation delay time, START high or START command to DRDY high			2	1/f _{CLK}

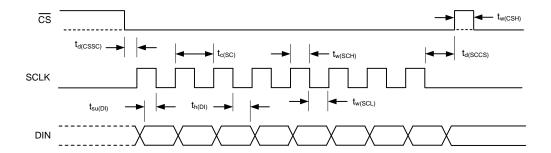
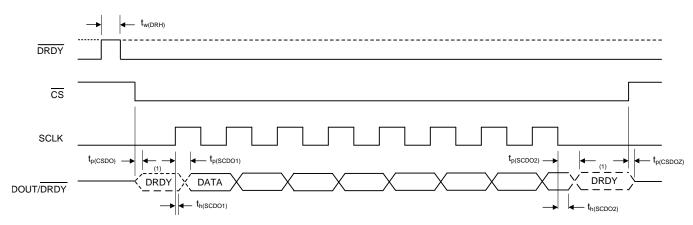


Figure 1. Serial Interface Timing Requirements

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 $^{^{(1)}}$ Before the first SCLK rising edge and after the last SCLK falling edge of a command, the function of DOUT/ \overline{DRDY} is data ready.

Figure 2. Serial Interface Switching Characteristics

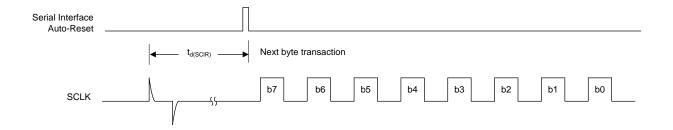


Figure 3. Serial Interface Auto-Reset Characteristics

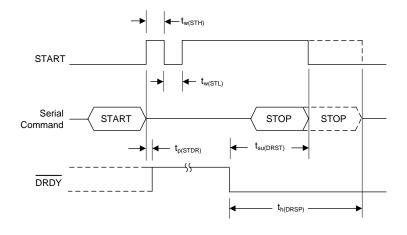


Figure 4. Conversion Control Timing Requirements



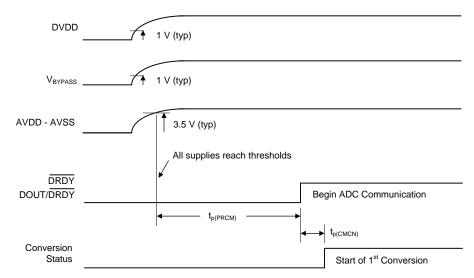


Figure 5. Power-Up Characteristics

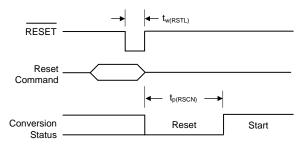


Figure 6. RESET pin and RESET Command Timing Requirements

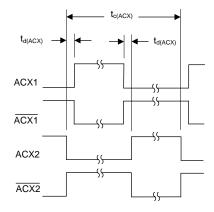


Figure 7. AC-Excitation Timing Characteristics

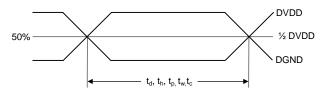
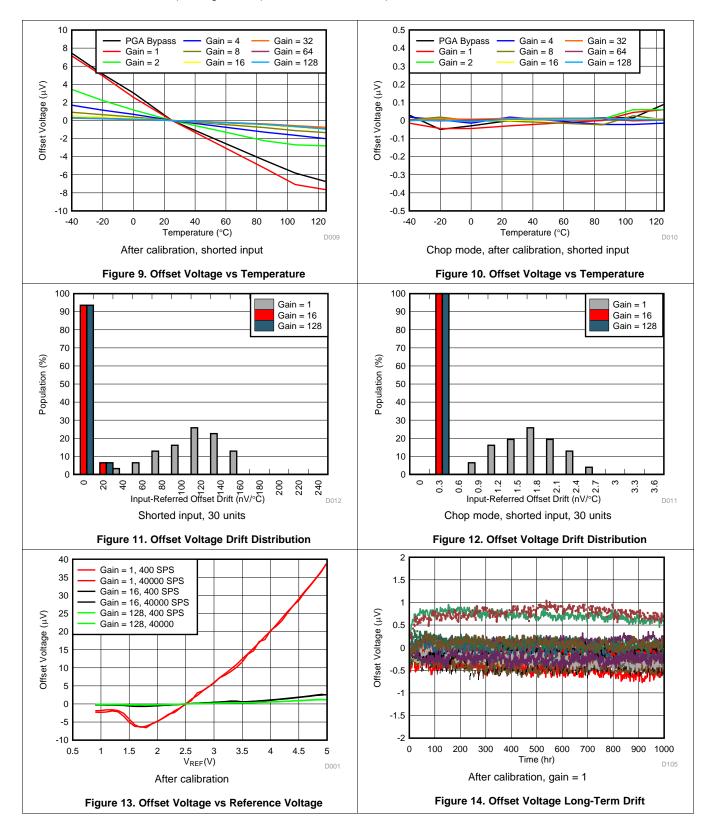


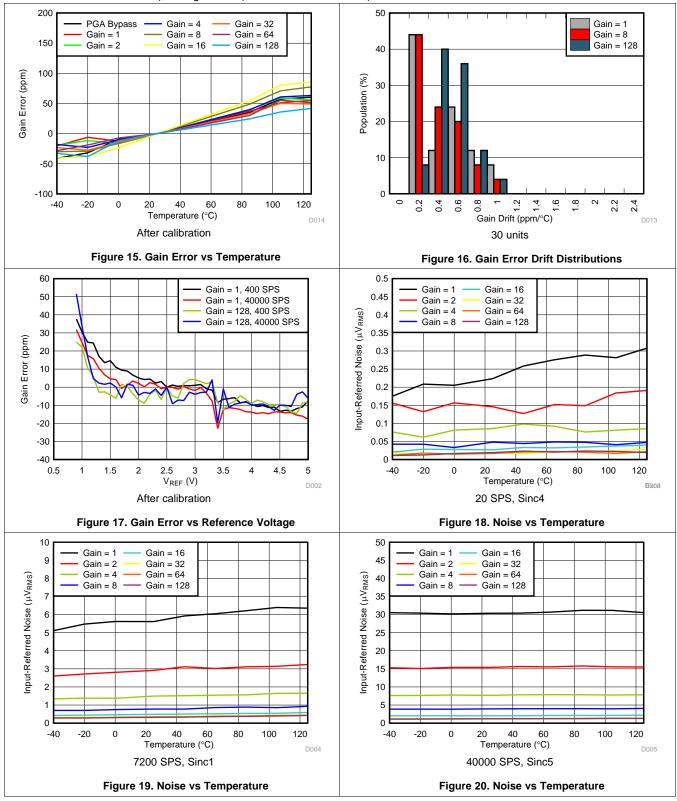
Figure 8. Timing Voltage-Level Reference



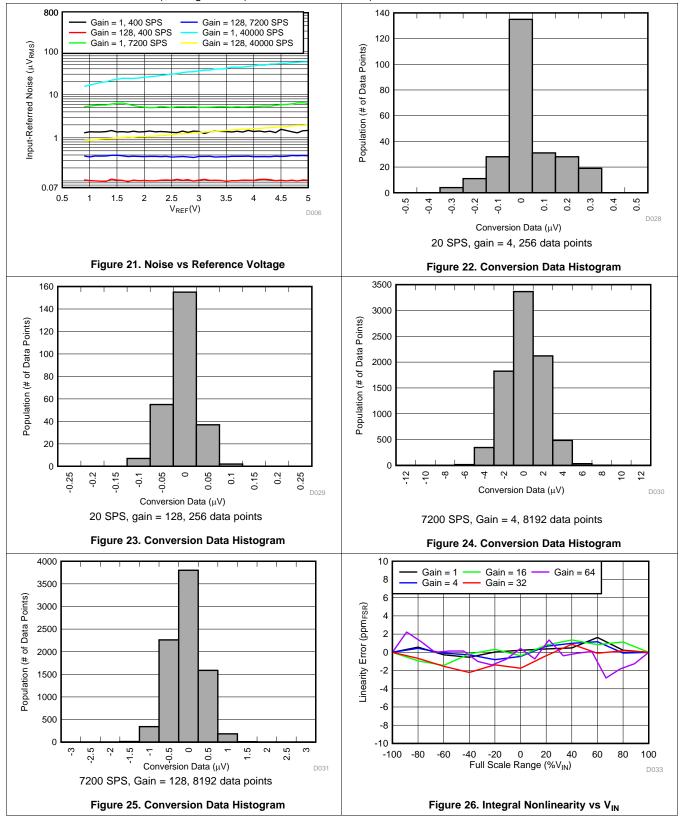
7.8 Typical Characteristics



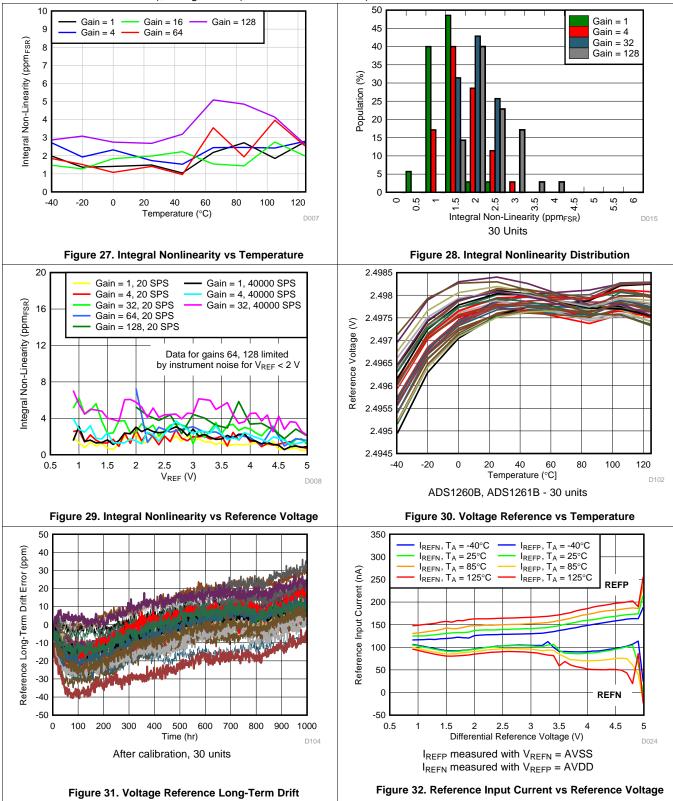






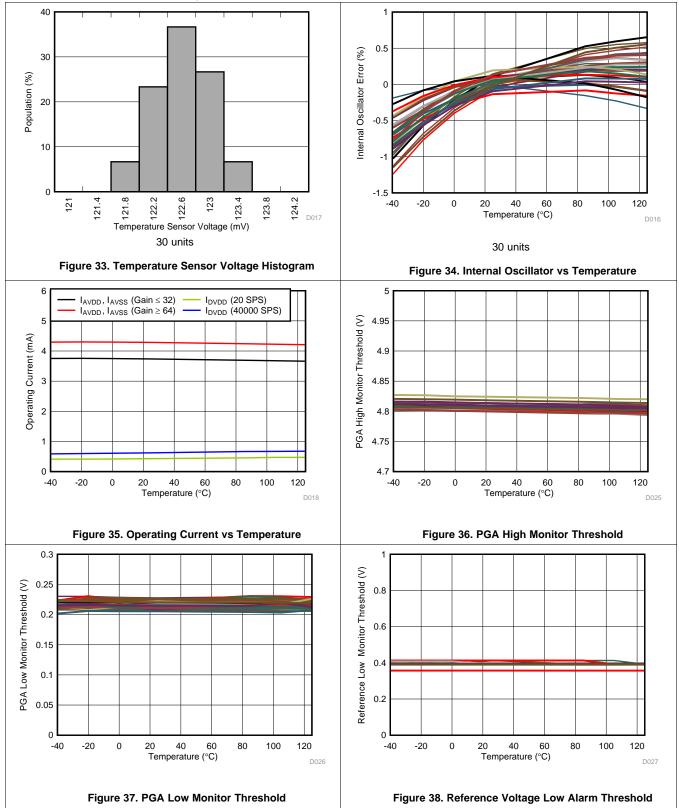




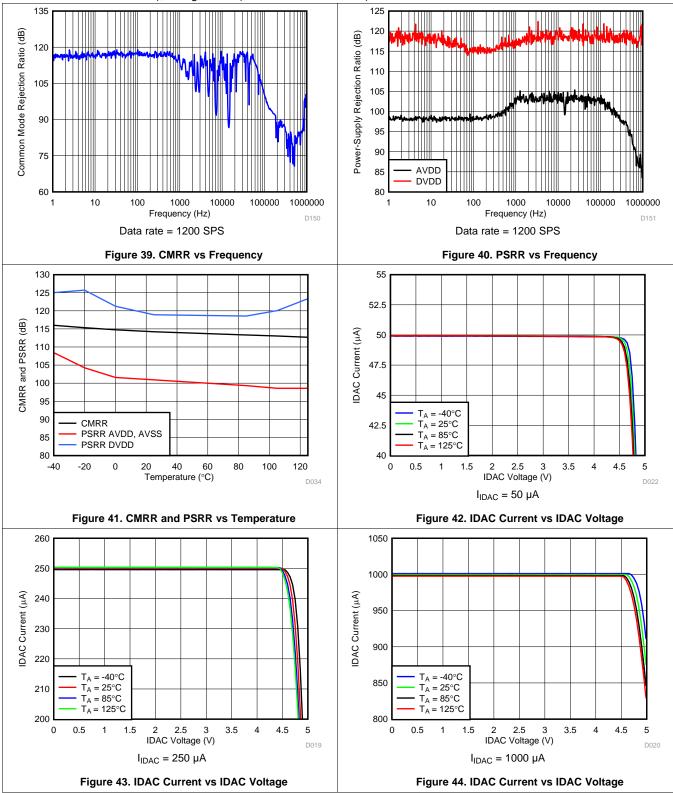




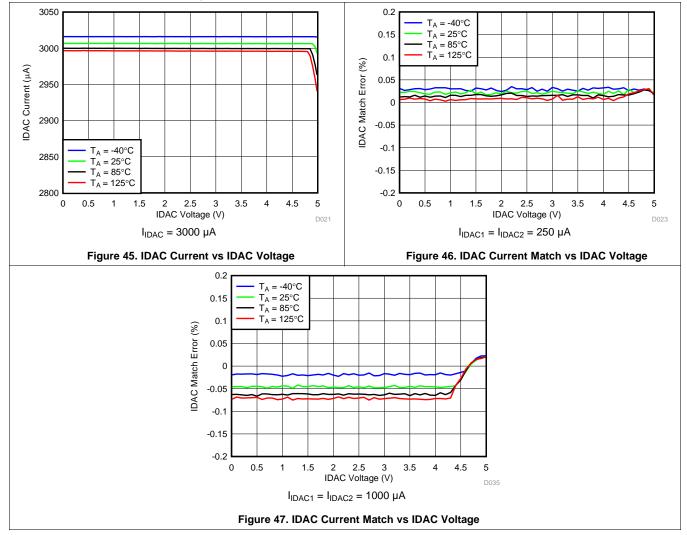
at $T_A = 25$ °C, AVDD = 5 V, AVSS = 0 V, DVDD = 3.3 V, $V_{REF} = 2.5$ V, data rate = 20 SPS, $f_{CLK} = 7.3728$ MHz ($f_{CLK} = 10.24$ MHz for data rate = 40 kSPS), and gain = 1 (unless otherwise noted)













8 Parameter Measurement Information

8.1 Noise Performance

The ADS126x noise performance depends on the ADC configuration: data rate, PGA gain, digital filter configuration, and chop mode. The combination of the parameters affect noise performance. Two significant factors affecting noise performance are data rate and PGA gain. Since the profile of noise is predominantly white (flat vs frequency), decreasing the data rate proportionally decreases bandwidth and therefore, total noise. Since the noise of the PGA is lower than that of the modulator of the ADC, increasing the gain reduces noise when treated as an input-referred quantity. Noise performance also depends on the digital filter and chop mode. As the order of the digital filter increases, the noise bandwidth correspondingly decreases resulting in lower noise. Further, as a result of two-point data averaging in chop mode, noise performance improves by $\sqrt{2}$ compared to normal operation.

Table 1 shows noise performance in units of μV_{RMS} (RMS = root mean square) under the conditions listed. The values in parenthesis are peak-to-peak values. Table 2 shows the noise performance in effective resolution (bits) under the specified conditions. The values shown in parenthesis are the noise-free resolution. Noise-free resolution is the resolution of the ADC with no code flicker. The noise-free resolution data are calculated based on the peak-to-peak noise measurements.

The effective resolution data listed in the tables are calculated using Equation 1:

Effective Resolution or Noise-Free Resolution = In (FSR / e_n) / In (2)

where

- FSR = full scale range = 2 · V_{REF} / Gain (See *Recommended Operating Conditions* for FSR)
- e_n = Input referred voltage noise (RMS value to calculate effective resolution, p-p value to calculate noise-free resolution)

The data shown in the noise performance table represent typical ADC performance at $T_A = 25^{\circ}$ C. The noise-performance data are the standard deviation and peak-to-peak computations of the ADC data. The noise data are acquired with inputs shorted, based on consecutive ADC readings for a period of ten seconds or 8192 data points, whichever occurs first. Because of the statistical nature of noise, repeated noise measurements may yield higher or lower noise performance results.

As a result of the increased full-scale input range provided by 5-V reference operation, effective resolution and noise-free resolution performance are typically optimized using a 5-V reference. The effective resolution and noise-free resolution performance data shown in Table 2 are with external 5-V reference operation.

Table 1. Noise in μV_{RMS} (μV_{PP}) at $T_A = 25^{\circ}C$ and Internal 2.5-V Reference

DATA			GAIN										
RATE (SPS)	FILTER	1	2	4	8	16	32	64	128				
2.5	FIR	0.18 (0.6)	0.078 (0.28)	0.046 (0.16)	0.025 (0.096)	0.014 (0.053)	0.012 (0.045)	0.01 (0.042)	0.01 (0.04)				
2.5	Sinc1	0.15 (0.47)	0.071 (0.28)	0.038 (0.14)	0.019 (0.075)	0.012 (0.051)	0.01 (0.039)	0.009 (0.037)	0.009 (0.037)				
2.5	Sinc2	0.14 (0.38)	0.065 (0.23)	0.032 (0.096)	0.018 (0.059)	0.011 (0.037)	0.007 (0.028)	0.007 (0.028)	0.008 (0.033)				
2.5	Sinc3	0.12 (0.38)	0.062 (0.17)	0.028 (0.064)	0.016 (0.053)	0.01 (0.035)	0.008 (0.027)	0.007 (0.026)	0.006 (0.023)				
2.5	Sinc4	0.1 (0.26)	0.059 (0.17)	0.032 (0.085)	0.016 (0.059)	0.010 (0.035)	0.008 (0.027)	0.006 (0.025)	0.006 (0.024)				
5	FIR	0.22 (0.89)	0.11 (0.4)	0.058 (0.24)	0.032 (0.13)	0.021 (0.085)	0.016 (0.065)	0.014 (0.061)	0.015 (0.066)				
5	Sinc1	0.18 (0.6)	0.093 (0.36)	0.047 (0.17)	0.025 (0.11)	0.017 (0.069)	0.014 (0.061)	0.012 (0.054)	0.014 (0.063)				
5	Sinc2	0.16 (0.64)	0.084 (0.32)	0.043 (0.16)	0.023 (0.085)	0.015 (0.064)	0.011 (0.047)	0.010(0.046)	0.011 (0.049)				
5	Sinc3	0.13 (0.51)	0.088 (0.32)	0.036 (0.15)	0.024 (0.091)	0.014 (0.053)	0.01 (0.043)	0.009 (0.045)	0.009 (0.042)				
5	Sinc4	0.13 (0.51)	0.077 (0.28)	0.034 (0.12)	0.021 (0.075)	0.013 (0.053)	0.010 (0.044)	0.008 (0.038)	0.009 (0.038)				
10	FIR	0.27 (1.4)	0.14 (0.72)	0.076 (0.4)	0.042 (0.21)	0.029 (0.15)	0.023 (0.12)	0.023 (0.11)	0.022 (0.11)				
10	Sinc1	0.23 (1.1)	0.13 (0.57)	0.064 (0.3)	0.036 (0.19)	0.024 (0.13)	0.02 (0.1)	0.018 (0.083)	0.018 (0.089)				
10	Sinc2	0.2 (0.89)	0.11 (0.51)	0.054 (0.24)	0.03 (0.14)	0.019 (0.093)	0.015 (0.075)	0.015 (0.079)	0.016 (0.077)				
10	Sinc3	0.18 (0.81)	0.097 (0.38)	0.05 (0.22)	0.028 (0.14)	0.019 (0.088)	0.015 (0.063)	0.013 (0.067)	0.013 (0.065)				
10	Sinc4	0.17 (0.68)	0.099 (0.45)	0.049 (0.24)	0.024 (0.12)	0.018 (0.085)	0.013 (0.063)	0.012 (0.061)	0.012 (0.062)				
16.6	Sinc1	0.3 (1.4)	0.16 (0.81)	0.082 (0.43)	0.048 (0.25)	0.031 (0.17)	0.025 (0.15)	0.024 (0.12)	0.024 (0.14)				

Product Folder Links: ADS1260 ADS1261



Noise Performance (continued)

Table 1. Noise in μV_{RMS} (μV_{PP}) at T_A = 25°C and Internal 2.5-V Reference (continued)

RATE Since Color Color	DATA			FING	(F-777) A	- 25 C and	SAIN			,
16.6 Sinc2 0.24 (1.2) 0.13 (0.64) 0.067 (0.34) 0.038 (0.2) 0.026 (0.14) 0.021 (0.11) 0.019 (0.099) 0.019 (0.016 (0.15) 0.058 (0.33) 0.026 (0.14) 0.021 (0.11) 0.019 (0.099) 0.017 (0.099) 0.018 (0.056 (0.34) 0.036 (0.18) 0.024 (0.12) 0.019 (0.095) 0.017 (0.099) 0.018 (0.056 (0.055) 0.056 (0.034) 0.035 (0.18) 0.022 (0.11) 0.017 (0.084) 0.016 (0.085) 0.016 (0.050) 0.016 (0.050) 0.018 (0.05		FILTER								400
16.6 Sincal 0.22 (0.98) 0.12 (0.64) 0.066 (0.29) 0.036 (0.18) 0.024 (0.12) 0.019 (0.085) 0.017 (0.092) 0.018 (0.02) 16.6 Sincel 0.21 (1.1) 0.12 (0.53) 0.066 (0.29) 0.038 (0.18) 0.022 (0.11) 0.017 (0.084) 0.016 (0.085) 0.016 (0.085) 20 Fire 0.37 (2.1) 0.14 (0.02) 0.036 (0.18) 0.042 (0.12) 0.034 (0.18) 0.029 (0.11) 0.017 (0.084) 0.026 (0.11) 0.014 (0.02) 0.034 (0.18) 0.029 (0.14) 0.022 (0.13) 0.022 (0.11) 0.025 (0.14) 0.022 (0.13) 0.021 (0.11) 0.028 (0.11) 0.020 (0.11) 0.018 (0.01) 0.020 (0.11) 0.018 (0.01) 0.021 (0.11) 0.018 (0.01) 0.020 (0.11) 0.018 (0.01) 0.021 (0.11) 0.018 (0.01) 0.028 (0.14) 0.022 (0.13) 0.021 (0.11) 0.028 (0.14) 0.022 (0.13) 0.021 (0.11) 0.028 (0.13) 0.031 (0.22) 0.022 (0.13) 0.017 (0.095) 0.017 (0.005) 0.017 (0.005) 0.017 (0.005) 0.017 (0.005) 0.017 (0.005) 0.017 (0.005) 0.017 (0.005) 0.017 (0.005) 0.017 (0.005)<	(SPS)									
16.6 Sinc4 0.21 (1.1) 0.12 (0.53) 0.06 (0.29) 0.035 (0.18) 0.022 (0.11) 0.017 (0.084) 0.016 (0.08) 0.016 (0.08) 0.016 (0.08) 0.016 (0.02) 0.034 (0.12) 0.034 (0.18) 0.025 (0.17) 0.030 (0.27) 0.030 (0.27) 0.030 (0.28) 0.025 (0.14) 0.025 (0.13) 0.025 (0.17) 0.030 (0.28) 0.028 (0.14) 0.025 (0.14) 0.022 (0.13) 0.021 (0.11) 0.020 (0.11) 0.020 (0.11) 0.025 (0.14) 0.022 (0.13) 0.021 (0.11) 0.022 (0.11) 0.022 (0.11) 0.024 (0.12) 0.024 (0.12) 0.024 (0.14) 0.022 (0.13) 0.021 (0.11) 0.018 (0.09) 0.018 (0.01) 0.024 (0.12) 0.024 (0.12) 0.018 (0.098) 0.018 (0.01) 0.024 (0.12) 0.024 (0.12) 0.018 (0.03) 0.034 (0.25) 0.038 (0.13) 0.040 (0.02) 0.034 (0.25) 0.038 (0.21) 0.038 (0.21) 0.034 (0.22) 0.038 (0.23) 0.034 (0.22) 0.038 (0.23) 0.034 (0.22) 0.038 (0.23) 0.038 (0.23) 0.034 (0.22) 0.038 (0.23) 0.038 (0.23) 0.038 (0.23) 0.038 (0.23) 0.038 (0.23) 0.038 (0.23) 0.038 (0.23)					0.067 (0.34)			1	0.019 (0.099)	0.019 (0.098)
20 FiR 0.37 (2) 0.2 (1.1) 0.1 (0.56) 0.059 (0.34) 0.041 (0.22) 0.034 (0.18) 0.029 (0.17) 0.03 (0.15) 20 Sinct 0.32 (1.8) 0.18 (0.92) 0.091 (0.48) 0.051 (0.26) 0.034 (0.22) 0.028 (0.14) 0.022 (0.14) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.022 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.14)<		Sinc3	` '	0.12 (0.64)	0.065 (0.3)	` ′	` ′	0.019 (0.095)	0.017 (0.092)	0.018 (0.093)
20 Sinct 0.32 (1.8) 0.18 (0.92) 0.091 (0.48) 0.051 (0.26) 0.034 (0.2) 0.028 (0.15) 0.025 (0.14) 0.025 (0.14) 20 Sinc2 0.27 (1.4) 0.15 (0.77) 0.073 (0.35) 0.042 (0.22) 0.027 (0.14) 0.022 (0.13) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.021 (0.11) 0.018 (0.099) 0.018 (0.099) 0.018 (0.099) 0.018 (0.099) 0.018 (0.099) 0.018 (0.099) 0.018 (0.099) 0.018 (0.01) 0.018 (0.01) 0.018 (0.01) 0.014 (0.02) 0.014 (0.22) 0.013 (0.108 0.017 (0.098) 0.018 (0.01) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.18) 0.030 (0.21) 0.030 (0.21) 0.030 (0.21) 0.030 (0.21) <	16.6	Sinc4	0.21 (1.1)		0.06 (0.29)	0.035 (0.18)	0.022 (0.11)	0.017 (0.084)	0.016 (0.085)	0.016 (0.086)
20 Sine2 0.27 (1.4) 0.15 (0.77) 0.073 (0.35) 0.042 (0.22) 0.027 (0.14) 0.022 (0.13) 0.021 (0.11) 0.028 (0.11) 20 Sincd 0.24 (1.2) 0.13 (0.64) 0.069 (0.35) 0.039 (0.21) 0.026 (0.14) 0.02 (0.11) 0.018 (0.09) 0.017 (0.095) 50 Sinct 0.49 (2.9) 0.27 (1.6) 0.14 (0.83) 0.08 (0.5) 0.038 (0.31) 0.043 (0.25) 0.039 (0.23) 0.038 (0.25) 50 Sincd 0.42 (2.3) 0.22 (1.3) 0.11 (0.68) 0.064 (0.38) 0.043 (0.27) 0.038 (0.22) 0.033 (0.23) 0.033 (0.23) 0.033 (0.23) 0.033 (0.23) 0.033 (0.23) 0.033 (0.23) 0.039 (0.23) 0.038 (0.23) 0.038 (0.23) 0.029 (0.18) 0.033 (0.24) 0.033 (0.24) 0.033 (0.24) 0.034 (0.23) 0.034 (0.23) 0.034 (0.23) 0.033 (0.24) 0.034 (0.23) 0.034 (0.23) 0.034 (0.23) 0.034 (0.24) 0.044 (0.25) 0.033 (0.17) 0.028 (0.14) 0.044 (0.25) 0.036 (0.23) 0.034 (0.24) 0.044 (0.25) 0.036 (0.23) 0.034 (0.24) 0.044 (0.25)	20	FIR	` '	0.2 (1.1)	0.1 (0.56)	, ,	, ,	0.034 (0.18)	0.029 (0.17)	0.03 (0.15)
20 Sinc3 0.24 (1.2) 0.13 (0.64) 0.069 (0.35) 0.039 (0.21) 0.026 (0.14) 0.02 (0.11) 0.018 (0.099) 0.017 (0.095) 0.033 (0.12) 0.038 (0.22) 0.038 (0.22) 0.038 (0.22) 0.038 (0.23) 0.038 (0.21) 0.028 (0.11) 0.028 (0.11) 0.015 (0.15) 0.044 (0.25) 0.033 (0.17) 0.028 (0.17) 0.028 (0.11) 0.028 (0.11) 0.056 (0.32) 0.036 (0.23) 0.033 (0.17) 0.028 (0.11) 0.028 (0.11) 0.056 (0.32) 0.036 (0.23) 0.033 (0.17) 0.028 (0.11) 0.028 (0.11) 0.056 (0.32) 0.036 (0.23) 0.034 (0.21) 0.028 (0.11) 0.028 (0.11) 0.056 (0.32) 0.036 (0.23) 0.034	20	Sinc1	0.32 (1.8)	0.18 (0.92)	0.091 (0.48)	0.051 (0.26)	0.034 (0.2)	0.028 (0.15)	0.025 (0.14)	0.025 (0.14)
20 Sinc4 0.23 (1.1) 0.13 (0.66) 0.066 (0.33) 0.037 (0.19) 0.024 (0.12) 0.018 (0.095) 0.017 (0.095) 0.017 (0.055) 50 Sinc1 0.49 (2.9) 0.27 (1.6) 0.14 (0.83) 0.08 (0.5) 0.053 (0.31) 0.043 (0.25) 0.039 (0.23) 0.038 (0.2 50 Sinc3 0.37 (2.2) 0.21 (1.2) 0.11 (0.64) 0.058 (0.35) 0.04 (0.25) 0.033 (0.19) 0.029 (0.18) 0.03 (0.18) 50 Sinc4 0.34 (2.2) 0.19 (1.1) 0.098 (0.61) 0.056 (0.32) 0.036 (0.23) 0.03 (0.17) 0.028 (0.17) 0.028 (0.16) 60 Sinc4 0.55 (3.3) 0.28 (1.1) 0.15 (0.88) 0.087 (0.53) 0.058 (0.34) 0.047 (0.28) 0.044 (0.29) 0.032 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.030 (0.17) 0.028 (0.17) 0.028 (0.18) 0.034 (0.29) 0.034 (0.12) 0.034 (0.12) 0.034 (0.12) 0.034 (0.12) 0.034 (0.12) 0.034 (0.12) 0.034 (0.12) 0.034 (0.12) 0.034 (0.12)	20	Sinc2	0.27 (1.4)	0.15 (0.77)	0.073 (0.35)	0.042 (0.22)	0.027 (0.14)	0.022 (0.13)	0.021 (0.11)	0.02 (0.11)
50 Sinct 0.49 (2.9) 0.27 (1.6) 0.14 (0.83) 0.08 (0.5) 0.053 (0.31) 0.043 (0.25) 0.039 (0.23) 0.038 (0.2 50 Sinc2 0.4 (2.3) 0.22 (1.3) 0.11 (0.69) 0.064 (0.38) 0.043 (0.27) 0.035 (0.22) 0.033 (0.2) 0.032 (0.2 50 Sinc4 0.34 (2) 0.19 (1.1) 0.098 (0.61) 0.056 (0.32) 0.033 (0.1) 0.029 (0.18) 0.030 (0.18) 60 Sinc1 0.55 (3.3) 0.28 (1.1) 0.15 (0.88) 0.087 (0.53) 0.058 (0.34) 0.047 (0.28) 0.044 (0.29) 0.042 (0.2 60 Sinc2 0.45 (2.7) 0.24 (1.4) 0.12 (0.71) 0.07 (0.45) 0.048 (0.22) 0.039 (0.25) 0.044 (0.29) 0.042 (0.2 60 Sinc3 0.41 (2.7) 0.21 (1.3) 0.11 (0.68) 0.065 (0.4) 0.044 (0.25) 0.036 (0.23) 0.032 (0.19) 0.031 (0.1 100 Sinc4 0.56 (6.3) 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.060 (0.39) 0.056 (0.37) 0.056 (0.3	20	Sinc3	0.24 (1.2)	0.13 (0.64)	0.069 (0.35)	0.039 (0.21)	0.026 (0.14)	0.02 (0.11)	0.018 (0.099)	0.018 (0.1)
50 Sinc2 0.4 (2.3) 0.22 (1.3) 0.11 (0.69) 0.064 (0.38) 0.043 (0.27) 0.035 (0.22) 0.033 (0.2) 0.032 (0.25) 50 Sinc3 0.37 (2.2) 0.2 (1.2) 0.11 (0.64) 0.058 (0.35) 0.04 (0.25) 0.033 (0.19) 0.029 (0.18) 0.03 (0.18) 50 Sinc4 0.34 (2) 0.19 (1.1) 0.098 (0.61) 0.056 (0.32) 0.036 (0.23) 0.030 (0.17) 0.028 (0.17) 0.028 (0.16) 50 Sinc4 0.34 (2) 0.19 (1.1) 0.098 (0.61) 0.056 (0.32) 0.036 (0.23) 0.030 (0.17) 0.028 (0.17) 0.035 (0.22) 60 Sinc3 0.41 (2.7) 0.24 (1.4) 0.12 (0.71) 0.07 (0.45) 0.048 (0.32) 0.039 (0.23) 0.036 (0.21) 0.035 (0.24) 60 Sinc4 0.37 (2) 0.21 (1.3) 0.11 (0.68) 0.059 (0.36) 0.041 (0.25) 0.036 (0.23) 0.032 (0.19) 0.031 (0.17) 60 Sinc4 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.086 (0.39) 0.036 (0.31) 0.036 (0.31) 0.03	20	Sinc4	0.23 (1.1)	0.13 (0.66)	0.066 (0.33)	0.037 (0.19)	0.024 (0.12)	0.018 (0.095)	0.017 (0.095)	0.017 (0.099)
50 Sinc3 0.37 (2.2) 0.2 (1.2) 0.11 (0.64) 0.058 (0.35) 0.04 (0.25) 0.033 (0.19) 0.029 (0.18) 0.03 (0.18) 50 Sinc4 0.34 (2) 0.19 (1.1) 0.098 (0.61) 0.056 (0.32) 0.03 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.17) 0.028 (0.21) 0.036 (0.23) 0.036 (0.23) 0.034 (0.25) 0.036 (0.23) 0.034 (0.25) 0.036 (0.23) 0.036 (0.23) 0.036 (0.23) 0.036 (0.23) 0.036 (0.23) 0.036 (0.23) 0.036 (0.21) 0.036 (0.23) 0.036 (0.21) 0.036 (0.21) 0.036 (0.23) 0.031 (0.17) 0.036 (0.23) 0.036 (0.23) 0.031 (0.17) 0.036 (0.23) 0.036 (0.23) 0.031 (0.17) 0.036 (0.23) 0.031 (0.17) 0.036 (0.23) 0.036 (0.23) 0.031 (0.17) 0.036 (0.23) 0.031 (0.18) 0.036 (0.21) 0.036 (0.23) 0.036 (0.23) 0.036 (0.23) 0.036 (0.21)<	50	Sinc1	0.49 (2.9)	0.27 (1.6)	0.14 (0.83)	0.08 (0.5)	0.053 (0.31)	0.043 (0.25)	0.039 (0.23)	0.038 (0.23)
50 Sinc4 0.34 (2) 0.19 (1.1) 0.098 (0.61) 0.056 (0.32) 0.036 (0.23) 0.03 (0.17) 0.028 (0.17) 0.028 (0.17) 60 Sinc1 0.55 (3.3) 0.28 (1.9) 0.15 (0.88) 0.087 (0.53) 0.058 (0.34) 0.047 (0.28) 0.044 (0.29) 0.042 (0.26) 60 Sinc2 0.45 (2.7) 0.24 (1.4) 0.12 (0.71) 0.07 (0.45) 0.048 (0.32) 0.039 (0.25) 0.036 (0.21) 0.035 (0.26) 60 Sinc3 0.41 (2.7) 0.21 (1.1) 0.11 (0.68) 0.065 (0.4) 0.044 (0.25) 0.033 (0.21) 0.033 (0.19) 0.031 (0.17 100 Sinc4 0.37 (2) 0.21 (1.1) 0.11 (0.6) 0.059 (0.36) 0.041 (0.25) 0.033 (0.21) 0.03 (0.18) 0.031 (0.17 100 Sinc1 0.69 (4.5) 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.062 (0.39) 0.056 (0.31) 0.036 (0.31) 0.036 (0.31) 0.046 (0.31) 0.045 (0.22) 100 Sinc2 0.56 (3.5) 0.3 (1.9) 0.14 (0.97) 0.09 (0.55) 0.062	50	Sinc2	0.4 (2.3)	0.22 (1.3)	0.11 (0.69)	0.064 (0.38)	0.043 (0.27)	0.035 (0.22)	0.033 (0.2)	0.032 (0.2)
60 Sinct 0.55 (3.3) 0.28 (1.9) 0.15 (0.88) 0.087 (0.53) 0.058 (0.34) 0.047 (0.28) 0.044 (0.29) 0.042 (0.2 60 Sinc2 0.45 (2.7) 0.24 (1.4) 0.12 (0.71) 0.07 (0.45) 0.048 (0.32) 0.039 (0.25) 0.036 (0.21) 0.035 (0.2 60 Sinc3 0.41 (2.7) 0.21 (1.3) 0.11 (0.68) 0.065 (0.4) 0.044 (0.25) 0.036 (0.23) 0.032 (0.19) 0.031 (0.1 60 Sinc4 0.37 (2) 0.22 (1.1) 0.11 (0.6) 0.059 (0.36) 0.041 (0.25) 0.033 (0.21) 0.03 (0.18) 0.03 (0.17 100 Sinc4 0.37 (2) 0.24 (1.1) 0.11 (0.6) 0.059 (0.36) 0.041 (0.25) 0.033 (0.21) 0.03 (0.18) 0.03 (0.17 100 Sinc4 0.58 (4.5) 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.06 (0.39) 0.056 (0.37) 0.056 (0.31) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.39) 0.051 (0.37) 0.056 (0.39) 0.051 (0.37) 0.056 (0.39) 0.051 (0.39)	50	Sinc3	0.37 (2.2)	0.2 (1.2)	0.11 (0.64)	0.058 (0.35)	0.04 (0.25)	0.033 (0.19)	0.029 (0.18)	0.03 (0.18)
60 Sinc2 0.45 (2.7) 0.24 (1.4) 0.12 (0.71) 0.07 (0.45) 0.048 (0.32) 0.039 (0.25) 0.036 (0.21) 0.035 (0.26) 60 Sinc3 0.41 (2.7) 0.21 (1.3) 0.11 (0.68) 0.065 (0.4) 0.044 (0.25) 0.036 (0.23) 0.032 (0.19) 0.031 (0.17 60 Sinc4 0.37 (2) 0.2 (1.1) 0.11 (0.6) 0.059 (0.36) 0.041 (0.25) 0.033 (0.21) 0.03 (0.18) 0.03 (0.17 100 Sinc1 0.69 (4.5) 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.06 (0.39) 0.056 (0.37) 0.056 (0.30) 100 Sinc2 0.56 (3.5) 0.3 (1.9) 0.16 (0.97) 0.090 (0.55) 0.062 (0.39) 0.051 (0.32) 0.046 (0.31) 0.045 (0.33) 0.046 (0.31) 0.045 (0.33) 0.046 (0.31) 0.045 (0.32) 0.046 (0.31) 0.045 (0.32) 0.046 (0.31) 0.045 (0.32) 0.046 (0.37) 0.056 (0.36) 0.045 (0.33) 0.041 (0.22) 0.041 (0.22) 0.041 (0.22) 0.041 (0.22) 0.041 (0.22) 0.041 (0.22) 0.046 (0.33) 0.046 (0.37)	50	Sinc4	0.34 (2)	0.19 (1.1)	0.098 (0.61)	0.056 (0.32)	0.036 (0.23)	0.03 (0.17)	0.028 (0.17)	0.028 (0.17)
60 Sinc3 0.41 (2.7) 0.21 (1.3) 0.11 (0.68) 0.065 (0.4) 0.044 (0.25) 0.036 (0.23) 0.032 (0.19) 0.031 (0.1 60 Sinc4 0.37 (2) 0.2 (1.1) 0.11 (0.6) 0.059 (0.36) 0.041 (0.25) 0.033 (0.21) 0.03 (0.18) 0.03 (0.17 100 Sinc1 0.69 (4.5) 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.06 (0.39) 0.056 (0.37) 0.056 (0.31) 100 Sinc2 0.56 (3.5) 0.3 (1.9) 0.16 (0.97) 0.09 (0.55) 0.062 (0.39) 0.051 (0.32) 0.046 (0.31) 0.045 (0.2 100 Sinc3 0.51 (3.4) 0.27 (1.8) 0.14 (0.9) 0.083 (0.51) 0.056 (0.36) 0.045 (0.32) 0.044 (0.27) 0.041 (0.27) 100 Sinc4 0.48 (3.3) 0.26 (1.6) 0.14 (0.87) 0.078 (0.48) 0.053 (0.34) 0.043 (0.27) 0.039 (0.24) 0.039 (0.24) 400 Sinc2 1.1 (8.2) 0.58 (4.2) 0.31 (2.3) 0.18 (1.3) 0.12 (0.9) 0.099 (0.74) 0.091 (0.65) 0.091 (0.6 <td>60</td> <td>Sinc1</td> <td>0.55 (3.3)</td> <td>0.28 (1.9)</td> <td>0.15 (0.88)</td> <td>0.087 (0.53)</td> <td>0.058 (0.34)</td> <td>0.047 (0.28)</td> <td>0.044 (0.29)</td> <td>0.042 (0.26)</td>	60	Sinc1	0.55 (3.3)	0.28 (1.9)	0.15 (0.88)	0.087 (0.53)	0.058 (0.34)	0.047 (0.28)	0.044 (0.29)	0.042 (0.26)
60 Sinc4 0.37 (2) 0.2 (1.1) 0.11 (0.6) 0.059 (0.36) 0.041 (0.25) 0.033 (0.21) 0.03 (0.18) 0.03 (0.17) 100 Sinc1 0.69 (4.5) 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.06 (0.39) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.31) 0.046 (0.31) 0.045 (0.22) 0.041 (0.27) 0.09 (0.55) 0.062 (0.39) 0.051 (0.32) 0.046 (0.31) 0.045 (0.22) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.28) 0.058 (0.36) 0.045 (0.3) 0.041 (0.27) 0.041 (0.28) 0.058 (0.36) 0.045 (0.3) 0.041 (0.27) 0.041 (0.28) 0.058 (0.36) 0.044 (0.30) 0.041 (0.28) 0.058 (0.36) 0.044 (0.28) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24)	60	Sinc2	0.45 (2.7)	0.24 (1.4)	0.12 (0.71)	0.07 (0.45)	0.048 (0.32)	0.039 (0.25)	0.036 (0.21)	0.035 (0.21)
100 Sinc1 0.69 (4.5) 0.37 (2.4) 0.19 (1.3) 0.11 (0.73) 0.075 (0.5) 0.06 (0.39) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.056 (0.37) 0.046 (0.31) 0.045 (0.22) 0.046 (0.31) 0.045 (0.22) 0.046 (0.31) 0.045 (0.22) 0.041 (0.27) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0.24) 0.039 (0	60	Sinc3	0.41 (2.7)	0.21 (1.3)	0.11 (0.68)	0.065 (0.4)	0.044 (0.25)	0.036 (0.23)	0.032 (0.19)	0.031 (0.19)
100 Sinc2 0.56 (3.5) 0.3 (1.9) 0.16 (0.97) 0.09 (0.55) 0.062 (0.39) 0.051 (0.32) 0.046 (0.31) 0.045 (0.22) 100 Sinc3 0.51 (3.4) 0.27 (1.8) 0.14 (0.9) 0.083 (0.51) 0.056 (0.36) 0.045 (0.3) 0.041 (0.27) 0.041 (0.27) 100 Sinc4 0.48 (3.3) 0.26 (1.6) 0.14 (0.87) 0.078 (0.48) 0.053 (0.34) 0.043 (0.27) 0.039 (0.24) 0.039 (0.24) 400 Sinc1 1.4 (9.6) 0.72 (5.4) 0.38 (2.7) 0.22 (1.6) 0.15 (1.1) 0.12 (0.85) 0.11 (0.85) 0.11 (0.79 400 Sinc2 1.1 (8.2) 0.58 (4.2) 0.31 (2.3) 0.18 (1.3) 0.12 (0.9) 0.099 (0.74) 0.091 (0.65) 0.091 (0.66) 400 Sinc3 1 (7.4) 0.53 (3.7) 0.28 (2) 0.17 (1.2) 0.11 (0.8) 0.09 (0.66) 0.083 (0.61) 0.083 (0.51) 400 Sinc4 0.95 (6.9) 0.51 (3.6) 0.27 (1.9) 0.15 (1.2) 0.1 (0.7) 0.084 (0.58) 0.077 (0.55) 0.077 (0.55) <	60	Sinc4	0.37 (2)	0.2 (1.1)	0.11 (0.6)	0.059 (0.36)	0.041 (0.25)	0.033 (0.21)	0.03 (0.18)	0.03 (0.17)
100 Sinc3 0.51 (3.4) 0.27 (1.8) 0.14 (0.9) 0.083 (0.51) 0.056 (0.36) 0.045 (0.3) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.041 (0.27) 0.043 (0.27) 0.039 (0.24) 0.091 (0.66) 0.034 (0.51) 0.091	100	Sinc1	0.69 (4.5)	0.37 (2.4)	0.19 (1.3)	0.11 (0.73)	0.075 (0.5)	0.06 (0.39)	0.056 (0.37)	0.056 (0.38)
100 Sinc4 0.48 (3.3) 0.26 (1.6) 0.14 (0.87) 0.078 (0.48) 0.053 (0.34) 0.043 (0.27) 0.039 (0.24) 0.040 (0.58) 0.011 (0.65) 0.011 (0.65) 0.011 (0.65) 0.011 (0.65) 0.011 (0.65) 0.091 (0.66) 0.083 (0.61) 0.091 (0.66) 0.081 (0.61) 0.091 (0.66) 0.081 (0.61) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.091 (0.66) 0.09	100	Sinc2	0.56 (3.5)	0.3 (1.9)	0.16 (0.97)	0.09 (0.55)	0.062 (0.39)	0.051 (0.32)	0.046 (0.31)	0.045 (0.29)
400 Sinc1 1.4 (9.6) 0.72 (5.4) 0.38 (2.7) 0.22 (1.6) 0.15 (1.1) 0.12 (0.85) 0.11 (0.85) 0.11 (0.79) 400 Sinc2 1.1 (8.2) 0.58 (4.2) 0.31 (2.3) 0.18 (1.3) 0.12 (0.9) 0.099 (0.74) 0.091 (0.65) 0.091 (0.6 400 Sinc3 1 (7.4) 0.53 (3.7) 0.28 (2) 0.17 (1.2) 0.11 (0.8) 0.09 (0.66) 0.083 (0.61) 0.083 (0.51) 400 Sinc4 0.95 (6.9) 0.51 (3.6) 0.27 (1.9) 0.15 (1.2) 0.1 (0.7) 0.084 (0.58) 0.077 (0.55) 0.077 (0.55) 1200 Sinc1 2.3 (17) 1.2 (9.2) 0.64 (5) 0.37 (2.9) 0.25 (1.9) 0.2 (1.6) 0.19 (1.4) 0.19 (1.4) 0.19 (1.4) 0.19 (1.4) 0.19 (1.4) 0.19 (1.4) 0.19 (1.4) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) <td>100</td> <td>Sinc3</td> <td>0.51 (3.4)</td> <td>0.27 (1.8)</td> <td>0.14 (0.9)</td> <td>0.083 (0.51)</td> <td>0.056 (0.36)</td> <td>0.045 (0.3)</td> <td>0.041 (0.27)</td> <td>0.041 (0.25)</td>	100	Sinc3	0.51 (3.4)	0.27 (1.8)	0.14 (0.9)	0.083 (0.51)	0.056 (0.36)	0.045 (0.3)	0.041 (0.27)	0.041 (0.25)
400 Sinc2 1.1 (8.2) 0.58 (4.2) 0.31 (2.3) 0.18 (1.3) 0.12 (0.9) 0.099 (0.74) 0.091 (0.65) 0.084 (0.58) 0.091 (0.65) 0.084 (0.58) 0.091 (0.65) 0.084 (0.58) 0.091 (0.65) 0.084 (0.58) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.077 (0.55) 0.071 (0.55) 0.011 (0.65) 0.019 (1.5	100	Sinc4	0.48 (3.3)	0.26 (1.6)	0.14 (0.87)	0.078 (0.48)	0.053 (0.34)	0.043 (0.27)	0.039 (0.24)	0.039 (0.26)
400 Sinc3 1 (7.4) 0.53 (3.7) 0.28 (2) 0.17 (1.2) 0.11 (0.8) 0.09 (0.66) 0.083 (0.61) 0.083 (0.51) 400 Sinc4 0.95 (6.9) 0.51 (3.6) 0.27 (1.9) 0.15 (1.2) 0.1 (0.7) 0.084 (0.58) 0.077 (0.55) 0.077 (0.55) 1200 Sinc1 2.3 (17) 1.2 (9.2) 0.64 (5) 0.37 (2.9) 0.25 (1.9) 0.2 (1.6) 0.19 (1.4) 0.19 (1.5) 1200 Sinc2 1.9 (14) 1 (7.6) 0.54 (3.9) 0.31 (2.4) 0.21 (1.6) 0.17 (1.3) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.16 (1.2) 0.14 (1.1) 0.	400	Sinc1	1.4 (9.6)	0.72 (5.4)	0.38 (2.7)	0.22 (1.6)	0.15 (1.1)	0.12 (0.85)	0.11 (0.85)	0.11 (0.79)
400 Sinc4 0.95 (6.9) 0.51 (3.6) 0.27 (1.9) 0.15 (1.2) 0.1 (0.7) 0.084 (0.58) 0.077 (0.55) 0.077 (0.55) 1200 Sinc1 2.3 (17) 1.2 (9.2) 0.64 (5) 0.37 (2.9) 0.25 (1.9) 0.2 (1.6) 0.19 (1.4) 0.19 (1.5) 1200 Sinc2 1.9 (14) 1 (7.6) 0.54 (3.9) 0.31 (2.4) 0.21 (1.6) 0.17 (1.3) 0.16 (1.2) 0.16 (1.2) 1200 Sinc3 1.8 (13) 0.92 (7) 0.49 (3.7) 0.29 (2.2) 0.19 (1.4) 0.16 (1.2) 0.14 (1.1) 0.14	400	Sinc2	1.1 (8.2)	0.58 (4.2)	0.31 (2.3)	0.18 (1.3)	0.12 (0.9)	0.099 (0.74)	0.091 (0.65)	0.091 (0.69)
1200 Sinc1 2.3 (17) 1.2 (9.2) 0.64 (5) 0.37 (2.9) 0.25 (1.9) 0.2 (1.6) 0.19 (1.4) 0.19 (1.5) 1200 Sinc2 1.9 (14) 1 (7.6) 0.54 (3.9) 0.31 (2.4) 0.21 (1.6) 0.17 (1.3) 0.16 (1.2) 0.16 (1.2) 1200 Sinc3 1.8 (13) 0.92 (7) 0.49 (3.7) 0.29 (2.2) 0.19 (1.4) 0.16 (1.2) 0.14 (1.1) 0.14 (1.1) 1200 Sinc4 1.6 (12) 0.86 (6.4) 0.46 (3.6) 0.27 (2) 0.18 (1.4) 0.15 (1.1) 0.13 (1) 0.13 (1) 2400 Sinc1 3.2 (25) 1.7 (13) 0.88 (6.7) 0.51 (3.9) 0.35 (2.7) 0.28 (2.2) 0.26 (2) 0.26 (2) 2400 Sinc2 2.7 (21) 1.4 (10) 0.76 (5.8) 0.44 (3.3) 0.3 (2.2) 0.24 (1.9) 0.22 (1.6) 0.22 (1.6) 2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.7) 0.2 (1.6) 0.2 (1.5) 2400 Sinc4 2.3 (1	400	Sinc3	1 (7.4)	0.53 (3.7)	0.28 (2)	0.17 (1.2)	0.11 (0.8)	0.09 (0.66)	0.083 (0.61)	0.083 (0.59)
1200 Sinc2 1.9 (14) 1 (7.6) 0.54 (3.9) 0.31 (2.4) 0.21 (1.6) 0.17 (1.3) 0.16 (1.2) 0.16 (1.2) 1200 Sinc3 1.8 (13) 0.92 (7) 0.49 (3.7) 0.29 (2.2) 0.19 (1.4) 0.16 (1.2) 0.14 (1.1) 0.14 (1.1) 1200 Sinc4 1.6 (12) 0.86 (6.4) 0.46 (3.6) 0.27 (2) 0.18 (1.4) 0.15 (1.1) 0.13 (1) 0.13 (1) 2400 Sinc1 3.2 (25) 1.7 (13) 0.88 (6.7) 0.51 (3.9) 0.35 (2.7) 0.28 (2.2) 0.26 (2) 0.26 (2) 2400 Sinc2 2.7 (21) 1.4 (10) 0.76 (5.8) 0.44 (3.3) 0.3 (2.2) 0.24 (1.9) 0.22 (1.6) 0.22 (1.6) 2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.7) 0.2 (1.6) 0.2 (1.5) 2400 Sinc4 2.3 (17) 1.2 (9.4) 0.65 (4.9) 0.37 (2.8) 0.25 (2) 0.21 (1.5) 0.19 (1.5) 0.19 (1.4) 4800 Sinc1 4.3 (400	Sinc4	0.95 (6.9)	0.51 (3.6)	0.27 (1.9)	0.15 (1.2)	0.1 (0.7)	0.084 (0.58)	0.077 (0.55)	0.077 (0.57)
1200 Sinc3 1.8 (13) 0.92 (7) 0.49 (3.7) 0.29 (2.2) 0.19 (1.4) 0.16 (1.2) 0.14 (1.1) 0.14 (1.1) 1200 Sinc4 1.6 (12) 0.86 (6.4) 0.46 (3.6) 0.27 (2) 0.18 (1.4) 0.15 (1.1) 0.13 (1) 0.13 (1) 2400 Sinc1 3.2 (25) 1.7 (13) 0.88 (6.7) 0.51 (3.9) 0.35 (2.7) 0.28 (2.2) 0.26 (2) 0.26 (2) 2400 Sinc2 2.7 (21) 1.4 (10) 0.76 (5.8) 0.44 (3.3) 0.3 (2.2) 0.24 (1.9) 0.22 (1.6) 0.22 (1.6) 2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.6) 0.2 (1.6) 0.2 (1.5) 2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.25 (2) 0.21 (1.5) 0.19 (1.5) 0.19 (1.4) 4800 Sinc4 2.3 (17) 1.2 (9.4) 0.69 (5.2) 0.46 (3.5) 0.37 (2.9) 0.34 (2.6) 0.34 (2.6) 4800 Sinc2 3.8 (29) 2 (15) </td <td>1200</td> <td>Sinc1</td> <td>2.3 (17)</td> <td>1.2 (9.2)</td> <td>0.64 (5)</td> <td>0.37 (2.9)</td> <td>0.25 (1.9)</td> <td>0.2 (1.6)</td> <td>0.19 (1.4)</td> <td>0.19 (1.5)</td>	1200	Sinc1	2.3 (17)	1.2 (9.2)	0.64 (5)	0.37 (2.9)	0.25 (1.9)	0.2 (1.6)	0.19 (1.4)	0.19 (1.5)
1200 Sinc4 1.6 (12) 0.86 (6.4) 0.46 (3.6) 0.27 (2) 0.18 (1.4) 0.15 (1.1) 0.13 (1) 0.13 (1) 2400 Sinc1 3.2 (25) 1.7 (13) 0.88 (6.7) 0.51 (3.9) 0.35 (2.7) 0.28 (2.2) 0.26 (2) 0.26 (2) 2400 Sinc2 2.7 (21) 1.4 (10) 0.76 (5.8) 0.44 (3.3) 0.3 (2.2) 0.24 (1.9) 0.22 (1.6) 0.22 (1.6) 2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.7) 0.2 (1.6) 0.2 (1.5) 2400 Sinc3 2.5 (19) 1.3 (9.4) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.7) 0.2 (1.6) 0.2 (1.5) 2400 Sinc4 2.3 (17) 1.2 (9.4) 0.65 (4.9) 0.37 (2.8) 0.25 (2) 0.21 (1.5) 0.19 (1.5) 0.19 (1.4) 4800 Sinc1 4.3 (33) 2.3 (17) 1.2 (9.4) 0.69 (5.2) 0.46 (3.5) 0.37 (2.9) 0.34 (2.6) 0.34 (2.6) 4800 Sinc2 3.8 (29)<	1200	Sinc2	1.9 (14)	1 (7.6)	0.54 (3.9)	0.31 (2.4)	0.21 (1.6)	0.17 (1.3)	0.16 (1.2)	0.16 (1.2)
2400 Sinc1 3.2 (25) 1.7 (13) 0.88 (6.7) 0.51 (3.9) 0.35 (2.7) 0.28 (2.2) 0.26 (2) 0.26 (2) 2400 Sinc2 2.7 (21) 1.4 (10) 0.76 (5.8) 0.44 (3.3) 0.3 (2.2) 0.24 (1.9) 0.22 (1.6) 0.22 (1.6) 2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.7) 0.2 (1.6) 0.2 (1.5) 2400 Sinc4 2.3 (17) 1.2 (9.4) 0.65 (4.9) 0.37 (2.8) 0.25 (2) 0.21 (1.5) 0.19 (1.5) 0.19 (1.4) 4800 Sinc1 4.3 (33) 2.3 (17) 1.2 (9.4) 0.69 (5.2) 0.46 (3.5) 0.37 (2.9) 0.34 (2.6) 0.34 (2.6) 4800 Sinc2 3.8 (29) 2 (15) 1.1 (8.5) 0.61 (4.7) 0.41 (3.1) 0.33 (2.6) 0.31 (2.3) 0.3 (2.3) 4800 Sinc3 3.5 (27) 1.8 (14) 0.97 (7.2) 0.56 (4.1) 0.38 (3) 0.31 (2.4) 0.28 (2.1) 0.28 (2.2) 4800 Sinc4 3.3 (25	1200	Sinc3	1.8 (13)	0.92 (7)	0.49 (3.7)	0.29 (2.2)	0.19 (1.4)	0.16 (1.2)	0.14 (1.1)	0.14 (1.1)
2400 Sinc2 2.7 (21) 1.4 (10) 0.76 (5.8) 0.44 (3.3) 0.3 (2.2) 0.24 (1.9) 0.22 (1.6) 0.22 (1.6) 2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.7) 0.2 (1.6) 0.2 (1.5) 2400 Sinc4 2.3 (17) 1.2 (9.4) 0.65 (4.9) 0.37 (2.8) 0.25 (2) 0.21 (1.5) 0.19 (1.5) 0.19 (1.4) 4800 Sinc1 4.3 (33) 2.3 (17) 1.2 (9.4) 0.69 (5.2) 0.46 (3.5) 0.37 (2.9) 0.34 (2.6) 0.34 (2.6) 4800 Sinc2 3.8 (29) 2 (15) 1.1 (8.5) 0.61 (4.7) 0.41 (3.1) 0.33 (2.6) 0.31 (2.3) 0.3 (2.3) 4800 Sinc3 3.5 (27) 1.8 (14) 0.97 (7.2) 0.56 (4.1) 0.38 (3) 0.31 (2.4) 0.28 (2.1) 0.28 (2.2) 4800 Sinc4 3.3 (25) 1.7 (13) 0.92 (7.1) 0.53 (4.1) 0.36 (2.7) 0.29 (2.2) 0.27 (2.1) 0.27 (1.9) 7200 Sinc1 5 (1200	Sinc4	1.6 (12)	0.86 (6.4)	0.46 (3.6)	0.27 (2)	0.18 (1.4)	0.15 (1.1)	0.13 (1)	0.13 (1)
2400 Sinc3 2.5 (19) 1.3 (9.8) 0.69 (5.2) 0.4 (3) 0.27 (2.1) 0.22 (1.7) 0.2 (1.6) 0.2 (1.5) 2400 Sinc4 2.3 (17) 1.2 (9.4) 0.65 (4.9) 0.37 (2.8) 0.25 (2) 0.21 (1.5) 0.19 (1.5) 0.19 (1.4) 4800 Sinc1 4.3 (33) 2.3 (17) 1.2 (9.4) 0.69 (5.2) 0.46 (3.5) 0.37 (2.9) 0.34 (2.6) 0.34 (2.6) 4800 Sinc2 3.8 (29) 2 (15) 1.1 (8.5) 0.61 (4.7) 0.41 (3.1) 0.33 (2.6) 0.31 (2.3) 0.3 (2.3) 4800 Sinc3 3.5 (27) 1.8 (14) 0.97 (7.2) 0.56 (4.1) 0.38 (3) 0.31 (2.4) 0.28 (2.1) 0.28 (2.2) 4800 Sinc4 3.3 (25) 1.7 (13) 0.92 (7.1) 0.53 (4.1) 0.36 (2.7) 0.29 (2.2) 0.27 (2.1) 0.27 (1.9) 7200 Sinc1 5 (38) 2.6 (20) 1.4 (10) 0.8 (6) 0.53 (4) 0.43 (3.2) 0.39 (2.9) 0.39 (2.9) 7200 Sinc2 4.6 (35) <td>2400</td> <td>Sinc1</td> <td>3.2 (25)</td> <td>1.7 (13)</td> <td>0.88 (6.7)</td> <td>0.51 (3.9)</td> <td>0.35 (2.7)</td> <td>0.28 (2.2)</td> <td>0.26 (2)</td> <td>0.26 (2)</td>	2400	Sinc1	3.2 (25)	1.7 (13)	0.88 (6.7)	0.51 (3.9)	0.35 (2.7)	0.28 (2.2)	0.26 (2)	0.26 (2)
2400 Sinc4 2.3 (17) 1.2 (9.4) 0.65 (4.9) 0.37 (2.8) 0.25 (2) 0.21 (1.5) 0.19 (1.5) 0.19 (1.4) 4800 Sinc1 4.3 (33) 2.3 (17) 1.2 (9.4) 0.69 (5.2) 0.46 (3.5) 0.37 (2.9) 0.34 (2.6) 0.34 (2.6) 4800 Sinc2 3.8 (29) 2 (15) 1.1 (8.5) 0.61 (4.7) 0.41 (3.1) 0.33 (2.6) 0.31 (2.3) 0.3 (2.3) 4800 Sinc3 3.5 (27) 1.8 (14) 0.97 (7.2) 0.56 (4.1) 0.38 (3) 0.31 (2.4) 0.28 (2.1) 0.28 (2.2) 4800 Sinc4 3.3 (25) 1.7 (13) 0.92 (7.1) 0.53 (4.1) 0.36 (2.7) 0.29 (2.2) 0.27 (2.1) 0.27 (1.9) 7200 Sinc1 5 (38) 2.6 (20) 1.4 (10) 0.8 (6) 0.53 (4) 0.43 (3.2) 0.39 (2.9) 0.39 (2.9) 7200 Sinc2 4.6 (35) 2.4 (19) 1.3 (9.9) 0.73 (5.4) 0.49 (3.8) 0.39 (2.9) 0.36 (2.8) 0.36 (2.7)	2400	Sinc2	2.7 (21)	1.4 (10)	0.76 (5.8)	0.44 (3.3)	0.3 (2.2)	0.24 (1.9)	0.22 (1.6)	0.22 (1.6)
4800 Sinc1 4.3 (33) 2.3 (17) 1.2 (9.4) 0.69 (5.2) 0.46 (3.5) 0.37 (2.9) 0.34 (2.6) 0.34 (2.6) 4800 Sinc2 3.8 (29) 2 (15) 1.1 (8.5) 0.61 (4.7) 0.41 (3.1) 0.33 (2.6) 0.31 (2.3) 0.3 (2.3) 4800 Sinc3 3.5 (27) 1.8 (14) 0.97 (7.2) 0.56 (4.1) 0.38 (3) 0.31 (2.4) 0.28 (2.1) 0.28 (2.2) 4800 Sinc4 3.3 (25) 1.7 (13) 0.92 (7.1) 0.53 (4.1) 0.36 (2.7) 0.29 (2.2) 0.27 (2.1) 0.27 (1.9) 7200 Sinc1 5 (38) 2.6 (20) 1.4 (10) 0.8 (6) 0.53 (4) 0.43 (3.2) 0.39 (2.9) 0.39 (2.9) 7200 Sinc2 4.6 (35) 2.4 (19) 1.3 (9.9) 0.73 (5.4) 0.49 (3.8) 0.39 (2.9) 0.36 (2.8) 0.36 (2.7)	2400	Sinc3	2.5 (19)	1.3 (9.8)	0.69 (5.2)	0.4 (3)	0.27 (2.1)	0.22 (1.7)	0.2 (1.6)	0.2 (1.5)
4800 Sinc2 3.8 (29) 2 (15) 1.1 (8.5) 0.61 (4.7) 0.41 (3.1) 0.33 (2.6) 0.31 (2.3) 0.3 (2.3) 4800 Sinc3 3.5 (27) 1.8 (14) 0.97 (7.2) 0.56 (4.1) 0.38 (3) 0.31 (2.4) 0.28 (2.1) 0.28 (2.2) 4800 Sinc4 3.3 (25) 1.7 (13) 0.92 (7.1) 0.53 (4.1) 0.36 (2.7) 0.29 (2.2) 0.27 (2.1) 0.27 (1.9) 7200 Sinc1 5 (38) 2.6 (20) 1.4 (10) 0.8 (6) 0.53 (4) 0.43 (3.2) 0.39 (2.9) 0.39 (2.9) 7200 Sinc2 4.6 (35) 2.4 (19) 1.3 (9.9) 0.73 (5.4) 0.49 (3.8) 0.39 (2.9) 0.36 (2.8) 0.36 (2.7)	2400	Sinc4	2.3 (17)	1.2 (9.4)	0.65 (4.9)	0.37 (2.8)	0.25 (2)	0.21 (1.5)	0.19 (1.5)	0.19 (1.4)
4800 Sinc3 3.5 (27) 1.8 (14) 0.97 (7.2) 0.56 (4.1) 0.38 (3) 0.31 (2.4) 0.28 (2.1) 0.28 (2.2) 4800 Sinc4 3.3 (25) 1.7 (13) 0.92 (7.1) 0.53 (4.1) 0.36 (2.7) 0.29 (2.2) 0.27 (2.1) 0.27 (1.9) 7200 Sinc1 5 (38) 2.6 (20) 1.4 (10) 0.8 (6) 0.53 (4) 0.43 (3.2) 0.39 (2.9) 0.39 (2.9) 7200 Sinc2 4.6 (35) 2.4 (19) 1.3 (9.9) 0.73 (5.4) 0.49 (3.8) 0.39 (2.9) 0.36 (2.8) 0.36 (2.7)	4800	Sinc1	4.3 (33)	2.3 (17)	1.2 (9.4)	0.69 (5.2)	0.46 (3.5)	0.37 (2.9)	0.34 (2.6)	0.34 (2.6)
4800 Sinc4 3.3 (25) 1.7 (13) 0.92 (7.1) 0.53 (4.1) 0.36 (2.7) 0.29 (2.2) 0.27 (2.1) 0.27 (1.9) 7200 Sinc1 5 (38) 2.6 (20) 1.4 (10) 0.8 (6) 0.53 (4) 0.43 (3.2) 0.39 (2.9) 0.39 (2.9) 7200 Sinc2 4.6 (35) 2.4 (19) 1.3 (9.9) 0.73 (5.4) 0.49 (3.8) 0.39 (2.9) 0.36 (2.7)	4800	Sinc2	3.8 (29)	2 (15)	1.1 (8.5)	0.61 (4.7)	0.41 (3.1)	0.33 (2.6)	0.31 (2.3)	0.3 (2.3)
7200 Sinc1 5 (38) 2.6 (20) 1.4 (10) 0.8 (6) 0.53 (4) 0.43 (3.2) 0.39 (2.9) 0.39 (2.9) 7200 Sinc2 4.6 (35) 2.4 (19) 1.3 (9.9) 0.73 (5.4) 0.49 (3.8) 0.39 (2.9) 0.36 (2.8) 0.36 (2.7)	4800	Sinc3	3.5 (27)	1.8 (14)	0.97 (7.2)	0.56 (4.1)	0.38 (3)	0.31 (2.4)	0.28 (2.1)	0.28 (2.2)
7200 Sinc2 4.6 (35) 2.4 (19) 1.3 (9.9) 0.73 (5.4) 0.49 (3.8) 0.39 (2.9) 0.36 (2.8) 0.36 (2.7)	4800	Sinc4	3.3 (25)	1.7 (13)	0.92 (7.1)	0.53 (4.1)	0.36 (2.7)	0.29 (2.2)	0.27 (2.1)	0.27 (1.9)
	7200	Sinc1	5 (38)	2.6 (20)	1.4 (10)	0.8 (6)	0.53 (4)	0.43 (3.2)	0.39 (2.9)	0.39 (2.9)
	7200	Sinc2	4.6 (35)		1.3 (9.9)	0.73 (5.4)	0.49 (3.8)	0.39 (2.9)	0.36 (2.8)	0.36 (2.7)
1200 31163 4.3 (33) 2.2 (11) 1.2 (3.3) 0.00 (3) 0.40 (3.0) 0.31 (2.0) 0.34 (2.5) 0.34 (2.0)	7200	Sinc3	4.3 (33)	2.2 (17)	1.2 (9.3)	0.68 (5)	0.46 (3.6)	0.37 (2.8)	0.34 (2.5)	0.34 (2.6)
7200 Sinc4 4.1 (31) 2.1 (15) 1.1 (8.8) 0.65 (5) 0.44 (3.3) 0.35 (2.6) 0.33 (2.5) 0.32 (2.5)	7200	Sinc4						0.35 (2.6)	0.33 (2.5)	0.32 (2.5)
	14400	Sinc5		` '						0.45 (3.4)
	19200	Sinc5		4.3 (34)	` ,				` '	0.53 (4.1)
25600 Sinc5 19 (140) 9.5 (73) 4.8 (37) 2.5 (18) 1.3 (10) 0.83 (6.3) 0.8 (6) 0.81 (6)	25600	Sinc5					1 1			
40000 Sinc5 30 (220) 15 (110) 7.7 (56) 3.9 (29) 2 (15) 1.2 (9.4) 1.2 (8.9) 1.2 (9)		Sinc5								



Table 2. Effective Resolution (Noise-Free Resolution) at $T_A = 25^{\circ}C$ and External 5-V Reference

DATA		GAIN								
RATE (SPS)	FILTER	1	2	4	8	16	32	64	128	
2.5	FIR	24 (24)	24 (22.8)	24 (23.8)	24 (23.8)	24 (23.8)	24 (22.8)	24 (22)	23 (20.8)	
2.5	Sinc1	24 (24)	24 (22.8)	24 (23.8)	24 (23.8)	24 (22.8)	24 (22.8)	24 (22.4)	23.2 (21.2)	
2.5	Sinc2	24 (24)	24 (22.8)	24 (23.8)	22.8 (23.8)	21.8 (22.8)	24 (23.8)	24 (22.4)	23.9 (22)	
2.5	Sinc3	24 (24)	24 (22.8)	24 (23.8)	22.8 (23.8)	24 (23.8)	24 (23.8)	24 (22.4)	23.8 (22)	
2.5	Sinc4	24 (24)	24 (22.8)	24 (23.8)	22.8 (23.8)	24 (23.8)	24 (23.8)	24 (23)	23.5 (22)	
5	FIR	24 (23)	24 (22.8)	24 (23.8)	24 (22.8)	24 (22.2)	24 (21.8)	23.6 (21.7)	22.5 (20.7)	
5	Sinc1	24 (23.7)	24 (23.8)	24 (23.8)	24 (22.8)	24 (22.2)	24 (22.8)	23.3 (21.4)	22.8 (20.7)	
5	Sinc2	24 (24)	24 (23.8)	24 (23.8)	24 (23.8)	24 (23.8)	24 (22.8)	23.7 (21.7)	22.8 (21)	
5	Sinc3	24 (24)	24 (23.8)	24 (23.8)	24 (23.8)	24 (23.8)	24 (22.8)	23.5 (21.4)	23.5 (21.7)	
5	Sinc4	24 (24)	24 (23.8)	24 (23.8)	22.8 (23.8)	24 (23.8)	24 (23.8)	24 (22)	23.3 (21.2)	
10	FIR	24 (22.4)	24 (22.8)	24 (22.8)	24 (22.2)	24 (21.8)	23.5 (21.2)	22.8 (20.5)	22.1 (19.9)	
10	Sinc1	24 (23)	24 (22.8)	24 (22.8)	24 (22.8)	24 (22.2)	23.6 (21.2)	23.4 (21.2)	22.3 (19.8)	
10	Sinc2	24 (23)	24 (22.8)	24 (22.8)	24 (22.8)	24 (22.2)	24 (22.2)	23.2 (21.4)	22.3 (20.2)	
10	Sinc3	24 (24)	24 (22.8)	24 (23.8)	24 (23.8)	24 (22.8)	24 (22.2)	23.3 (21.2)	22.7 (20.7)	
10	Sinc4	24 (24)	24 (22.8)	24 (23.8)	24 (22.8)	24 (22.8)	24 (22.2)	23.7 (21.4)	22.9 (20.8)	
16.6	Sinc1	24 (22)	24 (21.8)	24 (22.2)	24 (21.8)	23.7 (21.2)	23.4 (21)	22.5 (20.3)	21.8 (19.6)	
16.6	Sinc2	24 (22.4)	24 (22.8)	24 (22.2)	24 (22.2)	24 (21.8)	23.7 (21.2)	23 (20.7)	22 (19.5)	
16.6	Sinc3	24 (23)	24 (22.8)	24 (22.2)	24 (22.8)	24 (22.8)	23.9 (21.5)	23.1 (21)	22 (19.8)	
16.6	Sinc4	24 (23)	24 (22.8)	24 (22.8)	24 (22.8)	24 (22.2)	24 (21.5)	23.4 (20.7)	22.5 (20.1)	
20	FIR	24 (22)	23.8 (21.5)	23.9 (21.8)	23.9 (21.5)	23.5 (21)	22.9 (20.5)	22.2 (19.8)	21.3 (18.7)	
20	Sinc1	24 (22)	24 (22.2)	24 (21.8)	23.9 (21.8)	23.7 (21.5)	23.3 (21)	22.6 (20.3)	21.5 (19.2)	
20	Sinc2	24 (23)	24 (22.2)	24 (22.2)	24 (21.8)	24 (21.8)	23.6 (21.2)	22.8 (20.3)	21.9 (19.6)	
20	Sinc3	24 (22.4)	24 (22.8)	24 (22.2)	24 (22.8)	24 (21.8)	23.7 (21.5)	23 (20.7)	21.9 (19.4)	
20	Sinc4	24 (23)	24 (22.8)	24 (22.8)	24 (22.2)	24 (22.2)	23.8 (21.2)	23.1 (20.7)	22 (19.4)	
50	Sinc1	23.9 (21.4)	23.7 (21.5)	23.7 (21.2)	23.5 (20.8)	23.3 (20.6)	22.6 (20)	21.9 (19.3)	21 (18.6)	
50	Sinc2	24 (21.7)	23.9 (21.5)	23.8 (21.2)	23.7 (21.5)	23.5 (20.8)	22.9 (20.2)	22.1 (19.3)	21.2 (18.8)	
50	Sinc3	24 (22)	23.9 (21.5)	23.9 (21.5)	23.8 (21)	23.6 (21.2)	23 (20.5)	22.3 (19.8)	21.3 (18.6)	
50	Sinc4	24 (22)	24 (21.8)	24 (21.8)	23.9 (21.5)	23.7 (21.2)	23.2 (20.8)	22.4 (20)	21.5 (18.9)	
60	Sinc1	23.7 (21.4)	23.6 (21)	23.6 (21.2)	23.4 (20.8)	23.1 (20.5)	22.5 (19.9)	21.8 (19.1)	20.8 (18.2)	
60	Sinc2	24 (21.4)	23.8 (21.5)	23.7 (21.2)	23.6 (21.2)	23.4 (20.8)	22.7 (20.2)	22.1 (19.3)	21.2 (18.5)	
60	Sinc3	24 (21.7)	23.9 (21.5)	23.9 (21.5)	23.7 (21.2)	23.5 (20.8)	22.9 (20.5)	22.2 (19.5)	21.2 (18.8)	
60	Sinc4	24 (22)	24 (21.8)	23.9 (21.5)	23.7 (21.2)	23.4 (20.6)	23 (20.2)	22.2 (19.5)	21.2 (18.7)	
100	Sinc1	23.6 (21)	23.4 (20.6)	23.3 (20.5)	23.1 (20.4)	22.8 (20)	22.1 (19.4)	21.4 (18.8)	20.5 (17.7)	
100	Sinc2	23.8 (21)	23.6 (21)	23.6 (21)	23.4 (21)	23 (20.2)	22.4 (19.7)	21.7 (19.1)	20.8 (18)	
100	Sinc3	23.8 (21.2)	23.6 (21.2)	23.6 (21)	23.5 (21)	23.2 (20.5)	22.5 (19.9)	21.8 (19)	20.8 (17.9)	
100	Sinc4	23.9 (21.4)	23.7 (21.2)	23.7 (21.2)	23.6 (21)	23.3 (20.6)	22.6 (19.7)	21.9 (19.4)	21 (18.1)	
400	Sinc1	22.8 (19.8)	22.5 (19.7)	22.5 (19.6)	22.3 (19.6)	21.9 (19)	21.2 (18.2)	20.4 (17.6)	19.5 (16.6)	
400	Sinc2	23.1 (20.3)	22.8 (20.1)	22.8 (20)	22.6 (19.6)	22.1 (19.2)	21.4 (18.6)	20.7 (17.9)	19.8 (17.1)	
400	Sinc3	23.1 (20.4)	22.9 (20)	22.8 (19.9)	22.7 (20)	22.3 (19.4)	21.5 (18.7)	20.8 (17.8)	19.9 (17)	
400	Sinc4	23.2 (20.3)	23 (20.2)	22.9 (20.1)	22.7 (20.1)	22.3 (19.5)	21.7 (18.9)	21 (18)	20 (17.2)	
1200	Sinc1	22.1 (19.2)	21.8 (19.1)	21.7 (18.9)	21.6 (18.7)	21.1 (18.3)	20.4 (17.5)	19.7 (16.8)	18.8 (15.7)	
1200	Sinc2	22.3 (19.5)	22.1 (19.3)	22 (19.1)	21.8 (18.9)	21.4 (18.4)	20.6 (17.7)	20 (17.1)	19 (16)	
1200	Sinc3	22.4 (19.6)	22.2 (19.2)	22.1 (19.2)	21.9 (19)	21.5 (18.5)	20.8 (18)	20.1 (17.2)	19.2 (16.2)	
1200	Sinc4	22.5 (19.6)	22.3 (19.6)	22.2 (19.2)	22 (19.1)	21.6 (18.7)	20.9 (18)	20.2 (17.3)	19.2 (16.4)	
2400	Sinc1	21.6 (18.7)	21.4 (18.3)	21.3 (18.4)	21.1 (18.1)	20.7 (17.7)	19.9 (17.1)	19.2 (16.2)	18.3 (15.4)	
2400	Sinc2	21.8 (18.8)	21.6 (18.6)	21.5 (18.6)	21.3 (18.5)	20.9 (18)	20.2 (17.3)	19.5 (16.6)	18.5 (15.6)	

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Table 2. Effective Resolution (Noise-Free Resolution) at $T_A = 25$ °C and External 5-V Reference (continued)

DATA		GAIN								
RATE (SPS)	FILTER	1	2	4	8	16	32	64	128	
2400	Sinc3	21.9 (19.1)	21.7 (18.8)	21.6 (18.6)	21.4 (18.6)	21 (18.1)	20.3 (17.5)	19.6 (16.7)	18.7 (15.7)	
2400	Sinc4	22 (19.1)	21.8 (19)	21.8 (19)	21.6 (18.6)	21.1 (18)	20.4 (17.5)	19.7 (16.7)	18.8 (15.9)	
4800	Sinc1	21.1 (18.1)	20.9 (17.9)	20.9 (17.9)	20.6 (17.7)	20.2 (17.2)	19.5 (16.6)	18.8 (15.8)	17.9 (14.9)	
4800	Sinc2	21.3 (18.4)	21.1 (18.1)	21 (18.1)	20.8 (17.9)	20.4 (17.4)	19.7 (16.6)	19 (16.1)	18 (14.9)	
4800	Sinc3	21.4 (18.4)	21.2 (18.3)	21.1 (18.3)	21 (18)	20.5 (17.6)	19.8 (16.8)	19.1 (16.3)	18.2 (15.1)	
4800	Sinc4	21.5 (18.6)	21.3 (18.4)	21.2 (18.2)	21.1 (18.1)	20.6 (17.7)	19.9 (17)	19.2 (16.3)	18.2 (15.3)	
7200	Sinc1	20.9 (17.8)	20.7 (17.7)	20.6 (17.4)	20.4 (17.5)	20 (17)	19.3 (16.4)	18.6 (15.7)	17.7 (14.7)	
7200	Sinc2	21 (18.1)	20.8 (17.9)	20.7 (17.9)	20.6 (17.6)	20.2 (17.2)	19.4 (16.4)	18.7 (15.9)	17.8 (14.9)	
7200	Sinc3	21.1 (18.1)	20.9 (18.1)	20.8 (17.9)	20.6 (17.8)	20.2 (17.2)	19.5 (16.5)	18.8 (15.9)	17.9 (14.9)	
7200	Sinc4	21.2 (18.1)	21 (18)	20.9 (18.1)	20.7 (18)	20.3 (17.2)	19.6 (16.7)	18.9 (15.9)	18 (15)	
14400	Sinc5	20.5 (17.7)	20.3 (17.5)	20.2 (17.3)	20.1 (17.1)	19.8 (16.9)	19.1 (16.1)	18.4 (15.4)	17.5 (14.5)	
19200	Sinc5	19.7 (16.8)	19.5 (16.5)	19.4 (16.5)	19.4 (16.3)	19.2 (16.2)	18.8 (15.9)	18 (15.1)	17 (14.2)	
25600	Sinc5	18.2 (15.2)	18 (14.9)	18 (15.2)	17.9 (14.7)	17.9 (15.1)	17.8 (14.8)	17 (14.2)	16 (13.2)	
40000	Sinc5	17.4 (14.6)	17.2 (14.2)	17.2 (14.2)	17.2 (14.3)	17.2 (14.2)	17.1 (14.3)	16.3 (13.4)	15.3 (12.5)	



9 Detailed Description

9.1 Overview

The ADS1260 and ADS1261 are 5-channel and 10-channel, precision 24-bit, delta-sigma ($\Delta\Sigma$) ADCs with an integrated analog front end (AFE) and voltage reference. The low-noise and low-drift architecture make the ADCs suitable for precision measurement of low signal level sensors, such as strain-gauge bridges, pressure transducers and temperature sensors.

Key features of the ADC are:

- Very low noise, 1-GΩ input impedance PGA
- High-Precision, 24-bit $\Delta\Sigma$ ADC
- Internal oscillator
- 2.5-V voltage reference
- · Signal and voltage reference monitors
- Excitation current sources
- Input level-shift voltage
- Sensor burn-out current sources
- Temperature sensor
- Cyclic Redundancy Check (CRC) communication error detection
- Two voltage reference inputs (ADS1261)
- Four GPIO with ac-excitation (ADS1261)

The analog inputs (AINx) connect to the input multiplexer (MUX). The ADC supports three (five) differential or five (ten) single-ended input configurations for ADS1260 and ADS1261, respectively.

The programmable gain amplifier (PGA) follows the input multiplexer. The PGA is suitable for direct connection to low-level sensors. The gain is programmable from 1 to 128. The PGA bypass option connects the analog inputs directly to the precharge buffered modulator, extending the input voltage range to the power supplies. The PGA output connects to pins CAPP and CAPN. The ADC antialias filter is provided at the PGA output with an external capacitor.

The PGA is monitored to verify linear operation. Alarm bits in the status register set if the linear range of the PGA is exceeded.

A delta-sigma modulator measures the input voltage relative to the reference voltage to produce the 24-bit conversion result. The differential input range of the ADC is $\pm V_{RFF}$ / Gain.

The digital filter averages and decimates the modulator output data to yield the final, down-sampled conversion result. The sinc filter is programmable (sinc1 through sinc5) allowing optimization of conversion time, conversion noise and line-cycle rejection. The finite impulse response (FIR) filter mode provides single-cycle settled data with simultaneous rejection of 50-Hz and 60-Hz at data rates of 20 SPS or less.

The ADC reference is either 2.5-V internal, external or the 5-V analog power supply. The REFOUT pin provides the buffered reference voltage output. The external reference is monitored for low or missing voltage. The ADS1261 provides two voltage reference inputs, multiplexed with the analog inputs.

The ADC includes two current sources that provide excitation to resistive sensors (RTD). Additionally, the ADS1261 provides four GPIO control lines. The GPIOs are used for input and output of general-purpose logic signals, as well as providing drive signals for ac-excited bridges. The GPIOs are multiplexed to the analog inputs.

The temperature sensor and the power supply voltages are read through the multiplexer. The programmable burn-out test currents connect to the multiplexer output. The currents detect failed sensors or faults in the sensor connection. The level-shift voltage on AINCOM provides the bias for floating sensors.

The SPI-compatible serial interface is used to read the conversion data and also to configure and control the ADC. Data communication errors are detected by CRC. The serial interface consists of four signals: \overline{CS} , SCLK, DIN and DOUT/ \overline{DRDY} . The dual function DOUT/ \overline{DRDY} provides data output and also the data ready signal. The ADC serial interface can be implemented with as little as three pins by tying \overline{CS} low.

The ADC clock is either internal or external. The ADC detects the external clock automatically. The nominal clock frequency is 7.3728 MHz (10.24 MHz for 40-kSPS operation).

Product Folder Links: ADS1260 ADS1261

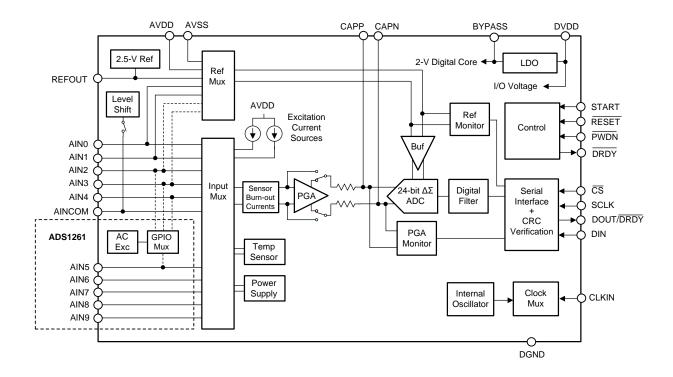


Overview (continued)

ADC conversions are controlled by the START pin or by the START command. The ADC is programmable for continuous or one-shot conversions. The DRDY or DOUT/DRDY pin provides the conversion data ready signal. When taken low, the RESET pin resets the ADC. The ADC is powered down by the PWDN pin or is powered down in software mode.

The ADC operates in either bipolar analog supply configuration (±2.5 V), or in a single 5-V supply configuration. The digital power supply range is 2.7 V to 5 V. The BYPASS pin is the internal subregulator output used for the ADC digital core.

9.2 Functional Block Diagram





9.3 Feature Description

The following sections describe the functional blocks of the ADC.

9.3.1 Analog Inputs

Figure 48 shows the analog input circuit consist of ESD-protection diodes, the input multiplexer and sensor burnout current sources. The ADS1260 has six analog inputs to support five single-ended measurement channels. The ADS1261 has 11 analog inputs to support 10 single-ended measurement channels. Both devices have four internal (system) measurements, and an option where no inputs are connected.

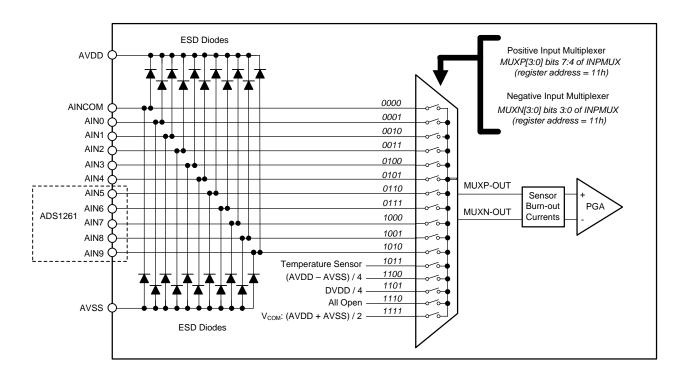


Figure 48. Analog Input Block Diagram

9.3.1.1 ESD Diodes

ESD diodes are incorporated to protect the ADC inputs from possible ESD events occurring during the manufacturing process and during PCB assembly when manufactured in an ESD-controlled environment. For system-level ESD protection, consider the use of external ESD protection devices for pins that are exposed to ESD, including the analog inputs.

If either input is driven below AVSS -0.3 V, or above AVDD +0.3 V, the internal protection diodes may conduct. If these conditions are possible, use external clamp diodes, series resistors, or both to limit the input current to the specified maximum value.

9.3.1.2 Input Multiplexer

The input multiplexer selects the signal for measurement. The multiplexer consists of independent positive and negative sections. See Figure 48 for multiplexer register settings. The multiplexers select any input as positive and any input as negative for the PGA. Because the level-shift voltage connects to AINCOM (only), AINCOM is suitable as the common input for single-ended signals that require a level-shift voltage.

The switching sequence of the multiplexer is break-before-make in order to reduce charge injection into the next measurement channel. Be aware that over-driving unused channels beyond the power supplies can effect conversions taking place on active channels. See the Input Overload section for more information.

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Feature Description (continued)

9.3.1.3 Temperature Sensor

The ADC has an internal temperature sensor. The temperature sensor is comprised of two internal diodes with one diode having 80 times the current density of the other. The difference in current density of the diodes yields a differential output voltage that is proportional to absolute temperature. The temperature sensor reading is converted by the ADC. See Figure 48 for register settings to select the temperature sensor for measurement.

Equation 2 shows how to convert the temperature sensor reading to degrees Celsius (°C):

Temperature (°C) = [(Temperature Reading (
$$\mu$$
V) – 122,400) / 420 μ V/°C] + 25°C (2)

Measure the temperature sensor with PGA on, gain = 1, burn-out current sources disabled and ac-excitation mode disabled. As a result of the low package-to-PCB thermal resistance, the internal temperature closely tracks the PCB temperature. Be aware that device self-heating increases the internal temperature relative to the surrounding PCB.

9.3.1.4 Power-Supply Readback

Read the power-supply voltage by the appropriate input multiplexer selection. The supply voltages are divided to reduce the voltage levels to within the ADC input range. The analog and digital supply readback levels are scaled by Equation 3 and Equation 4, respectively:

Analog supply
$$(V) = (AVDD - AVSS) / 4$$
 (3)

Digital supply
$$(V) = DVDD / 4$$
 (4)

Measure the power supply voltages with either the internal or an external reference. If using an external reference, the minimum reference voltage is 1.5 V. Perform the measurement with PGA enabled, gain = 1, burnout current sources disabled and ac-excitation mode disabled. See Figure 48 for register settings to measure the supply voltages.

9.3.1.5 Inputs Open

This configuration opens all inputs. Use this configuration to test the functionality of the sensor burn-out current sources, and the PGA output monitors. When the inputs are open, the current sources drive the PGA inputs to full scale, resulting in an PGA monitor alarm and clipped conversion data. See Figure 48 for register settings to open all inputs.

9.3.1.6 Internal V_{COM} Connection

For this multiplexer configuration, all inputs are open and the PGA inputs are connected to an internal V_{COM} voltage as defined: (AVDD + AVSS) / 2. Use this mode to measure the ADC noise performance and offset voltage, or to short the inputs for offset calibration. See Figure 48 for register settings of the internal V_{COM} connection.



Feature Description (continued)

9.3.1.7 Alternate Functions

The ADC has several alternate functions that are multiplexed with the analog inputs. The alternate functions are reference input, current source output, GPIO, ac-excitation and level-shift voltage output. The functions are enabled by programming of the associated registers. The analog inputs retain measurement ability if the alternate functions are programmed. Table 3 summarizes the alternate functions.

Table 3. Analog Input Alternate Functions

ANALO	OG INPUTS	REFERENCE INPUTS	CURRENT SOURCES	GPIO/AC-EXCITATION ⁽¹⁾	LEVEL-SHIFT
ADS1260	ADS1261	REFERENCE INPUTS	CURRENT SOURCES	GPIO/AC-EXCITATION.	VOLTAGE
AINCOM	AINCOM	_	yes	_	yes
AIN0	AIN0	REFP0	yes	_	_
AIN1	AIN1	REFN0	yes	_	_
AIN2	AIN2	REFP1 (1)	yes	GPIO0/ACX1	_
AIN3	AIN3	REFN1 ⁽¹⁾	yes	GPIO1/ACX2	_
AIN4	AIN4	_	yes	GPIO2/ACX1	_
_	AIN5	_	yes	GPIO3/ACX2	_
_	AIN6	_	yes	_	_
_	AIN7	_	yes	_	_
_	AIN8	_	yes	_	_
_	AIN9	_	yes	_	_

⁽¹⁾ ADS1261 and ADS1261B only.

9.3.2 PGA

The PGA is a low-noise, CMOS differential-input, differential-output amplifier. The PGA extends the dynamic range of the ADC, important when used with low level sensors. The PGA provides gains of 1 through 32 and the ADC provides additional gains of 2 and 4. The combined gains are 1 through 128. Gain is controlled by the GAIN[2:0] register bits as shown in the Figure 49. In PGA bypass mode, the input voltage range extends to the analog supplies. The PGA is powered down in bypass mode.

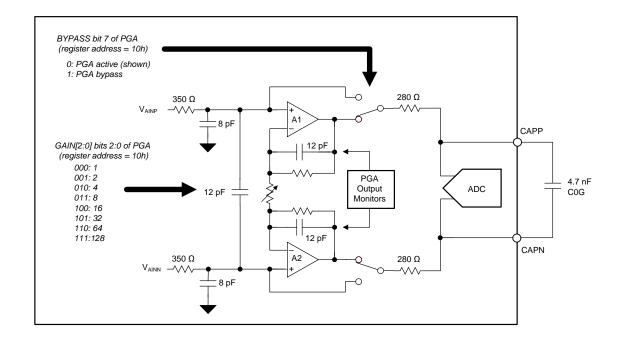


Figure 49. PGA Block Diagram



The PGA consists of two chopper-stabilized amplifiers (A1 and A2), and a resistor network that determines the PGA gain. The resistor network is precision matched, providing low drift performance. The PGA integrates noise filters to reduce sensitivity to electromagnetic-interference (EMI). The PGA output is monitored to indicate when the operating headroom is exceeded.

Pins CAPP and CAPN are the PGA positive and negative outputs, respectively. Connect an external 4.7-nF capacitor (type C0G) as shown in Figure 49. The capacitor filters the modulator sample pulses and with the internal resistors, forms the antialias filter. Place the capacitor as close as possible to the pins using short traces. Avoid running clock traces or other digital traces close to these pins.

The full-scale differential input voltage range of the ADC is determined by the reference voltage and gain. Table 4 shows the differential input voltage range verses gain for $V_{RFF} = 2.5 \text{ V}$.

ruble 4.1 dii Godie Voltage Rulige								
GAIN[2:0] BITS	GAIN	FULL-SCALE DIFFERENTIAL INPUT RANGE ⁽¹⁾						
000	1	±2.500 V						
001	2	±1.250 V						
010	4	±0.625 V						
011	8	±0.312 V						
100	16	±0.156 V						
101	32	±0.078 V						
110	64	±0.039 V						
111	128	±0.0195 V						

Table 4. Full-Scale Voltage Range

As with many amplifiers, the PGA has an input voltage range limitation that must not be exceeded in order to maintain linear operation. The specified input voltage range is expressed as the absolute voltage at the positive and negative inputs. As specified in Equation 5, the specified absolute input voltage depends on gain, the expected maximum differential voltage, and the minimum analog power-supply voltage.

AVSS + 0.3 V +
$$V_{IN}$$
 · (Gain - 1) / 2 · < V_{AINP} and V_{AINN} < AVDD - 0.3 V - V_{IN} · (Gain - 1) / 2

where

- V_{AINP}, V_{AINN} = absolute input voltage
- V_{IN} = maximum differential input voltage = V_{AINP} V_{AINN}
- Gain (for gains = 64 and 128, use gain = 32 in the calculation)
- AVDD = minimum AVDD voltage
- AVSS = maximum AVSS voltage

(5)

⁽¹⁾ $V_{REF} = 2.5 \text{ V}$. Full scale differential input voltage range is proportional to V_{REF} .



The relationship of the PGA input to the PGA output is shown graphically in Figure 50. The PGA output voltages (V_{OUTP}, V_{OUTN}) depend on the respective absolute input voltage, the differential input voltage, and the PGA gain. To maintain the PGA within the linear operating range, the PGA output voltages must not exceed either AVDD – 0.3 V or AVSS + 0.3 V. The diagram depicts a positive differential input voltage that results in a positive differential output voltage.

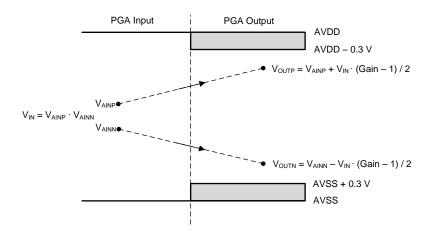


Figure 50. PGA Input/Output Range

9.3.2.1 PGA Bypass Mode

Bypass the PGA to extend the input voltage range up to the analog power supply voltages. In bypass mode, the PGA is bypassed and the analog inputs are connected directly to the precharge buffers of the modulator, thereby extending the input voltage range. Be aware of the increased analog input current in bypass mode. See the *Recommended Operating Conditions* for the bypass-mode input voltage range specification, and see the *Electrical Characteristics* for the input current specification.

9.3.2.2 PGA Voltage Monitor

The PGA has voltage monitors to provide indication when the PGA is overloaded. In overload condition, the conversion data are no longer valid. If either the PGA positive or negative output exceeds AVDD – 0.2 V, the high alarm bit is set (PGAH_ALM). Similarly, if either PGA positive or negative output is less than AVSS + 0.2 V, the low alarm bit is set (PGAL_ALM). The monitor alarm state is read in the STATUS byte. The monitor alarm is read-only and automatically resets at the start of the next conversion cycle after the overload condition is cleared. The monitor diagram and threshold values are shown in Figure 51 and Figure 52.

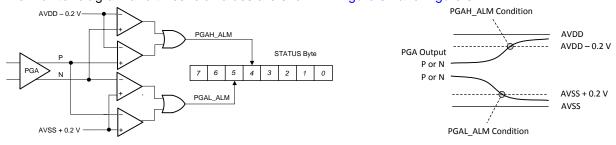


Figure 51. PGA Monitor Diagram

Figure 52. PGA Monitor Thresholds

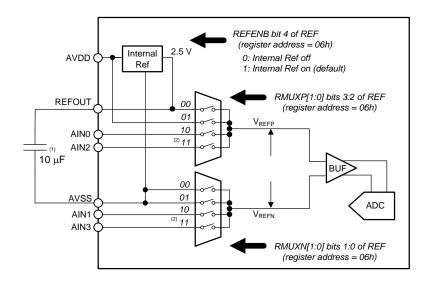
The PGA monitors consist of fast-responding voltage comparators. Comparator operation is disabled during multiplexer changes to minimize the false triggering during these input switching events. However, it is possible the monitors can detect other transient overload conditions that may occur after gain changes, sensor connection changes, and so on.

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9.3.3 Reference Voltage

The ADC requires a reference voltage for operation. The reference voltage options are 2.5-V internal, one or two external inputs (ADS1260 or ADS1261, respectively) or the 5-V analog power supply. The reference voltage is selected by independent positive and negative reference multiplexers for the reference positive and reference negative voltages, respectively. The default reference is the 5-V analog power supply (AVDD – AVSS). Figure 53 shows the block diagram of the reference multiplexer.



- (1) The internal reference requires a 10-µF capacitor connected to pins REFOUT and AVSS.
- (2) ADS1261 only.

Figure 53. Reference Input Diagram

Program the RMUXP[1:0] and RMUXN[1:0] bits of the REF register to select the positive and negative reference voltages, respectively. The positive reference selections are internal positive, AIN0, AIN2, or AVDD. The negative reference input selections are internal negative, AIN1, AIN3, or AVSS. The reference low-voltage monitor is located after the reference multiplexer. See the *Reference Monitor* section for more information.

9.3.3.1 Internal Reference

The ADC incorporates a 2.5-V reference that is enabled by the REFENB bit of the REF register (default = off). Program the reference multiplexer bits RMUXP[1:0] and RMUXN[1:0] to 00b to select the internal reference. A 10- μ F capacitor is required between pins REFOUT and AVSS to filter reference noise. REFOUT is the reference output and AVSS is the reference return. Use a star-layout connection or plane connection for the reference return, connecting close to the AVSS pin. When the reference is enabled, be aware of the settling time before beginning conversions. Also be aware of the reference inrush current that may result in a transient droop of the AVDD voltage. Enable the internal reference for sensor excitation current source operation.

9.3.3.2 External Reference

Use an external reference by applying the reference voltage to the designated analog inputs. The reference inputs are differential with positive and negative inputs. Program the reference multiplexer bits RMUXP[1:0] and RMUXN[1:0] to 10b or 11b to select inputs AINO/AIN1 or AIN2/AIN3, respectively (AIN2/AIN3 is available only for the ADS1261). For application that use multiple references, it is possible to connect the reference grounds together and use a single input pin for ground. Follow the specified absolute and differential reference voltage operating conditions, as specified in the *Recommended Operating Conditions*. Connect a 100-nF capacitor across the reference input pins to filter noise. Be aware of the reference input current if reference impedances are present. Consider the error to the overall system accuracy.

Product Folder Links: ADS1260 ADS1261



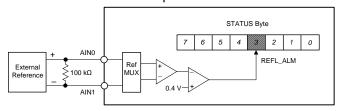
9.3.3.3 AVDD - AVSS Reference (Default)

A third reference option is the 5-V analog power supply (AVDD - AVSS). Select this reference option by setting the reference multiplexer bits RMUXP[1:0] and RMUXN[1:0] to 01b. For a 6-wire load cell application that uses excitation sense lines, or for ac-excitation operation, connect the excitation sense lines to the analog input reference inputs and program the ADC for external reference operation.

9.3.3.4 Reference Monitor

The ADC incorporates a reference monitor that detects an invalid reference voltage. As shown in Figure 54 and Figure 55, if the reference voltage ($V_{REF} = V_{REFP} - V_{REFN}$) is below 0.4 V, the REFL_ALM bit is set in the STATUS byte. The alarm is read-only and resets at the next conversion after the low reference condition is cleared.

Use the reference monitor to detect a missing or failed reference voltage. To implement detection of a missing reference, use a $100\text{-k}\Omega$ resistor across the reference inputs. If either input is unconnected, the resistor biases the differential reference input towards 0 V so that the missing reference can be detected.



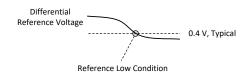


Figure 54. Reference Monitor

Figure 55. Reference Monitor Threshold

9.3.4 Level-Shift Voltage (VBIAS)

The ADC integrates a level-shift voltage that can be connected to the AINCOM pin by an internal switch. As shown in Figure 56, the level-shift voltage is the mid-voltage between AVDD and AVSS. The purpose of the voltage is to shift the signal level of floating sensors to within the input range of the ADC. Isolated thermocouples and piezoelectric sensors are examples of sensors that are suitable for connection to the level-shift voltage. For these sensors, connect the negative lead to the AINCOM pin and enable the level-shift voltage.

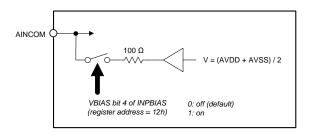


Figure 56. Level-Shift Voltage Diagram

The turn-on time of the level-shift voltage depends on the total external capacitance connected from the AINCOM pin to ground or AVSS. Table 5 lists the level-shift voltage settling times for various load capacitance. Be certain the level-shift voltage is fully settled before starting a conversion.

Table 5. Level-Shift Enable Time

LOAD CAPACITANCE	LEVEL-SHIFT VOLTAGE SETTLING TIME
0.1 μF	0.22 ms
1 μF	2.2 ms
10 μF	22 ms

Product Folder Links: ADS1260 ADS1261



9.3.5 Burn-Out Current Sources

The burn-out current sources are used to detect the occurrence of sensor burn-out or break. If the sensor or sensor connection is open, the currents drive either or both positive and negative PGA inputs to opposite supply voltages where the occurrence of an open sensor is detected by the PGA monitors or detected by the host for out-of-range (or clipped) conversion data.

Figure 57 shows the burn-out currents connect at the output of the analog input multiplexer. The currents sink and source, and are configurable in pullup or pulldown mode. In pullup mode, the sourcing current connects to the positive input channel and the sinking current connects to the negative input channel. In this configuration, an open circuit pulls the inputs to positive full scale. The currents are Off, 0.050 μ A, 0.2 μ A, 1 μ A, and 10 μ A. See the *Burn-out Current Source* section for application information.

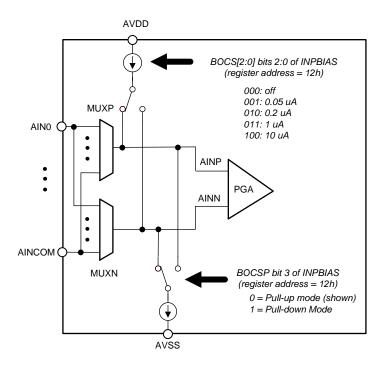


Figure 57. Burn-Out Current Sources



9.3.6 Sensor-Excitation Current Sources (IDAC1 and IDAC2)

The ADC incorporates two current sources that are used to provide excitation current to a resistive temperature device (RTD), thermistor, diode and other sensor type that require constant current biasing. The currents are programmable over the 50 μ A to 3000 μ A range and are internally multiplexed to all analog input pins. The current source multiplexer is shown in Figure 58. The IMUX1 and IMUX2 register bits connect the corresponding current source to the analog inputs. The IMAG1 and IMAG2 register bits program the corresponding current magnitude.

Enable the internal reference for current source operation. The current source value can be doubled or an intermediate value produced by connecting the current sources to the same analog input. Take care not to exceed the current source compliance voltage range. That is, when the current source is loaded by resistance, the voltage at the pin increases and must not exceed specification; otherwise the specified current source accuracy is not met.

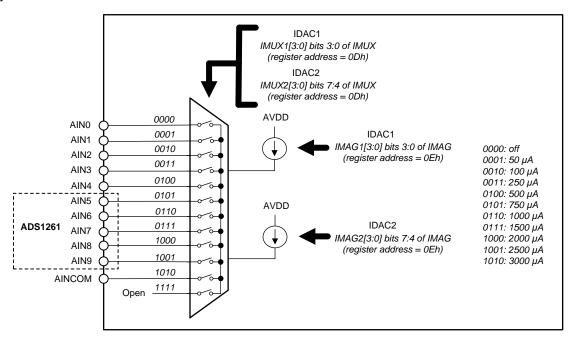


Figure 58. Current Source Connection



9.3.7 General-Purpose Input/Outputs (GPIOs)

The ADS1261 and ADS1261B devices provide four GPIO pins, GPIO0 through GPIO3. The GPIOs are digital inputs/outputs that are referenced to analog AVDD and AVSS. The GPIOs are read and written by the GPIO_DAT bits of register MODE3. The GPIOs are multiplexed with analog inputs AIN2 to AIN5. As shown in Figure 59, the GPIOs have a series of programming registers. Bits GPIO_CON[3:0] connect the GPIOs to the associated pin (1 = connect). Bits GPIO_DIR program the direction of the GPIOs; (0 = output, 1 = input). The input voltage threshold is the voltage value between AVDD and AVSS. Bits GPIO_DAT[3:0] are the data values for the GPIOs. Observe that if a GPIO pin is programmed as an output, the value read is the value previously written to the register data, not the actual state of the pin.

The GPIOs also provide the ac-excitation drive signals. AC-excitation mode override the GPIO register data values. See the *AC-Excitation Mode* section for details.

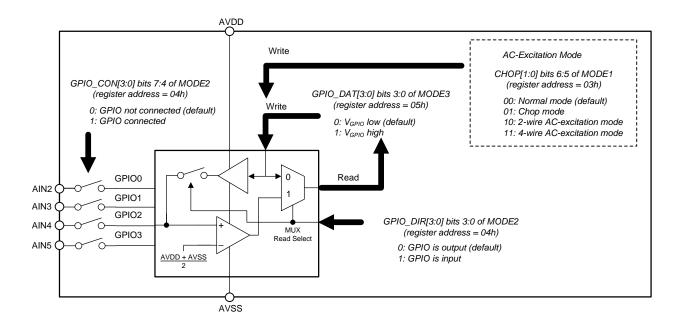


Figure 59. GPIO Block Diagram

9.3.8 Oversampling

The ADC operates on the principle of oversampling, defined as the ratio of the sample rate of the modulator to that of the ADC output data rate. Oversampling improves ADC noise by digital bandwidth limiting (low-pass filtering) of the data. The digital filter also performs data rate reduction (decimation) in order to reduce the data rate proportional with the amount of data filtering.

9.3.9 Modulator

The modulator is an inherently stable, fourth-order, 2+2 pipelined $\Delta\Sigma$ modulator. The modulator samples the analog input voltage at a high sample rate ($f_{MOD} = f_{CLK} / 8$) and converts the analog input to a ones-density bit-stream given by the ratio of the input signal to the reference voltage. The modulator shapes the noise of the converter to high frequency, where the noise is removed by the digital filter.



9.3.10 Digital Filter

The digital filter receives the modulator output data and produces a high-resolution conversion result. The digital filter low-pass filters and decimates the modulator data (data rate reduction), yielding the final data output. By adjusting the type of filtering, tradeoffs are made between resolution, data throughput and line cycle rejection.

The digital filter has two selectable modes: $\sin(x) / x$ (sinc) mode and finite impulse response (FIR) mode (see Figure 60). The sinc mode provides data rates of 2.5 SPS through 40000 SPS with variable sinc orders of 1 through 5. The FIR filter provides simultaneous rejection of 50-Hz and 60-Hz frequencies with data rates 2.5 SPS through 20 SPS while providing single-cycle settled conversions.

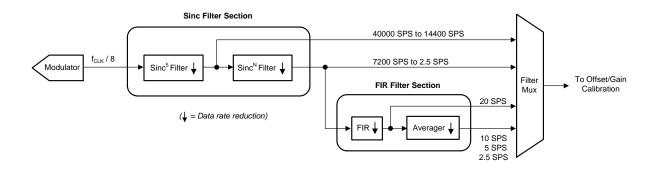


Figure 60. Digital Filter Block Diagram

9.3.10.1 Sinc Filter

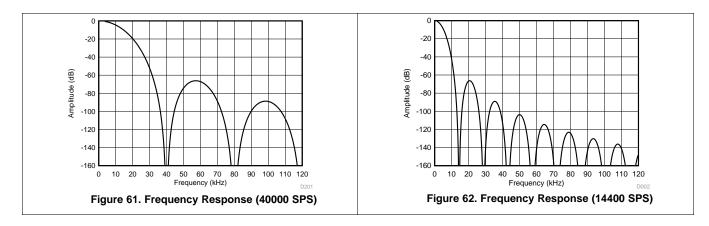
The sinc filter is composed of two stages: a variable-decimation sinc5 filter, followed by a variable-decimation, variable-order sinc filter. The first stage filters and down-samples the modulator data to yield data rates of 40000 SPS, 25600 SPS, 19200 SPS, and 14400 SPS. These data rates bypass the second stage and as a result have a sinc5 characteristic filter response. The second stage receives data from the first stage at a fixed rate of 14400 SPS. The data rate is reduced to the range 7200 SPS to 2.5 SPS, with programmable orders of sinc.

The data rate is programmed by the DR[4:0] bits of register MODE0. The filter mode is programmed by the FILTER[2:0] bits of register MODE0 (see Table 32).

9.3.10.1.1 Sinc Filter Frequency Response

The characteristic of the sinc filter is low pass. The filter reduces noise present in the signal and noise present within the ADC. Changing the data rate and filter order changes the filter bandwidth.

As shown in Figure 61 and Figure 62, the first-stage sinc5 filter has frequency response nulls occurring at N \cdot f_{DATA}, where N = 1, 2, 3 and so on. At the null frequencies, the filter has zero gain. Data rates of 25600 SPS and 19200 SPS have similar frequency response.



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The second stage superimposes frequency response nulls to the nulls of the first stage 14400 SPS output. The first of the superimposed response nulls occurs at the data rate, followed by nulls occurring at multiples of the data rate. Figure 63 illustrates the frequency response for various orders of sinc at data rate of 2400 SPS. This data rate has five nulls between the larger nulls at multiples of 14400 Hz. This frequency response is similar to that of data rates 2.5 SPS to 7200 SPS. Figure 64 shows the frequency response nulls for 10 SPS.

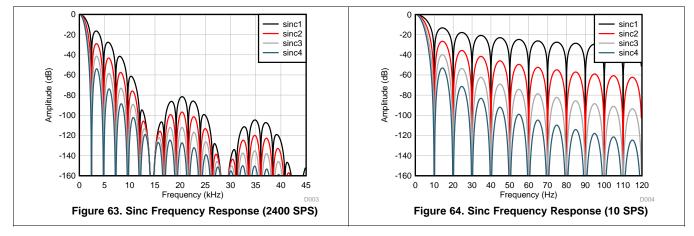


Figure 65 and Figure 66 show the frequency response of data rates 50 SPS and 60 SPS, respectively. Increase the attenuation at 50 Hz or 60 Hz and harmonics by increasing the order of the sinc filter, as shown in the figures.

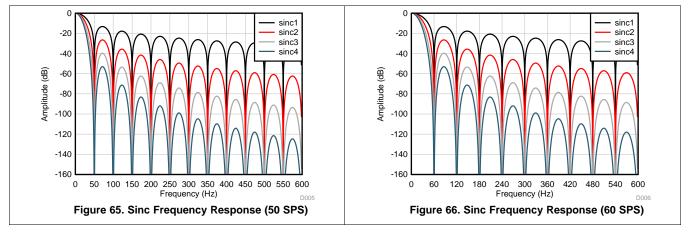
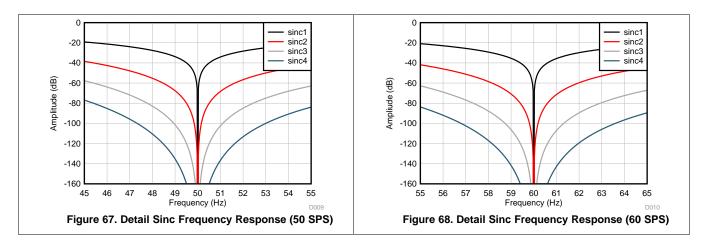


Figure 67 and Figure 68 show the detailed frequency response at 50 SPS and 60 SPS, respectively.





9.3.10.2 FIR Filter

The finite impulse response (FIR) filter is a coefficient based filter architecture that provides an overall low-pass filter response. The filter provides simultaneous attenuation of 50 Hz and 60 Hz and harmonics at data rates of 20 SPS to 2.5 SPS. The conversion latency time of the FIR filter data rates are single-cycle. As shown in Figure 60, the FIR filter receives pre-filtered data from the sinc filter. The FIR filter decimates the data to yield the output data rates of 20 SPS. A variable averager (sinc1) provides data rates of 10 SPS, 5 SPS, and 2.5 SPS. Table 6 lists the bandwidth of the data rates in FIR filter mode.

9.3.10.2.1 FIR Filter Frequency Response

Figure 69 and Figure 70 show the FIR filter frequency attenuates 50 Hz and 60 Hz by a series of response nulls placed close to these frequencies. The response nulls are repeated at harmonics of 50 Hz and 60 Hz.

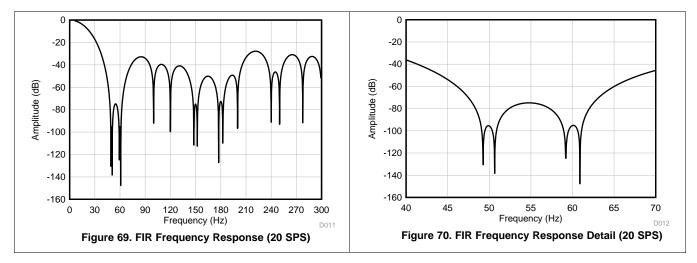


Figure 71 is the FIR filter response at 10 SPS. As a result of the variable averager, new frequency nulls are superimposed. The first null appears at the date rate. Additional nulls occur at frequencies folded around multiples of 20 Hz.

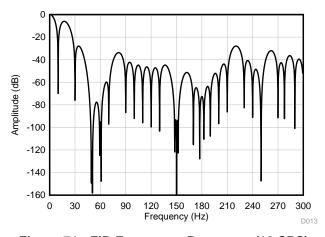


Figure 71. FIR Frequency Response (10 SPS)



9.3.10.3 Filter Bandwidth

The bandwidth of the filter depends on the data rate and the filter mode. Be aware that the bandwidth of the entire system is the combined response of the filter, the antialias filter and external filters. Table 6 lists the bandwidth versus data rate and filter mode. Table 6 also lists the filter modes available for each data rate.

Table 6. Filter Bandwidth

DATA RATE	-3-dB BANDWIDTH (Hz)							
(SPS)	FIR	SINC1	SINC2	SINC3	SINC4	SINC5		
2.5	1.2	1.10	0.80	0.65	0.58	_		
5	2.4	2.23	1.60	1.33	1.15	_		
10	4.7	4.43	3.20	2.62	2.28	_		
16.6		7.38	5.33	4.37	3.80	_		
20	13	8.85	6.38	5.25	4.63	_		
50	_	22.1	16.0	13.1	11.4	_		
60		26.6	19.1	15.7	13.7	_		
100		44.3	31.9	26.2	22.8	_		
400		177	128	105	91.0	_		
1200	_	525	381	314	273	_		
2400	_	1015	751	623	544	_		
4800	_	1798	1421	1214	1077	_		
7200	_	2310	1972	1750	1590	_		
14400	_	_	_	_	_	2940		
19200				_	_	3920		
25600				_	_	5227		
40000	_	_	_	_	_	8167		



9.3.10.4 50-Hz and 60-Hz Normal Mode Rejection

To reduce 50-Hz and 60-Hz noise interference, configure the conversion period to reject the noise at 50 Hz and 60 Hz. 50-Hz and 60-Hz noise rejection depends on the filter type. Table 7 summarizes the 50-Hz and 60-Hz noise rejection versus data rate and filter type. The table values are based on 2% and 6% tolerance of noise frequency to ADC clock frequency. For the sinc filter mode, noise rejection is increased by increasing the order of the filter. Common mode noise is also rejected at these frequencies.

Table 7. 50-Hz and 60-Hz Normal Mode Rejection

			DIGITAL FILTER	RESPONSE (dB)	
DATA RATE (SPS)	FILTER TYPE	50 Hz ±2%	60 Hz ±2%	50 Hz ±6%	60 Hz ±6%
2.5	FIR	-113	-99	-88	-80
2.5	Sinc1	-36	-37	-40	-37
2.5	Sinc2	-72	-74	-80	-74
2.5	Sinc3	-108	-111	-120	-111
2.5	Sinc4	-144	-148	-160	-148
5	FIR	-111	-95	-77	-76
5	Sinc1	-34	-34	-30	-30
5	Sinc2	-68	-68	-60	-60
5	Sinc3	-102	-102	-90	-90
5	Sinc4	-136	-136	-120	-120
10	FIR	-111	-94	-73	-68
10	Sinc1	-34	-34	-25	-25
10	Sinc2	-68	-68	-50	-50
10	Sinc3	-102	-102	-75	- 75
10	Sinc4	-136	-136	-100	-100
16.6	Sinc1	-34	-21	-24	-21
16.6	Sinc2	-68	-42	-48	-42
16.6	Sinc3	-102	-63	-72	-63
16.6	Sinc4	-136	-84	-96	-84
20	FIR	-95	-94	-66	-66
20	Sinc1	-18	-34	-18	-24
20	Sinc2	-36	-68	-36	-48
20	Sinc3	-54	-102	-54	-72
20	Sinc4	-72	-136	-72	-96
50	Sinc1	-34	-15	-24	-15
50	Sinc2	-68	-30	-48	-30
50	Sinc3	-102	-45	-72	-45
50	Sinc4	-136	-60	-96	-60
60	Sinc1	-13	-34	-12	-24
60	Sinc2	-27	-68	-24	-48
60	Sinc3	-40	-102	-36	-72
60	Sinc4	-53	-136	-48	-96



9.4 Device Functional Modes

9.4.1 Conversion Control

Conversions are controlled by either the START pin or by the START command. If using commands to control conversions, keep the START pin low to avoid contentions between pin and commands. Commands take affect on the 16th falling SCLK edge (CRC mode disabled) or on the 32nd falling SCLK edge (CRC mode enabled). See Figure 4 for conversion-control timing details.

The ADC provides two conversion modes: continuous and pulse. The continuous-conversion mode performs conversions indefinitely until stopped by the user. Pulse-conversion mode performs one conversion and then stops. The conversion mode is programmed by the CONVRT bit (bit 4 of register MODE0).

9.4.1.1 Continuous-Conversion Mode

This conversion mode performs continuous conversions until stopped by the user. To start conversions, take the START pin high or send the START command. DRDY is driven high at the time the conversion is initiated. DRDY is driven low when the conversion data are ready. Conversion data are available to read at that time. Conversions are stopped by taking the START pin low or by sending the STOP command. When conversions are stopped, the conversion in progress runs to completion. To restart a conversion that is in progress, toggle the START pin low-then-high or send a new START command.

9.4.1.2 Pulse-Conversion Mode

In pulse-conversion mode, the ADC performs one conversion when START is taken high or when the START command is sent. When the conversion completes, further conversions stop. The DRDY output is driven high to indicate the conversion is in progress, and is driven low when the conversion data are ready. Conversion data are available to read at that time. To restart a conversion in progress, toggle the START pin low-then-high or send a new START command. Driving START low or sending the STOP command does not interrupt the current conversion.

9.4.1.3 Conversion Latency

The digital filter averages data from the modulator in order to produce the conversion result. The stages of the digital filter must have settled data in order to provide fully-settled output data. The order and the decimation ratio of the digital filter determine the amount of data averaged, and in turn, affect the latency of the conversion data. The FIR and sinc1 filter modes are zero latency because the ADC provides the conversion result in one conversion cycle. Latency time is an important consideration for the data throughput rate in multiplexed applications.

Table 8 lists the conversion latency values of the ADC. Conversion latency is defined as the time from the start of the first conversion, by taking the START pin high or sending the START command, to the time when the conversion data are ready. If the input signal is settled, then the ADC provides fully settled data under this condition. The conversion latency values listed in the table are with the start-conversion delay parameter = $50 \mu s$, and include the overhead time needed to process the data. After the first conversion completes (in continuous conversion mode), the period of the following conversions are equal to $1/f_{DATA}$. The first conversion latency in chop and ac-excitation modes are twice the values listed in the table. Also when operating in these modes, the period of the following conversions are equal to the values listed in the table.



Device Functional Modes (continued)

Table 8. Conversion Latency

DATA RATE	CONVERSION LATENCY - t _(STDR) ⁽¹⁾ (ms)							
(SPS)	FIR	SINC1	SINC2	SINC3	SINC4	SINC5		
2.5	402.2	400.4	800.4	1,200	1,600	_		
5	202.2	200.4	400.4	600.4	800.4	_		
10	102.2	100.4	200.4	300.4	400.4	_		
16.6	_	60.43	120.4	180.4	240.4	_		
20	52.23	50.43	100.4	150.4	200.4	_		
50	_	20.43	40.43	60.43	80.43	_		
60	_	17.09	33.76	50.43	67.09	_		
100	_	10.43	20.43	30.43	40.43	_		
400	_	2.925	5.425	7.925	10.43	_		
1200	_	1.258	2.091	2.925	3.758	_		
2400	_	0.841	1.258	1.675	2.091	_		
4800	_	0.633	0.841	1.050	1.258	_		
7200	_	0.564	0.702	0.841	0.980	_		
14400	_	_	_	_	_	0.423		
19200	_	_	_	_	_	0.336		
25600	_	_	_	_	_	0.271		
40000	_	_	_	_	_	0.179		

⁽¹⁾ Chop mode off, conversion-start delay = $50 \mu s$ (DELAY[3:0] = 0001)

If the input signal changes while free-running conversions, the conversion data are a mix of old and new data, as shown in Figure 72. After an input change, the number of conversion periods required for fully settled data are determined by dividing the conversion latency by the period of the data rate, plus add one conversion period to the result. In chop mode and ac-excitation mode, use twice the latency values listed in the table.

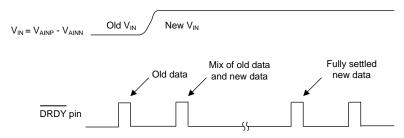


Figure 72. Input Change During Conversions

9.4.1.4 Start-Conversion Delay

Some applications may require a delay at the start of a conversion in order to allow settling time for the PGA output antialias filter or to allow time after input and configuration changes. The ADC provides a user programmable delay time that delays the start of a new conversion. The default value is 50 μ s. This allows for settling of the antialiasing filter. Use additional delay time as needed to provide settling time for external components. The delay time increases the conversion latency values listed in Table 8. As an alternative to the programmable start-conversion delay, manually delay the start of conversion after input and configuration changes.

Start-conversion delay is an important consideration for operation in ac-excitation mode. In this mode, the reference inputs to the bridge, and therefore, the bridge output signals are reversed for each conversion As a result, time delay is required to allow for settling of external filter components after reversal. As a general guideline, set the start-conversion delay parameter to a minimum of 15 times the R-C time constant of the signal input and reference input filters.



9.4.2 Chop Mode

The PGA and modulator are chopper-stabilized at high frequency in order to reduce offset voltage, offset voltage drift and 1/f noise. The offset and noise artifacts are modulated to high frequency and are removed by the digital filter. Although chopper stabilization is designed to remove all offset, a small offset voltage may remain. The optional global chop mode removes the remaining offset errors, providing exceptional offset voltage drift performance.

Chop mode alternates the signal polarity of consecutive conversions. The ADC subtracts consecutive, alternatephase conversions to yield the final conversion data. The result of subtraction removes the offset.

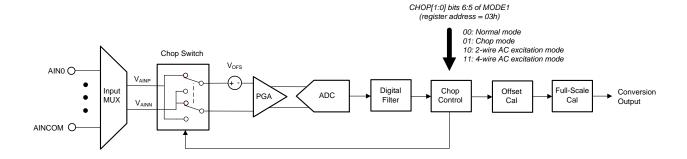


Figure 73. ADC Chop Mode

As shown in Figure 73, the internal chop switch reverses the signal after the input multiplexer. V_{OFS} models the internal offset voltage. The operational sequence of chop mode is as follows:

Conversion C1: $V_{AINP} - V_{AINN} - V_{OFS} \rightarrow$ First conversion withheld after start

Conversion C2: $V_{AINN} - V_{AINP} - V_{OFS} \rightarrow Output 1 = (C1 - C2) / 2 = V_{AINP} - V_{AINN}$

Conversion C3: $V_{AINP} - V_{AINN} - V_{OFS} \rightarrow Output 2 = (C3 - C2) / 2 = V_{AINP} - V_{AINN}$

The sequence repeats for all conversions. Because of the internal mathematical operations, the chop mode data rate is reduced. The chop mode data rate is proportional to the order of the sinc filter. Referring to Table 8, the new data rate is equal to 1 / latency values and the first conversion latency is 2 x latency values. Because of the two-point data averaging arising from the mathematical operations, noise is reduced by $\sqrt{2}$. For chop mode, divide the noise data values shown in Table 1 by $\sqrt{2}$ to derive the new noise performance data. The null frequencies of the digital filter are not changed in chop-mode operation. However, new null frequencies appear at multiples of f_{DATA} / 2.

9.4.3 AC-Excitation Mode

Resistive bridge sensors are excited by dc or ac voltages; for dc or ac currents. DC voltage excitation is the most common type of excitation. AC excitation reverses the polarity of the voltage by the use of external switching components. Similar in concept to chop mode, the result of the voltage reversal removes offset voltage in the connections leading from the bridge to the ADC inputs. This removal includes the offset voltage of the ADC itself. The ADS1261 and ADS1261B devices provide the signals necessary to drive the external switching components in order to reverse the bridge voltage.

The timing of the drive signals is synchronized to the ADC conversion phase. During one conversion phase, the voltage polarity is normal. For the alternate conversion phase, the voltage polarity is reversed. The ADC compensates the reversed polarity conversion by internal reversal of the reference voltage. The ADC subtracts the data corresponding to the normal and reverse phases in order to remove offset voltage from the input.

The ADC output drive signals do not overlap in order to avoid bridge cross-conduction that can otherwise occur during excitation voltage reversal. The switch rate of the ac-excitation drive signals are at the data rate to avoid unnecessary fast switching. See Figure 7 for output drive timing.

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Table 9 shows the ac-excitation drive signals and the associated GPIO pins. Program the ac-excitation mode using the CHOP[1:0] bits in register MODE1. AC excitation can be programmed for two-wire or four-wire drive mode. For two-wire operation, two drive signals are provided on the GPIOs. If needed, use two external inverters to derive four signals to drive discrete transistors. The GPIO drive levels are referred to the 5-V analog supply. Be aware that the ac-excitation mode changes the nominal data rate, depending on the order of the sinc filter. See the *Chop Mode* section for details of the effective data rate.

Table 9. AC-Excitation Drive Pins

DEVICE PIN	GPIO	2-WIRE MODE (CHOP[1:0] = 10)	4-WIRE MODE (CHOP[1:0] = 11)
AIN2	GPIO0	ACX1	ACX1
AIN3	GPIO1	ACX2	ACX2
AIN4	GPIO2	_	ACX1
AIN5	GPIO3	_	ACX2

9.4.4 ADC Clock Mode

Operate the ADC with an external clock or with the internal oscillator. The clock frequency is 7.3728 MHz, except for $f_{DATA} = 40000$ SPS then $f_{CLK} = 10.24$ MHz (internal or external). For external clock operation, apply the clock signal to CLKIN. For internal-clock operation, connect CLKIN to DGND. The internal oscillator begins operation immediately at power-up. The ADC automatically selects the clock mode of operation. Read the clock mode bit in the STATUS register to determine the clock mode.

9.4.5 Power-Down Mode

The ADC has two power-down modes: hardware and software. In both power-down modes, the digital outputs remain driven. The digital inputs must be maintained at V_{IH} or V_{IL} levels (do not float the digital inputs). The internal low-dropout regulator remains on, drawing 25 μ A (typical) from DVDD.

9.4.5.1 Hardware Power-Down

Take the PWDN pin low to engage hardware power-down mode. Except for the internal LDO, all ADC functions are disabled. To exit hardware power-down mode (wake-up) take the PWDN pin high. The register values are not reset at wake-up. The internal reference is shut down in this mode; therefore, be sure to accommodate the start-up time of the internal reference before starting conversions.

9.4.5.2 Software Power-Down

Set the PWDN bit (bit 7 of register MODE3) to engage software power-down mode. Similar to the operation of hardware power-down mode, software mode powers down the internal functions except the serial interface remains powered, and the internal reference bias is unchanged (On or Off). Exit the software power-down mode by clearing the PWDN bit. The register values are not reset.

9.4.6 Reset

The ADC is reset in three ways: at power-on, by the RESET pin, and by the RESET command. When reset, the serial interface, conversion-control logic, digital filter, and register values are reset. The RESET bit of the STATUS byte is set to indicate a device reset has occurred by any of the three reset methods. Clear the bit to detect the next device reset. If the START pin is high after reset, the ADC begins conversions.

9.4.6.1 Power-on Reset

At power-on, after the supply voltages cross the reset-voltage thresholds, the \underline{ADC} is reset and 2^{16} f_{CLK} cycles later the ADC is ready for communication. Until this time, \overline{DRDY} is held low. \overline{DRDY} is driven high to indicate when the ADC is ready for communication. If the START pin is high, the conversion cycle starts 512 / f_{CLK} cycle after \overline{DRDY} asserts high. Figure 5 shows the power-on reset behavior.

9.4.6.2 Reset by Pin

Reset the ADC by taking the $\overline{\text{RESET}}$ pin low and then returning the pin high. After reset, the conversion starts 512 / f_{CLK} cycles later. See Figure 6 for RESET timing.



9.4.6.3 Reset by Command

Reset the ADC by the RESET command. Toggle \overline{CS} high to make sure the serial interface resets before sending the command. For applications that tie \overline{CS} low, see the Serial Interface Auto-Reset section for information on how to reset the serial interface. After reset, the conversion starts 512 / f_{CLK} cycles later. See Figure 6 for timing details.

9.4.7 Calibration

The ADC incorporates calibration registers and associated commands to calibrate offset and full-scale errors. Calibrate by using calibration commands, or calibrate by writing to the calibration registers directly (user calibration). To calibrate by command, send the offset or full-scale calibration commands. To user calibrate, write values to the calibration registers based on calculations of the conversion data. Perform offset calibration before full-scale calibration.

9.4.7.1 Offset and Full-Scale Calibration

Use the offset and full-scale (gain) registers to correct offset or full-scale errors, respectively. As shown in Figure 74, the offset calibration register is subtracted from the output data before multiplication by the full-scale register, which is divided by 400000h. After the calibration operation, the final output data are clipped to 24 bits.

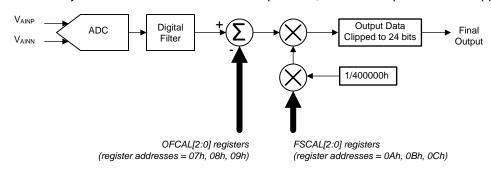


Figure 74. Calibration Block Diagram

Equation 6 shows the internal calibration.

Final Output Data = (Filter Output - OFCAL[2:0]) · FSCAL[2:0] / 400000h

9.4.7.1.1 Offset Calibration Registers

The offset calibration word is 24 bits, consisting of three 8-bit registers, as listed in Table 10. The offset value is subtracted from the conversion result. The offset value is in two's complement format with a maximum positive value equal to 7FFFFFh, and a maximum negative value equal to 800000h. A register value equal to 000000h has no offset correction. Although the offset calibration register provides a wide range of possible offset values, the input signal after calibration cannot exceed ±106% of the pre-calibrated range; otherwise, the ADC is overranged. Table 11 lists example values of the offset register.

Table 10. Offset Calibration Registers

REGISTER	BYTE ORDER	ADDRESS				віт о	RDER			
OFCAL0	LSB	07h	B7	В6	B5	B4	В3	B2	B1	B0 (LSB)
OFCAL1	MID	08h	B15	B14	B13	B12	B11	B10	В9	B8
OFCAL2	MSB	09h	B23 (MSB)	B22	B21	B20	B19	B18	B17	B16

Table 11. Offset Calibration Register Values

OFCAL[2:0] REGISTER VALUE	IDEAL OUTPUT VALUE ⁽¹⁾
000001h	FFFFFh
000000h	000000h
FFFFFh	000001h

(1) Output value with no offset error

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(6)



9.4.7.1.2 Full-Scale Calibration Registers

The full-scale calibration word is 24 bits consisting of three 8-bit registers, as listed in Table 12. The full-scale calibration value is in straight-binary format, normalized to a unity-gain factor at a value of 400000h. Table 13 lists register values for selected gain factors. Gain errors greater than unity are corrected by using full-scale values less than 400000h. Although the full-scale register provides a wide range of possible values, the input signal after calibration must not exceed ±106% of the precalibrated input range; otherwise, the ADC is overranged.

Table 12. Full-Scale Calibration Registers

REGISTER	BYTE ORDER	ADDRESS	BIT ORDER							
FSCAL0	LSB	0Ah	B7	B6	B5	B4	В3	B2	B1	B0 (LSB)
FSCAL1	MID	0Bh	B15	B15 B14 B13 B12 B11 B10 B9 B8					B8	
FSCAL2	MSB	0Ch	B23 (MSB)	B22	B21	B20	B19	B18	B17	B16

Table 13. Full-Scale Calibration Register Values

FSCAL[2:0] REGISTER VALUE	GAIN FACTOR
433333h	1.05
400000h	1.00
3CCCCCh	0.95

9.4.7.2 Offset Self-Calibration (SFOCAL)

The offset self-calibration command corrects offset errors internal to the ADC. When the offset self-calibration command is sent, the ADC disconnects the external inputs, shorts the inputs to the PGA, and then averages 16 conversion results to compute the calibration value. Averaging the data reduces conversion noise to improve calibration accuracy. When calibration is complete, the ADC restores the user input and performs one conversion using the new calibration value.

9.4.7.3 Offset System-Calibration (SYOCAL)

The offset system-calibration command corrects system offset errors. For this type of calibration, the user shorts the inputs to either the ADC or to the system. When the command is sent, the ADC averages 16 conversion results to compute the calibration value. Averaging the data reduces conversion noise to improve calibration accuracy. When calibration is complete, the ADC performs one conversion using the new calibration value.

9.4.7.4 Full-Scale Calibration (GANCAL)

The full-scale calibration command corrects gain error. To calibrate, apply a positive full-scale calibration voltage to the ADC, wait for the signal to settle, and then send the calibration command. The ADC averages 16 conversion results to compute the calibration value. Averaging the data reduces conversion noise to improve calibration accuracy. The ADC computes the full-scale calibration value so that the calibration voltage is scaled to positive full scale output code. When calibration is complete, the ADC performs one new conversion using the new calibration value.



9.4.7.5 Calibration Command Procedure

Use the following procedure to calibrate using commands. The register-lock mode must be UNLOCK for all calibration commands. After power-on, make sure the reference voltage has stabilized before calibrating. Perform offset calibration before full-scale calibration.

- 1. Configure the ADC as required.
- 2. Apply the appropriate calibration signal (zero or full-scale)
- 3. Take the START pin high or send the START command to start conversions. DRDY is driven high.
- 4. Before the conversion cycle completes, send the calibration command. Keep $\overline{\text{CS}}$ low otherwise the command is cancelled. Send no other commands during the calibration period.
- 5. Calibration time depends on the data rate and digital filter mode. See Table 14. DRDY asserts low when calibration is complete. The offset or full-scale calibration registers are updated with new values. At calibration completion, new conversion data are ready using the new calibration value.

Table 14. Calibration Time (Ins)										
DATA RATE			FILTER	MODE ⁽¹⁾						
(SPS)	FIR	SINC1	SINC2	SINC3	SINC4	SINC5				
2.5	6805	6801	7601	8401	9201	_				
5	3405	3401	3801	4201	4601	_				
10	1705	1701	1901	2101	2301	_				
16.6	_	1021	1141	1261	1381	_				
20	854.5	850.9	951.0	1051	1151	_				
50	_	340.9	380.9	420.9	460.9	_				
60	_	284.2	317.5	350.9	384.2	_				
100	_	170.9	190.9	210.9	230.9	_				
400	_	43.36	48.36	53.36	58.36	_				
1200	_	15.02	16.69	18.36	20.02	_				
2400	_	7.938	8.772	9.605	10.44	_				
4800	_	4.397	4.813	5.230	5.647	_				
7200	_	3.216	3.494	3.772	4.050	_				
14400	_	_	_	_	_	1.892				
19200	_	_	_	_	_	1.458				
25600	_	_	_	_	_	1.133				
40000	_	_	_	_	_	0.738				

Table 14. Calibration Time (ms)

9.4.7.6 User Calibration Procedure

To user calibrate, apply the calibration voltage, acquire conversion data, and compute the calibration value. The computed value is written to the corresponding calibration registers. Before starting calibration, preset the offset and full-scale registers to 000000h and 400000h, respectively.

To offset calibrate, short the ADC inputs (or inputs to the system) and average n number of the conversion results. Averaging conversion data reduces noise to improve calibration accuracy. Write the averaged value of the conversion data to the offset registers.

To gain calibrate using a full scale calibration voltage, temporarily reduce the full scale register 95% to avoid output clipped codes (set FSCAL[2:0] to 3CCCCCh). Acquire n number of conversions and average the conversions to reduce noise to improve calibration accuracy. Compute the full-scale calibration value as shown in Equation 7:

Full-Scale Calibration Value = Expected Code / Actual Code \cdot 400000h

where

• Expected code = 799998h using full scale calibration signal and 95% scale factor

(7)

⁽¹⁾ Nominal clock frequency. Chop and AC-Excitation modes disabled.



9.5 Programming

9.5.1 Serial Interface

The serial interface is SPI-compatible and is used to read conversion data, configure registers, and control the ADC. The serial interface consists of four control lines: \overline{CS} , SCLK, DIN, and DOUT/ \overline{DRDY} . Most microcontroller SPI peripherals can operate with the ADC. The interface operates in SPI mode 1, where CPOL = 0 and CPHA = 1. In SPI mode 1, SCLK idles low and data are updated or changed on SCLK rising edges; data are latched or read on SCLK falling edges. Timing details of the SPI protocol are found in Figure 1 and Figure 2.

9.5.1.1 Chip Select (CS)

 $\overline{\text{CS}}$ is an active-low input that selects the serial interface for communication. $\overline{\text{CS}}$ must be low during the entire data transaction. When $\overline{\text{CS}}$ is taken high, the serial interface resets, SCLK input activity is ignored (blocking commands), and DOUT/ $\overline{\text{DRDY}}$ enters the high-impedance state. The operation of $\overline{\text{DRDY}}$ is not effected by $\overline{\text{CS}}$. If the ADC is a single device connected to the serial bus, $\overline{\text{CS}}$ can be tied low in order to reduce the serial interface to three lines.

9.5.1.2 Serial Clock (SCLK)

SCLK is the serial clock input that shifts data into and out of the ADC. Output data are updated on the rising edge of SCLK and input data are latched on the falling edge of SCLK. Return SCLK low after the data operation is completed. SCLK is a Schmidt-triggered input designed to improve noise immunity. Even though SCLK is noise resistant, keep SCLK as noise-free as possible to avoid unintentional SCLK transitions. Avoid ringing and overshoot on the SCLK input. Place a series termination resistor close to the SCLK drive pin to reduce ringing.

9.5.1.3 Data Input (DIN)

DIN is the serial data input to the ADC. DIN is used to input commands and register data to the ADC. Data are latched on the falling edge of SCLK.

9.5.1.4 Data Output/Data Ready (DOUT/DRDY)

The DOUT/DRDY pin is a dual-function output. The functions of this pin are data output and data ready. The functionality changes automatically based on whether a read data operation is in progress. During a read data operation, the functionality is data output. After the read operation is complete, the functionality changes to data ready.

In data output mode, data are updated on the SCLK rising edge, therefore the host latches the data on the falling edge of SCLK. In data-ready mode, the pin functions the same as DRDY (if CS is low) by asserting low when data are ready. Therefore, monitor either DOUT/DRDY or DRDY to determine when data are ready. When CS is high, the DOUT/DRDY pin is in the high-impedance mode (tri-state).

9.5.1.5 Serial Interface Auto-Reset

The serial interface is reset by taking \overline{CS} high. Applications that tie \overline{CS} low do not have the ability to reset the serial interface by \overline{CS} . If a false SCLK occurs (for example, caused by a noise pulse or clocking glitch), the serial interface may inadvertently advance one or more bit positions, resulting in loss of synchronization to the host. If loss of synchronization occurs, the ADC interface does not respond correctly until the interface is reset.

For applications that tie $\overline{\text{CS}}$ low, the serial interface auto-reset feature recovers the interface in the event that an unintentional SCLK glitch occurs. When the first SCLK low-to-high transition occurs (either caused by a glitch or by normal SCLK activity), seven SCLK transitions must occur within 65536 f_{CLK} cycles (8.9 ms) to complete the byte transaction, otherwise the serial interface resets. After reset, the interface is ready to begin the next byte transaction. If the byte transaction is completed within the 65536 f_{CLK} cycles, the serial interface does not reset. The cycle of SCLK detection re-starts at the next rising edge of SCLK. The serial interface is reset by holding SCLK low for a minimum 65536 f_{CLK} cycles.

The auto-reset function is enabled by the SPITIM bit (default is off). See Figure 3 for timing details.

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Programming (continued)

9.5.2 Data Ready (DRDY)

DRDY is an output that asserts low when conversion data are ready. After power-up, DRDY also indicates when the ADC is ready for communication. The operation of DRDY depends on the <u>conversion</u> mode (continuous or pulse) and whether the conversion data are retrieved or not. Figure 75 shows DRDY operation with and without data retrieval in the two modes of conversion.

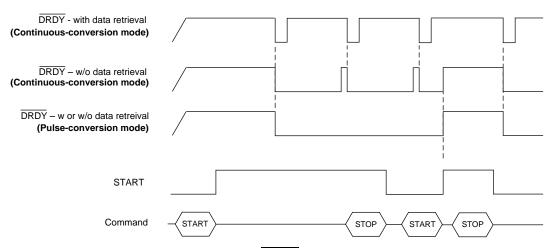


Figure 75. DRDY Operation

9.5.2.1 DRDY in Continuous-Conversion Mode

In continuous-conversion mode, \overline{DRDY} is driven high when conversions are started and is driven low when conversion data are ready. During data readback, \overline{DRDY} returns high at the end of the read operation. If the conversion data are not read, \overline{DRDY} pulses high 16 f_{CLK} cycles prior to the next falling edge.

To read conversion data before the next conversion is ready, send the complete read-data command 16 f_{CLK} cycles before the next \overline{DRDY} falling edge. If the readback command is sent less than 16 f_{CLK} cycles before the \overline{DRDY} falling edge, either old or new conversion data are provided, depending on the timing of when the command is sent. In the case that old conversion data are provided, \overline{DRDY} driven low is delayed until after the read data operation is completed. In this case, the DRDY bit of the STATUS byte is cleared to indicate the same data have been read. If new conversion data are provided, \overline{DRDY} transitions low at the normal period of the data rate. In this case, the DRDY bit of the \overline{STATUS} byte is set to indicate that new data have been read. To make sure new data are read back, wait until \overline{DRDY} asserts low before starting the data read operation.

9.5.2.2 DRDY in Pulse-Conversion Mode

DRDY is driven high at conversion start and is driven low when the conversion data are ready. During the data read operation DRDY remains low until a new conversion is started.

9.5.2.3 Data Ready by Software Polling

Use software polling of data ready in lieu of hardware polling of \overline{DRDY} or $DOUT/\overline{DRDY}$. To software poll, read the STATUS register and poll the DRDY bit. In order to not skip conversion data in continuous conversion mode, poll the bit at least as often as the period of the data rate. If the DRDY bit is set, then conversion data are new since the previous data read operation. If the bit is cleared, conversion data are not new since the previous data read operation. In this case, the previous conversion data are returned.

9.5.3 Conversion Data

Conversion data are read by the RDATA command. To read data, take $\overline{\text{CS}}$ low and issue the read data command. The data field response consists of the optional STATUS byte, three data bytes, and the optional CRC byte. The CRC is computed over the combination of status byte and conversion data bytes. See the RDATA Command for details to read conversion data.



Programming (continued)

9.5.3.1 Status byte (STATUS)

The status byte contains information on the operating state of the ADC. The STATUS byte is included with the conversion data by enabling bit STATENB of register MODE3. Optionally, read the STATUS register directly to read status information without the need to read conversion data. See Figure 81 for details.

9.5.3.2 Conversion Data Format

The conversion data are 24 bits, in two's-complement format to represent positive and negative values. The data output begins with the most significant bit (sign bit) first. The data are scaled so that $V_{\rm IN}=0$ V results in an uncalibrated code value of 000000h; positive full scale equals 7FFFFh and negative full scale equals 800000h; see Table 15 for the uncalibrated code values. The data are clipped to 7FFFFh (positive full scale) and 800000h (negative full scale) during positive and negative signal overdrive, respectively.

DESCRIPTION INPUT SIGNAL (V) 24-BIT CONVERSION DATA (1) Positive full scale $\geq V_{REF} / Gain \cdot (2^{23} - 1) / 2^{23}$ 7FFFFh 1 LSB V_{REF} / (Gain · 2²³) 000001h Zero scale 0 000000h -1 LSB -V_{REF} / (Gain · 2²³) **FFFFFFh** Negative full scale ≤-V_{REF} / Gain 800000h

Table 15. ADC Conversion Data Codes

9.5.4 CRC

Cyclic redundancy check (CRC) is an error checking code that detects communication errors to and from the host. CRC is the division remainder of the data payload bytes by a fixed polynomial. The data payload is 1, 2, 3 or 4 bytes depending on the data operation. The CRC mode is optional and is enabled by the CRCENB bit. See Table 35 to program the CRC mode.

The user computes the CRC corresponding to the two command bytes and appends the CRC to the command string (3rd byte). A 4th, zero-value byte completes the command field. The ADC repeats the CRC calculation and compares the calculation to the received CRC. If the user and repeated CRC values match, the command executes and the ADC responds by transmitting the repeated CRC during the 4th byte of the command. If the operation is conversion data or register data read, the ADC responds with a 2nd CRC that is computed over the requested data payload bytes. The response data payload is 1, 3, or 4 bytes depending on the data operation.

If the user and repeated CRC values do not match, the command does not execute and the ADC responds with an inverted CRC for the actual received command bytes. The inverted CRC is intended to signal the host of the failed operation. The user terminates transmission of the command bytes to match the action of ADC termination. The CRCERR bit is set in the STATUS register when a CRC error is detected. The ADC is ready to accept the next command after a CRC error occurs at the end of the 4th byte.

The CRC data byte is the 8-bit remainder of the bitwise exclusive-OR (XOR) operation of the argument by a CRC polynomial. The CRC polynomial is based on the CRC-8-ATM (HEC): $X^8 + X^2 + X^0 + 1$. The nine binary polynomial coefficients are: 100000111. The CRC calculation is preset with "1" data values.

The CRC mnemonics apply to the following command sections.

- CRC-2: Input CRC of command bytes 1 and 2. Except for WREG command, the value of byte 2 is arbitrary
- Out CRC-1: Output CRC of one register data byte
- Out CRC-2: Output CRC of two command bytes, inverted value if input CRC error detected
- Out CRC-3: Output CRC of three conversion data bytes
- Out CRC-4: Output CRC of three conversion data bytes plus STATUS byte
- Echo Byte 1: Echo of received input byte 1
- Echo Byte 2: Echo of received input byte 2

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⁽¹⁾ Ideal (calibrated) conversion data.



9.5.5 Commands

Commands read conversion data, control the ADC, and read and write register data. See Table 16 for the list of commands. Send only the commands that are listed in Table 16. The ADC executes commands at completion of the 2nd byte (no CRC verification) or at completion of the 4th byte (with CRC verification). Follow the two byte or four byte format according to the CRC mode. Except for register write commands, the value of the second command byte is arbitrary but the value is included in the CRC calculation (total of two-byte CRC). If a CRC error is detected, the ADC does not execute the command. Taking $\overline{\text{CS}}$ high before the command is completed results in termination of the command. When $\overline{\text{CS}}$ is taken low, the communication frame is reset to start a new command.

Table 16. Command Byte Summary

MNEMONIC	DESCRIPTION	BYTE 1	BYTE 2	BYTE 3 (CRC Mode Only)	BYTE 4 (CRC Mode only)					
Control Comn	Control Commands									
NOP	No operation	00h	Arbitrary	CRC-2	00h					
RESET	Reset	06h	Arbitrary	CRC-2	00h					
START	Start conversion	08h	Arbitrary	CRC-2	00h					
STOP	Stop conversion	0Ah	Arbitrary	CRC-2	00h					
Read Data Co	mmand			·						
RDATA	Read conversion data	12h	Arbitrary	CRC-2	00h					
Calibration Co	ommands			·						
SYOCAL	System offset calibration	16h	Arbitrary	CRC-2	00h					
GANCAL	Gain calibration	17h	Arbitrary	CRC-2	00h					
SFOCAL	Self offset calibration	19h	Arbitrary	CRC-2	00h					
Register Com	mands			·						
RREG	Read register data	20h + rrh ⁽¹⁾	Arbitrary	CRC-2	00h					
WREG	Write register data	40h + rrh ⁽¹⁾	Register data	CRC-2	00h					
Protection Co	mmands	1	<u> </u>	•	ı					
LOCK	Register lock	F2h	Arbitrary	CRC-2	00h					
UNLOCK	Register unlock	F5h	Arbitrary	CRC-2	00h					

⁽¹⁾ rrh = 5-bit register address.

9.5.5.1 NOP Command

This command is no operation. Use the NOP command to validate the CRC response byte and error detection without affecting normal operation. Table 17 shows the NOP command byte sequence.

Table 17. NOP Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	00h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	00h	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo byte 2	Out CRC-2



9.5.5.2 RESET Command

The RESET command resets ADC operation and resets the registers to default values. See the *Reset by Command* section for details. Table 18 shows the RESET command byte sequence.

Table 18. RESET Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	06h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode	•	•		
DIN	06h	Arbitrary	CRC-2	00H
DOUT/DRDY	FFh	Echo byte 1	Echo byte 2	Out CRC-2

9.5.5.3 START Command

This command starts conversions. See the *Conversion Control* section for details. Table 19 shows the START command byte sequence.

Table 19. START Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode	•			
DIN	08h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	08h	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo byte 2	Out CRC-2

9.5.5.4 STOP Command

This command stops conversions. See the *Conversion Control* section for details. Table 20 shows the STOP command byte sequence.

Table 20. STOP Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	0Ah	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	0Ah	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo byte 2	Out CRC-2

9.5.5.5 RDATA Command

This command reads conversion data. Because the data are buffered, the data can be read at any time during the conversion phase. If data are read near the completion of the next conversion, old or new conversion data are returned. See the *Data Ready* (*DRDY*) section for details.

The response of conversion data varies in length from 3 to 5 bytes depending if the STATUS byte and CRC bytes are included. See the *Conversion Data Format* section for the numeric data format. See Table 21, Figure 76 (minimum configuration) and Figure 77 (maximum configuration) for operation of the RDATA command.



Table 21. RDATA Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4	BYTE 5	BYTE 6	BYTE 7	BYTE 8	BYTE 9
No CRC mode									
DIN	12h	Arbitrary	00h	00h	00h	00h			
DOUT/DRDY	FFh	Echo byte 1	STATUS (1)	MSB data	MID data	LSB data			
CRC mode									
DIN	12h	Arbitrary	CRC-2	00h	00h	00h	00h	00h	00h
DOUT/DRDY	FFh	Echo byte 1	Echo byte 2	Out CRC-2	STATUS (1)	MSB data	MID data	LSB data	Out CRC-3 or Out CRC-4

(1) Optional STATUS byte

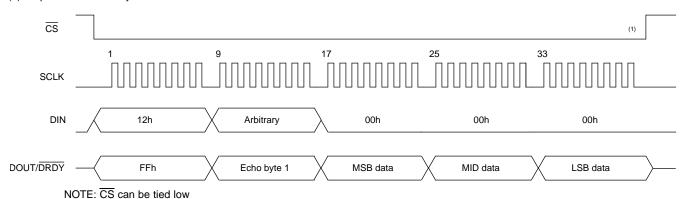


Figure 76. Conversion Data Read Operation (STATUS Byte and CRC Mode Disabled)

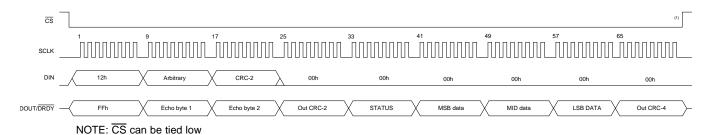


Figure 77. Conversion Data Read Operation (STATUS Byte and CRC Mode Enabled)

9.5.5.6 SYOCAL Command

This command is used for *system* offset calibration. See the *Offset System-Calibration (SYOCAL)* section for details. Table 22 shows the SYOCAL command byte sequence.

Table 22. SYOCAL Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	16h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	16h	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo Byte 2	Out CRC-2



9.5.5.7 GANCAL Command

This command is for gain calibration. See the *Full-Scale Calibration (GANCAL)* section for details. Table 23 shows the GANCAL command byte sequence.

Table 23. GANCAL Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	17h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode		•		
DIN	17h	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo Byte 2	Out CRC-2

9.5.5.8 SFOCAL Command

This command is used for *self* offset calibration. See the *Offset Self-Calibration (SFOCAL)* section for details. Table 24 shows the SFOCAL command byte sequence.

Table 24. SFOCAL Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	19h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	19h	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo Byte 2	Out CRC-2

9.5.5.9 RREG Command

Use the RREG command to read register data. The register data are read one byte at a time by issuing the RREG command for each operation. Add the register address (rrh) to the base opcode (20h) to construct the command byte (20h + rrh). Table 25 shows the command byte sequence. The ADC responds with the register data byte, most significant bit first. The response to registers outside the valid address range is 00h. Figure 78 shows an example of the register read operation. The Out CRC-1 byte is the CRC calculated for the register data byte.

Table 25. RREG Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3 BYTE 4		BYTE 5	BYTE 6
No CRC mode						
DIN	20h + rrh ⁽¹⁾	Arbitrary	00h			
DOUT/DRDY	FFh	Echo byte 1	Register data			
CRC mode						
DIN	20h + rrh	Arbitrary	CRC-2	00h	00h	00h
DOUT/DRDY	FFh	Echo byte 1	Echo byte 2	Out CRC-2	Register data	Out CRC-1

(1) rrh = 5-bit register address



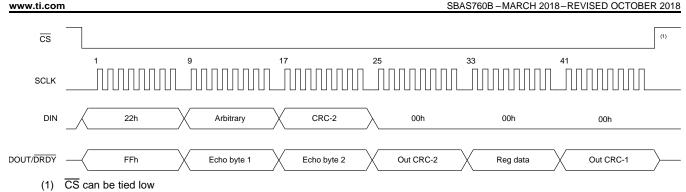


Figure 78. Register Read Operation (address = 02h, CRC Mode Enabled)

9.5.5.10 WREG Command

Use the WREG command to write register data. The register data are written one byte at a time by issuing the WREG command for each operation. Add the register address (rrh) to the base opcode (40h) to construct the command byte (40h + rrh). Table 26 shows the command byte sequence. Figure 79 shows an example of the WREG operation. Be aware that writing to certain registers results in conversion restart. Table 29 lists the registers that restart an ongoing conversion when written to. Do not write to registers outside the address range.

Table 26. WREG Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	40h + rrh ⁽¹⁾	Register data		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	40h + rrh	Register data	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1 Echo byte 2		Out CRC-2

(1) rrh = 5-bit register address.

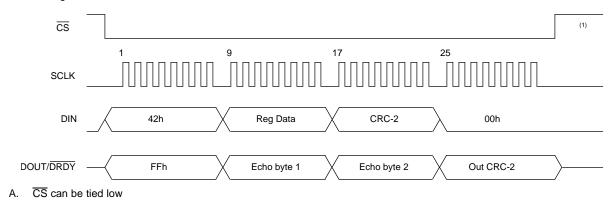


Figure 79. Register Write Operation (address = 02h, CRC Mode Enabled)



9.5.5.11 LOCK Command

The LOCK command locks-out write access to the registers including the calibration registers that are changed by calibration commands. The default mode is UNLOCK. Read access is allowed in LOCK mode. Table 27 shows the LOCK command byte sequence.

Table 27. LOCK Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	F2h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	F2h	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo Byte2	out CRC-2

9.5.5.12 UNLOCK Command

The UNLOCK command allows register write access, including access to the contents of the calibration registers that can be changed by the calibration commands. Table 28 shows the UNLOCK command byte sequence.

Table 28. UNLOCK Command

DIRECTION	BYTE 1	BYTE 2	BYTE 3	BYTE 4
No CRC mode				
DIN	F5h	Arbitrary		
DOUT/DRDY	FFh	Echo byte 1		
CRC mode				
DIN	F5h	Arbitrary	CRC-2	00h
DOUT/DRDY	FFh	Echo byte 1	Echo Byte2	Out CRC-2



9.6 Register Map

The register map consists of 19, one-byte registers. Collectively, the registers are used to configure the ADC to the desired operating mode. Access the registers by using the RREG and WREG (read-register and write-register) commands. Register data are accessed one register byte at a time for each command operation. At power-on or device reset, the registers are reset to the default values, as shown in the *Default* column of Table 29. Writing new data to certain registers causes the ADC conversion in progress to restart. These registers are listed in the *Restart* column in Table 29.

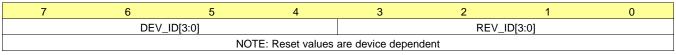
Register-write access is enabled or disabled by the UNLOCK and LOCK commands, respectively. The default mode is register UNLOCK. See the *LOCK Command* section for more details.

REGISTER DEFAULT RESTART BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 (rrh) 00h ID xxh DEV ID[3:0] REV ID[3:0] 01h **STATUS** 01h LOCK CRCERR PGAL_ALM PGAH_ALM REFL_ALM DRDY CLOCK RESET MODE0 02h 24h Yes DR[4:0] FILTER[2:0] 03h MODE1 01h Yes 0 CHOP[1:0] CONVRT DELAY[3:0] GPIO_DIR[3:0] MODE2 GPIO_CON[3:0] 04h 00h MODE3 00h **PWDN** STATENB CRCENB SPITIM GPIO_DAT[3:0] REF 05h Yes REFENB RMUXP[1:0] RMUXN[1:0] 07h OFCAL0 00h OFC[7:0] 08h OFCAL 1 00h OFC[15:8] 09h OFCAL2 00h OFC[23:16] 0Ah FSCAL0 00h FSC[7:0] 0Bh FSCAL1 00h FSC[15:8] FSCAL2 0Ch 40h FSC[23:16] 0Dh **IMUX** FFh IMUX2[3:0] IMUX1[3:0] 0Eh IMAG 00h IMAG2[3:0] IMAG1[3:0] 0Fh **RESERVED** 00h 00h 00h BYPASS 10h PGA GAIN[2:0] Yes 0 0 0 0 11h **INPMUX** FFh Yes MUXP[3:0] MUXN[3:0] 12h **INPBIAS** 00h Yes **VBIAS** BOCSP BOCS[2:0]

Table 29. Register Map Summary

9.6.1 Device Identification (ID) Register (address = 00h) [reset = xxh]

Figure 80. ID Register



LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 30. ID Register Field Descriptions

Bit	Field	Туре	Reset	Description
7:4	DEV_ID[3:0]	R	xh	Device ID
				1000: ADS1261
				1010: ADS1260B
3:0	REV_ID[3:0]	R	xh	Revision ID
				Note: Revision ID can change without notification



9.6.2 Device Status (STATUS) Register (address = 01h) [reset = 01h]

Figure 81. STATUS Register

7	6	5	4	3	2	1	0
LOCK	CRCERR	PGAL_ALM	PGAH_ALM	REFL_ALM	DRDY	CLOCK	RESET
R-0h	R/W-0h	R-0h	R-0h	R-0h	R-0h	R-xh	R/W-1h

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 31. STATUS Register Field Descriptions

Bit	Field		Reset	Description
7	LOCK	Type R	0h	•
,	LOCK	K	OH	Register Lock Status
				Indicates register lock status. Register writes are locked by the LOCK command and unlocked by the UNLOCK command.
				Register write not locked (default)
				1: Register write locked
6	CRCERR	R/W	0h	CRC Error
				Indicates that a CRC error is detected by the ADC. The CRC error bit remains set until cleared by the user.
				0: No CRC error
				1: CRC error
5	PGAL_ALM	R	0h	PGA Low Alarm
				Indicates PGA output voltage is below the low limit. The alarm resets at the start of conversion cycles.
				0: No Alarm
				1: Alarm
4	PGAH_ALM	R	0h	PGA High Alarm
				Indicates PGA output voltage is above the high limit. The alarm resets at the start of conversion cycles.
				0: No Alarm
				1: Alarm
3	REFL_ALM	R	0h	Reference Low Alarm
				Indicates reference voltage is below the low limit. The alarm resets at the start of conversion cycles.
				0: No Alarm
				1: Alarm
2	DRDY	R	0h	Data Ready
				Indicates conversion data ready.
				0: Conversion data not new since the previous read operation
				1: Conversion data new since the previous read operation
1	CLOCK	R	xh	Clock
				Indicates internal or external clock mode. The ADC automatically selects the clock source.
				0: ADC clock is internal
				1: ADC clock is external
0	RESET	R/W	1h	Reset
				Indicates ADC reset. Clear the bit to detect next device reset.
				0: No reset
				1: Reset (default)

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9.6.3 Mode 0 (MODE0) Register (address = 02h) [reset = 24h]

Figure 82. MODE0 Register



LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 32. MODE0 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7:3	DR[4:0]	R/W	4h	Data Rate
				Select the ADC data rate.
				00000: 2.5 SPS
				00001: 5 SPS
				00010: 10 SPS
				00011: 16. 6 SPS
				00100: 20 SPS (default)
				00101: 50 SPS
				00110: 60 SPS
				00111: 100 SPS
				01000: 400 SPS
				01001: 1200 SPS
				01010: 2400 SPS
				01011: 4800 SPS
				01100: 7200 SPS
				01101: 14400 SPS
				01110: 19200 SPS
				01111: 25600 SPS
				10000 - 11111: 40000 SPS (f _{CLK} = 10.24 MHz)
2:0	FILTER[2:0]	R/W	4h	Digital Filter
				Select the digital filter mode.
				000: sinc1
				001: sinc2
				010: sinc3
				011: sinc4
				100: FIR (default)
				101: Reserved
				110: Reserved
				111: Reserved



9.6.4 Mode 1 (MODE1) Register (address = 03h) [reset = 01h]

Figure 83. MODE1 Register

7	6	5	4	3	2	1	0
0	CHOP	CHOP[1:0]			DELAY[3:0]		
R/W-0h	R/W-	R/W-0h			R/W	/-1h	

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

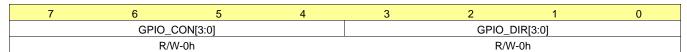
Table 33. MODE1 Register Field Descriptions

Bit	Field	Туре	Reset	Description		
7	0	R/W	0h	Reserved		
				Always write 0		
6:5	CHOP[1:0]	R/W	0h	Chop and AC-Excitation Modes		
				Select the Chop and ac-excitation modes.		
				00: Normal mode (default)		
				01: Chop mode		
				10: 2-wire ac-excitation mode (ADS1261 only)		
				11: 4-wire ac-excitation mode (ADS1261 only)		
4	CONVRT	R/W	0h	ADC Conversion Mode		
				Select the ADC conversion mode.		
				0: Continuous conversions (default)		
				1: Pulse (one shot) conversion		
3:0	DELAY[3:0]	R/W	1h	Conversion Start Delay		
				Program the time delay at conversion start. Delay values are with f _{CLK} = 7.3728 MHz.		
				0000: 0 µs (not for 25600 SPS or 40000 SPS operation)		
				0001: 50 μs (default)		
				0010: 59 μs		
				0011: 67 μs		
				0100: 85 μs		
				0101: 119 μs		
				0110: 189 μs		
				0111: 328 μs		
				1000: 605 μs		
				1001: 1.16 ms		
				1010: 2.27 ms		
				1011: 4.49 ms		
				1100: 8.93 ms		
				1101: 17.8 ms		
				1110: Reserved		
				1111: Reserved		



9.6.5 Mode 2 (MODE2) Register (address = 04h) [reset = 00h]

Figure 84. MODE2 Register



LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 34. MODE2 Register Field Descriptions⁽¹⁾

Bit	Field	Туре	Reset	Description
7	GPIO_CON[3]	R/W	Oh	GPIO3 Pin Connection Connect GPIO3 to analog input AIN5. 0: GPIO3 not connected to AIN5 (default) 1: GPIO3 connected to AIN5
6	GPIO_CON[2]	R/W	Oh	GPIO2 Pin Connection Connect GPIO2 to analog input AIN4. 0: GPIO2 not connected to AIN4 (default) 1: GPIO2 connected to AIN4
5	GPIO_CON[1]	R/W	Oh	GPIO1 Pin Connection Connect GPIO1 to analog input AIN3. 0: GPIO1 not connected to AIN3 (default) 1: GPIO1 connected to AIN3
4	GPIO_CON[0]	R/W	Oh	GPIO0 Pin Connection Connect GPIO0 to analog input AIN2 0: GPIO0 not connected to AIN2 (default) 1: GPIO0 connected to AIN2
3	GPIO_DIR[3]	R/W	Oh	GPIO3 Pin Direction Configure GPIO3 as a GPIO input or GPIO output on AIN5. 0: GPIO3 is an output (default) 1: GPIO3 is an input
2	GPIO_DIR[2]	R/W	Oh	GPIO2 Pin Direction Configure GPIO2 as a GPIO input or GPIO output on AIN4. 0: GPIO2 is an output (default) 1: GPIO2 is an input
1	GPIO_DIR[1]	R/W	Oh	GPIO1 Pin Direction Configure GPIO1 as a GPIO input or GPIO output on AIN3. 0: GPIO1 is an output (default) 1: GPIO1 is an input
0	GPIO_DIR[0]	R/W	Oh	GPIO0 Pin Direction Configure GPIO0 as a GPIO input or GPIO output on AIN2. 0: GPIO0 is an output (default) 1: GPIO0 is an input

(1) ADS1261 and ADS1261B only



9.6.6 Mode 3 (MODE3) Register (address = 05h) [reset = 00h]

Figure 85. MODE3 Register

7	6	5	4	3	2	1	0
PWDN	STATENB	CRCENB	SPITIM		GPIO_D	AT[3:0]	
R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W	/-0h	

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 35. MODE3 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7	PWDN	R/W	0h	Software Power-down Mode Select the software power-down mode. 0: Normal mode (default) 1: Software power-down mode
6	STATENB	R/W	Oh	STATUS Byte Enable the Status byte for the conversion data read operation. 0: No Status byte (default) 1: Status byte enabled
5	CRCENB	R/W	0h	CRC Data Verification Enable CRC data verification. 0: No CRC (default) 1: CRC enabled
4	SPITIM	R/W	0h	SPI Auto-Reset Function Enable the SPI auto-reset function. 0: SPI auto-reset disabled (default) 1: SPI auto-reset enabled
3	GPIO_DAT[3] ⁽¹⁾	R/W	0h	GPIO3 Data Read or write the GPIO3 data on AIN5. 0: GPIO3 is low (default) 1: GPIO3 is high
2	GPIO_DAT[2] ⁽¹⁾	R/W	Oh	GPIO2 Data Read or write the GPIO2 data on AIN4. 0: GPIO2 is low (default) 1: GPIO2 is high
1	GPIO_DAT[1] ⁽¹⁾	R/W	Oh	GPIO1 Data Read or write the GPIO1 data on AIN3. 0: GPIO1 is low (default) 1: GPIO1 is high
0	GPIO_DAT[0] ⁽¹⁾	R/W	0h	GPIO0 Data Read or write the GPIO1 data on AIN3. 0: GPIO0 is low (default) 1: GPIO0 is high

(1) ADS1261 and ADS1261B only



9.6.7 Reference Configuration (REF) Register (address = 06h) [reset = 05h]

Figure 86. REF Register

7	6	5	4	3	3 2		0
0	0	0	REFENB	RMUXP	P[1:0]	RMUX	(N[1:0]
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-1h		R/W	/-1h

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 36. REF Register Field Descriptions

Bit	Field	Туре	Reset	Description
7:5	0	R/W	0h	Reserved
				Always write 0h
4	REFENB	R/W	0h	Internal Reference Enable
				Enable the internal reference.
				0: Internal reference disabled (default)
				1: Internal reference enabled
3:2	RMUXP[1:0]	R/W	1h	Reference Positive Input
				Select the positive reference input.
				00: Internal reference positive
				01: AVDD internal (default)
				10: AIN0 external
				11: AIN2 external (ADS1261 only)
1:0	RMUXN[1:0]	R/W	1h	Reference Negative Input
				Select the negative reference input.
				00: Internal reference negative
				01: AVSS internal (default)
				10: AIN1 external
				11: AIN3 external (ADS1261 only)



9.6.8 Offset Calibration (OFCALx) Registers (address = 07h, 08h, 09h) [reset = 00h, 00h, 00h] Figure 87. OFCAL1, OFCAL2 Registers

7	6	5	4	3	2	1	0				
	OFC[7:0]										
	R/W-00h										
15	14	13	12	11	10	9	8				
			OFC	[15:8]							
			R/W	-00h							
23	22	21	20	19	18	17	16				
	OFC[23:16]										
	R/W-00h										

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 37. OFCAL0, OFCAL1, OFCAL2 Registers Field Description

Bit	Field	Туре	Reset	Description
23:0	OFC[23:0]	R/W	000000h	Offset Calibration
				These three registers are the 24-bit offset calibration word. The offset calibration is two's complement format. The ADC subtracts the offset value from the conversion result before the full-scale operation.

9.6.9 Full-Scale Calibration (FSCALx) Registers (address = 0Ah, 0Bh, 0Ch) [reset = 00h, 00h, 40h] Figure 88. FSCAL0, FSCAL1, FSCAL2 Registers

7	6	5	4	3	2	1	0				
	FSC[7:0]										
	R/W-00h										
15	14	13	12	11	10	9	8				
			FSC	[15:8]							
			R/V	V-00h							
23	22	21	20	19	18	17	16				
FSC[23:16]											
	R/W-40h										

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

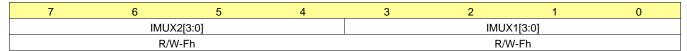
Table 38. FSCAL0, FSCAL1, FSCAL2 Registers Field Description

Bit	Field	Туре	Reset	Description
23:0	FSC[23:0]	R/W	400000h	Full-Scale Calibration
				These three registers are the 24-bit full scale calibration word. The full-scale calibration is straight binary format. The ADC divides the register value by 400000h then multiplies the result with the conversion data. The scaling operation occurs after the offset operation.



9.6.10 IDAC Multiplexer (IMUX) Register (address = 0Dh) [reset = FFh]

Figure 89. IMUX Register



LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

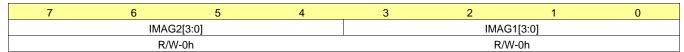
Table 39. IMUX Register Field Descriptions

D:4		ı		Passintian
Bit	Field	Туре	Reset	Description
7:4	IMUX2[3:0]	R/W	Fh	IDAC2 Output Multiplexer
				Select the IDAC2 analog input pin connection.
				0000: AIN0
				0001: AIN1
				0010: AIN2
				0011: AIN3
				0100: AIN4
				0101: AIN5 (ADS1261 only)
				0110: AIN6 (ADS1261 only)
				0111: AIN7 (ADS1261 only)
				1000: AIN8 (ADS1261 only)
				1001: AIN9 (ADS1261 only)
				1010: AINCOM
				1011: No connection
				1100: No connection
				1101: No connection
				1110: No connection
				1111: No connection (default)
3:0	IMUX1[3:0]	R/W	Fh	IDAC1 Output Multiplexer
				Select the IDAC1 analog input pin connection.
				0000: AIN0
				0001: AIN1
				0010: AIN2
				0011: AIN3
				0100: AIN4
				0101: AIN5 (ADS1261 only)
				0110: AIN6 (ADS1261 only)
				0111: AIN7 (ADS1261 only)
				1000: AIN8 (ADS1261 only)
				1001: AIN9 (ADS1261 only)
				1010: AINCOM
				1011: No connection
				1100: No connection
				1101: No connection
				1110: No connection
				1111: No connection (default)



9.6.11 IDAC Magnitude (IMAG) Register (address = 0Eh) [reset = 00h]

Figure 90. IMAG Register



LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 40. IMAG Register Field Descriptions

D:4		Tuna	•	
Bit	Field	Туре	Reset	Description
7:4	IMAG2[3:0]	R/W	0h	IDAC2 Current Magnitude
				Select the magnitude of current source IDAC2.
				0000: Off (default)
				0001: 50 μΑ
				0010: 100 μΑ
				0011: 250 μΑ
				0100: 500 μΑ
				0101: 750 μΑ
				0110: 1000 μΑ
				0111: 1500 μΑ
				1000: 2000 μΑ
				1001: 2500 μΑ
				1010: 3000 μΑ
				1011: Off
				1100: Off
				1101: Off
				1110: Off
				1111: Off
3:0	IMAG1[3:0]	R/W	0h	IDAC1 Current Magnitude
				Select the magnitude of current source IDAC1.
				0000: Off (default)
				0001: 50 μA
				0010: 100 μA
				0011: 250 μA
				0100: 500 μΑ
				0101: 750 μA
				0110: 1000 μA
				0111: 1500 μΑ
				1000: 2000 μΑ
				1001: 2500 μΑ
				1010: 3000 μΑ
				1011: Off
				1100: Off
				1101: Off
				1110: Off
				1111: Off

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9.6.12 Reserved (RESERVED) Register (address = 0Fh) [reset = 00h]

Figure 91. RESERVED Register

7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0
R-0h							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 41. RESERVED Register Field Descriptions

Bit	Field	Туре	Reset	Description	
7:0	0	R	0h	Reserved	
				These bits are read only and always return 0	

9.6.13 PGA Configuration (PGA) Register (address = 10h) [reset = 00h]

Figure 92. PGA Register

7	6	5	4	3	2	1	0
BYPASS	0	0	0	0		GAIN[2:0]	
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W-0h	

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

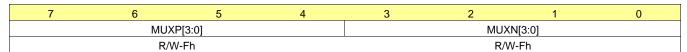
Table 42. PGA Register Field Descriptions

Bit	Field	Туре	Reset	Description
7	BYPASS	R/W	0h	PGA Bypass Mode
				Select the PGA mode.
				0: PGA mode (default)
				1: PGA bypass
6:3	0	R/W	0h	Reserved
				Always write 0
2:0	GAIN[2:0]	R/W	0h	Gain
				Select the gain.
				000: 1 (default)
				001: 2
				010: 4
				011: 8
				100: 16
				101: 32
				110: 64
				111: 128



9.6.14 Input Multiplexer (INPMUX) Register (address = 11h) [reset = FFh]

Figure 93. INPMUX Register



LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 43. INPMUX Register Field Descriptions

	I	_	T	
Bit	Field	Туре	Reset	Description
7:4	MUXP[3:0]	R/W	Fh	Positive Input Multiplexer
				Select the positive multiplexer input.
				0000: AINCOM
				0001: AIN0
				0010: AIN1
				0011: AIN2
				0100: AIN3
				0101: AIN4
				0110: AIN5 (ADS1261 only)
				0111: AIN6 (ADS1261 only)
				1000: AIN7 (ADS1261 only)
				1001: AIN8 (ADS1261 only)
				1010: AIN9 (ADS1261 only)
				1011: Internal temperature sensor positive
				1100: Internal (AVDD - AVSS) / 4 positive
				1101: Internal (DVDD / 4) positive
				1110: Inputs open
				1111: Internal connection to V _{COM} (default)
3:0	MUXN[3:0]	R/W	Fh	Negative Input Multiplexer
				Select the negative multiplexer input.
				0000: AINCOM
				0001: AIN0
				0010: AIN1
				0011: AIN2
				0100: AIN3
				0101: AIN4
				0110: AIN5 (ADS1261 only)
				0111: AIN6 (ADS1261 only)
				1000: AIN7 (ADS1261 only)
				1001: AIN8 (ADS1261 only)
				1010: AIN9 (ADS1261 only)
				1011: Internal temperature sensor negative
				1100: Internal (AVDD - AVSS) / 4 negative
				1101: Internal (DVDD / 4) negative
				1110: All inputs open
				1111: Internal connection to V _{COM} (default)

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9.6.15 Input Bias (INPBIAS) Register (address = 12h) [reset = 00h]

Figure 94. INPBIAS Register

7	6	5	4	3	2	1	0
0	0	0	VBIAS	BOCSP		BOCS[2:0]	
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/W-0h	

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 44. INPBIAS Register Field Descriptions

Bit	Field	Туре	Reset	Description
7:5	0	R/W	0h	Reserved
				Always write 0
4	VBIAS	R/W	0h	VBIAS
				Select the VBIAS connection to the AINCOM pin.
				0: VBIAS disabled (default)
				1: VBIAS enabled
3	BOCSP	R/W	0h	Burn-Out Current Source Polarity
				Select the burn-out current source polarity.
				0: Pull-up mode (default)
				1: Pull-down mode
2:0	BOCS[2:0]	R/W	0h	Burn-Out Current Source Magnitude
				Select the burn-out current source magnitude.
				000: Off (default)
				001: 50 nA
				010: 200 nA
				011: 1 μΑ
				100: 10 μΑ
				101: Reserved
				110: Reserved
				111: Reserved



10 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

10.1 Application Information

10.1.1 Input Range

In PGA mode, the input voltage must be within the specified input range for linear operation. The following exercise shows how to use Equation 5 to verify the input voltage is within specification. The exercise is a thermocouple with the negative lead connected to AINCOM and the level-shift voltage enabled (2.5 V). The gain factor = 32 and the ADC is powered by a single 5-V power supply. The summary of conditions are:

- V_{AINN} = Negative absolute input voltage = 2.5 V
- V_{AINP} = Positive absolute input voltage = 2.56 V
- V_{IN} = Differential input voltage = 60 mV
- AVDD = 4.75 V (worst-case minimum)
- AVSS = 0 V
- Gain = 32

Evaluation of the equation results in:

1.23 V < 2.5 V and 2.56 V < 3.52 V

The inequality is satisfied, therefore the absolute input voltages are within the specified PGA input range. The input requirement can also be verified by measuring the PGA output voltages (pins CAPP and CAPN) with a voltmeter. Check that both outputs are within the range: AVSS + $0.3~V < V_{(CAPP)}$ and $V_{(CAPN)} < AVDD - 0.3~V$, under the worst-case input and power-supply conditions.

10.1.2 Input Overload

Observe the input overvoltage precautions as outlined in the ESD Diodes section. If an overvoltage condition occurs on an unused channel, the overvoltage channel may crosstalk to the measurement channel. One solution is to externally clamp the inputs with low-forward voltage diodes as shown in Figure 95. The external diodes divert the overvoltage current around the ADC inputs to the power supply and ground. Be aware of the reverse leakage current of the Schottky diodes that may lead to measurement errors.

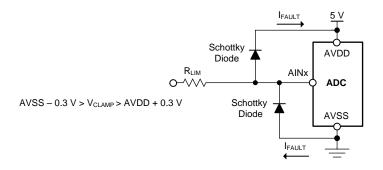


Figure 95. External Diode Clamps

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Application Information (continued)

10.1.3 Burn-out Current Source

When using the burn-out current sources, be aware of the offset error caused by the currents flowing through impedances in the input path, including the multiplexer resistance R_{MUX}), external filter resistors and the internal impedance of the sensor R_{EXT}), as shown in Figure 96. In many cases, the offset error can be calibrated. Be aware that the combination of chop mode and high data rates increases the input current to the PGA. The increased input current can affect the accuracy of the burn-out current sources.

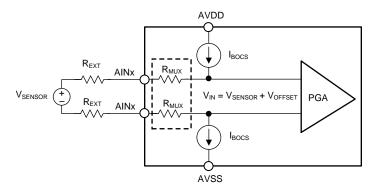


Figure 96. Burn-Out Current Source Offset Voltage Error

10.1.4 Unused Inputs and Outputs

Analog Inputs

To minimize input leakage of the measurement channel, tie unused inputs to mid-supply voltage (AVDD + AVSS) / 2 or to AVDD.

Digital I/O

Not all the digital I/Os may be needed to operate the ADC. Be sure not to float both used and unused digital inputs, including during power-down mode. The following is a summary of the optional digital I/Os connection:

- $\overline{\text{CS}}$: Tie $\overline{\text{CS}}$ low to permanently enable the serial interface.
- CLKIN: Tie CLKIN to DGND to permanently operate the ADC with the internal oscillator.
- START: Tie START to DGND to control conversions by command. Tie START to DVDD to permanently free-run conversions (Continuous-conversion mode only)
- RESET: Tie RESET to DVDD if not using hardware reset. The ADC is reset at power-on. The ADC is also reset by the RESET command.
- PWDN: Tie PWDN to DVDD if not using the hardware power-down mode. The ADC can be powered down by software.
- DRDY: The functionality of the DRDY output is also provided by the dual-mode DOUT/DRDY pin. The DOUT/DRDY output is active when CS is low. Data ready is also determined by software polling. Because the conversion data are buffered, data can be read at any time without the need to synchronize to data ready.

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Application Information (continued)

10.1.5 AC-Excitation

Figure 97 shows a example of an ac-excited bridge measurement system. The example shown omits optional filter components for clarity. The transistors switch the bridge excitation voltage by drive signals provided by the GPIO drivers through the analog input pins. The timing of the drive signals are synchronized to the ADC conversions. The drive signals do not overlap in order to avoid bridge commutation during the switching phase of the drive signal. The transistors gate resistors bias the transistors off at power-on. At host start-up, the host configures the ADC to the ac-excitation mode. See Figure 7 for timing of the drive signals.

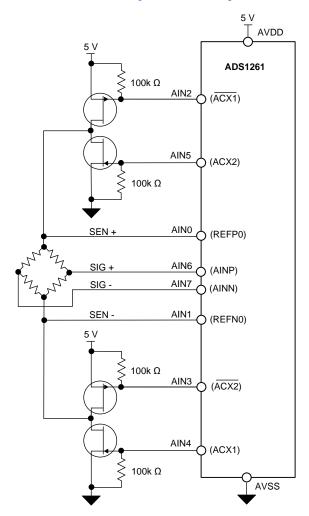


Figure 97. 4-Wire Drive, AC-Excitation Example

The recommended sequence ac-excitation configuration is as follows:

- Stop conversions by taking the START pin low, or by control of conversions in software mode; send the STOP command
- 2. Program the input and reference MUX, gain, data rata, filter mode and other configurations as needed
- 3. Program the 2-wire or 4-wire ac-excitation mode
- 4. Program the 2 GPIOs or 4 GPIOs internal connection to the analog input pins
- 5. Program the 2 GPIOs or 4 GPIOs as outputs to enable drive signals at the analog input pins.

Start the conversions. Adjust the time delay parameter as necessary based on the time constant of the input and reference filters.

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Application Information (continued)

10.1.6 Serial Interface and Digital Connections

Figure 98 shows an example of the digital connections from a host μ C to the ADC. Not all I/O connections are necessary for basic ADC operation; see Unused Inputs and Outputs. Impedance-matching resistors in series with the I/O PCB traces help reduce overshoot and ringing, and is particularly helpful over long trace runs.

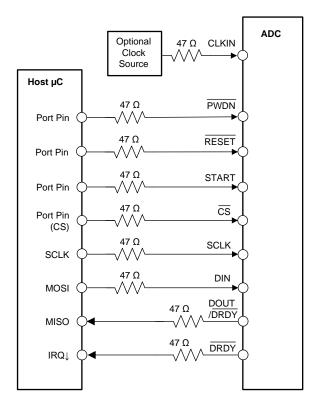


Figure 98. Serial Interface and Digital I/O Connections



10.2 Typical Application

Figure 99 shows a fault-protected, 3-wire RTD application with hardware-based, lead-wire compensation. Two current sources are used together to compensate the RTD lead wire resistance. One current source (IDAC1) provides excitation to the RTD element through R_{LEAD1} . The reference voltage of the ADC is derived directly from this current by resistor R_{REF} . The second current source cancels lead-wire resistance by generating a voltage drop on lead-wire resistance R_{LEAD2} equal to the voltage drop of R_{LEAD1} . Because the R_{RTD} signal voltage is measured differentially via inputs AIN2 and AIN3, the voltages across the lead wire resistance cancel. Resistor R_{BIAS} level-shifts the RTD signal voltage to within the ADC input range. The current sources route to the RTD element through low V_{F} diodes to provide input fault protection.

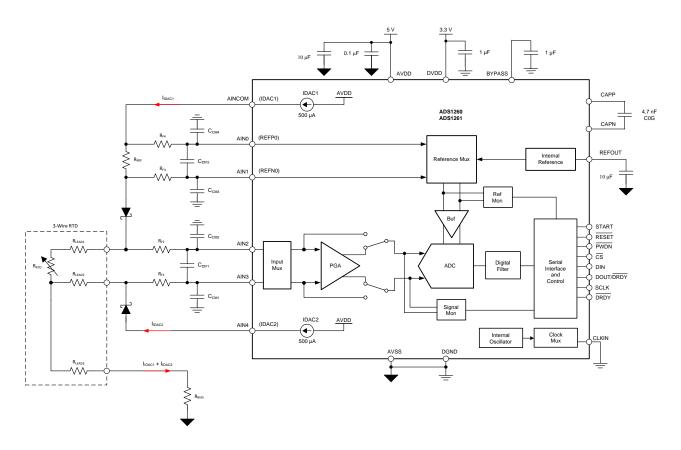


Figure 99. RTD Element With 3-Wire Lead Resistance Compensation

10.2.1 Design Requirements

The key considerations in the design of a 3-wire RTD circuit are the accuracy, stability and noise of the measurement, accuracy of the lead-wire compensation and self-heating of the sensor. Stability of the measurement is determined by the offset and gain drift of the ADC and by the drift of the external reference resistor. Measurement noise is determined by the ADC sample rate and by the digital filter settings. These parameters are not summarized here. Table 45 summarizes the basic design goals for a 3-wire Pt100 RTD.

Table 45. Design Goals

DESIGN PARAMETER	VALUE
RTD sensor type	3-wire Pt100
RTD resistance range	20 Ω to 400 Ω
RTD lead resistance range	0 Ω to 10 Ω
RTD self heating	< 1 mW

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Table 46 summarize the parameters of the detailed design procedure that follows.

Table 46. Design Parameters

	DESIGN PARAMETER	DESIGN VALUE
I _{IDAC}	IDAC current	500 μA
P _{RTD}	RTD power dissipation	0.1 mW
V _{RTD}	RTD input voltage	0.20 V
Gain	ADC gain	8
V _{REF}	Reference voltage (design target allows for 10% overrange)	1.76 V
R _{REF}	Reference resistor (senses the IDAC current to generate V _{REF})	3.52 kΩ
R _{BIAS}	Bias resistor (provides the RTD level-shift voltage)	1.10 kΩ
V _{RTDN}	RTD negative input voltage	1.1 V
V _{RTDP}	RTD positive input voltage	1.31 V
V _{IDAC1}	IDAC1 loop voltage	3.37 V

10.2.2 Detailed Design Procedure

IDAC1 current flows through reference resistor, R_{REF} , which generates the ADC reference voltage, $V_{REF} = I_{IDAC1} \cdot R_{REF}$. IDAC1 current also flows through the RTD element. Since the same current flows through R_{REF} and the RTD element, the RTD measurement is ratiometric, which means the drift and error of the current source are cancelled. Therefore, the measurement accuracy is solely dependent on the tolerance of R_{REF} and on ADC gain and offset errors. The errors are calibrated by host software control using shorted-input calibration and using a 400 Ω precision resistor for full-scale calibration.

The current of IDAC2 is programmed to the same value as IDAC1 and is connected to R_{LEAD2} . IDAC2 generates an equal voltage drop across R_{LEAD1} and IDAC1. The accuracy of lead-wire compensation depends on the matching error between IDAC1 to IDAC2.

Using R_{RTD} = 400 Ω , IDAC current = 500 μ A, and gain = 8, the minimum ADC reference voltage requirement calculates to 1.6 V. To provide 10% design margin, R_{REF} calculates to 3.52 k Ω (1.76 V / 500 μ A). 500 μ A is selected to minimize heating of the sensor.

Resistor R_{BIAS} level-shifts the RTD voltage to meet the input range requirement of the ADC. This voltage is V_{RTDN} and the low limit is calculated by Equation 8. The V_{RTDN} low limit is 1 V.

$$AVSS + 0.3 V + V_{RTD} \cdot (Gain - 1) / 2 \le V_{RTDN}$$
(8)

Using 10% design margin, R_{BIAS} calculates to 1.1 k Ω = 1.1 V / (2 · 500 μ A). The next step is to verify the positive RTD voltage (V_{RTDP}) does not exceed the maximum input range, as shown in Equation 9:

$$Maximum V_{RTDP} \le AVDD - 0.3 V - V_{RTD} \cdot (Gain - 1) / 2$$
(9)

Evaluation of the equation results in the V_{RTDP} high limit = 3.75 V. Calculate the actual V_{RTDP} input voltage by Equation 10:

Actual
$$V_{RTDP} = V_{RTDN} + I_{IDAC1} \cdot (R_{RTD} + 2 \cdot R_{LEAD}) = 1.1 \text{ V} + 500 \,\mu\text{A} \cdot (400 \,\Omega + 20 \,\Omega) = 1.31 \text{ V}$$
 (10)

 $V_{RTDN} = 1.1 \text{ V}$ and $V_{RTDP} = 1.31 \text{ V}$ satisfy the negative and positive input voltage requirements of the ADC, respectively.

Verify the burden voltage of current source IDAC1 is below the specified compliance range. The burden voltage is the sum of voltages in the IDAC1 loop as calculated by V_{RTDP} + (IDAC1 · R_{REF}) + V_D (V_D = external diode voltage). The result is 3.37 V, which meets the specified compliance voltage of the current source.

External filter components R_{F1} , R_{F2} , C_{DIF1} , C_{CM1} , C_{CM2}) and R_{F3} , R_{F4} , C_{DIF2} , C_{CM3} , and C_{CM4}) filter the signal and reference inputs of the ADC. The filters remove both differential and common-mode noise. The input signal differential filter cutoff frequency as calculated by Equation 11:

$$f_{DIF} = 1 / [2\pi \cdot R_{F1} + R_{F2}) \cdot R_{DIF1} + C_{M1} || C_{M2})]$$
(11)

The Input signal common-mode filter is calculated by Equation 12:

$$f_{CM} = 1 / (2\pi \cdot R_{F1} \cdot C_{M1}) = 1 / (2\pi \cdot R_{F2} \cdot C_{M2})$$
 (12)

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Component mismatch in the common-mode filter converts common-mode noise into differential noise. Use a differential capacitor C_{DIF1} 10x higher value than the common-mode capacitors, C_{CM1} and C_{CM2} to minimize the effects of mismatch. The recommended range of input resistors is 1 k Ω to 10 k Ω ; increasing the resistance beyond 10 k Ω beyond could compromise noise and drift performance of the ADC. Use high-quality COG ceramics or film-type capacitors. For consistent noise performance across the full RTD temperature range, match the corner frequencies of the input and reference filters. Detailed information is found in the RTD Ratiometric Measurements and Filtering Using the ADS1148 and ADS1248 Family of Devices Application Report

10.2.3 Application Curves

Figure 100 shows the resistance measurement results. The measurements are taken at $T_A = 25^{\circ}\text{C}$. The data are taken using a precision resistor simulator with a 3-wire connection in place of the RTD. A system offset calibration is performed using shorted inputs. A system gain calibration is performed using a 390- Ω precision resistor. The measurement data are in ohms and do not include the error of the RTD sensor. The measured resistance error is < $\pm 0.02~\Omega$ over the $20-\Omega$ to $400-\Omega$ range.

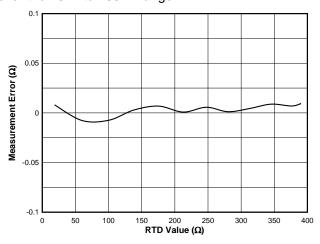


Figure 100. 3-Wire RTD Example Measurement Results

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Product Folder Links: ADS1260 ADS1261



10.3 Initialization Setup

Figure 101 shows a general configuration and measurement procedure.

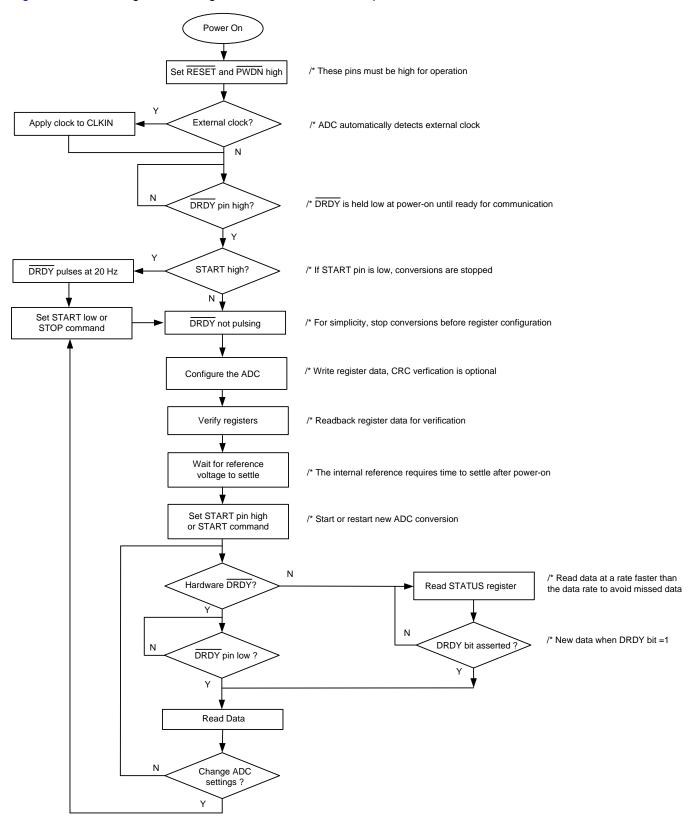


Figure 101. ADC Configuration and Measurement Procedure



11 Power Supply Recommendations

The ADC requires an analog power supply (AVDD, AVSS) and digital power supply (DVDD). The analog power supply can be bipolar (AVDD = \pm 2.5 V and AVSS = \pm 2.5 V) or unipolar (AVDD = 5 V and AVSS = DGND). The digital supply range is 2.7 V to 5.25 V. DVDD powers the ADC core by use of an internal regulator. DVDD also sets the digital I/O voltage. Keep in mind that the GPIO I/O voltages are AVDD and AVSS. Voltage ripple produced by switch-mode power supplies may interfere with the ADC conversions. Use low-dropout regulators (LDOs) to reduce switch-mode power supply ripple.

11.1 Power-Supply Decoupling

Good power-supply decoupling is important in order to achieve optimum performance. Power supplies must be decoupled close to the power supply pins using short, direct connections to ground. For the analog supply, place 0.1- μ F and 10- μ F capacitors between AVDD and AVSS and 0.1- μ F capacitors from each supply to ground. Connect a 1- μ F capacitor from DVDD to the ground plane. Connect a 1- μ F capacitor from BYPASS to the ground plane.

11.2 Analog Power-Supply Clamp

It is important to evaluate circumstances when an input signal is present with the ADC, both powered and unpowered. When the input signal exceeds the power-supply voltage, it is possible to *backdrive* the analog power-supply voltage with the input signal through a conduction path of the internal ESD diodes. Backdriving the ADC power supply can also occur when the power-supply is on. The backdriven current path is illustrated in Figure 102. Depending on how the power supply responds during a backdriven condition, it is possible to exceed the maximum rated ADC supply voltage. The ADC voltage must not be exceeded at all times. One solution is to clamp the analog supply to safe voltage using an external zener diode.

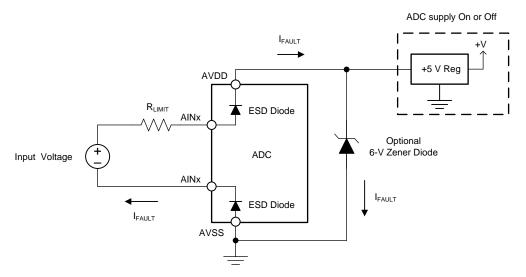


Figure 102. Analog Power-Supply Clamp

11.3 Power-Supply Sequencing

The power supplies can be sequenced in any order, but do not allow the analog or digital inputs to exceed the respective analog or digital power-supplies without external limits of the possible input fault currents.

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12 Layout

Good layout practices are crucial to realize the full-performance of the ADC. Poor grounding can quickly degrade the noise performance. The following layout guidelines help provide the best results.

12.1 Layout Guidelines

For best performance, dedicate an entire PCB layer to a ground plane and do not route any other signal traces on this layer. However, depending on restrictions imposed by specific end equipment, a dedicated ground plane may not be practical. If ground plane separation is necessary, make a direct connection of the planes at the ADC. Do not connect individual ground planes at multiple locations because this configuration creates ground loops.

Route digital traces away from the CAPP and CAPN pins, away from the REFOUT pin, and away from all analog inputs and associated components in order to minimize interference.

Avoid long traces on DOUT/DRDY, because high capacitance on this pin can lead to increase of ADC noise levels. Use a series resistor or a buffer if long traces are used.

The internal reference output return shares the same pin as the AVSS power supply. To minimize coupling between the power supply and reference-return trace, route the traces separately; ideally, as a star connection to the AVSS pin.

Use COG capacitors on the analog inputs and for the CAPP to CAPN capacitor. Use ceramic capacitors (for example, X7R grade) for the power supply decoupling capacitors. High-K capacitors (Y5V) are not recommended. The REFOUT pin requires a 10-µF capacitor and can be either ceramic or tantalum type. Place the required capacitors as close as possible to the device pins using short, direct traces. For optimum performance, use low-impedance connections on the ground-side connections of the bypass capacitors.

When applying an external clock, be sure the clock is free of overshoot and glitches. A source-termination resistor placed at the clock buffer often helps reduce overshoot. Glitches present on the clock input can lead to noise within the conversion data.

12.2 Layout Example

Figure 103 is an example layout of the ADS1261, requiring a minimum of three PCB layers. The example circuit is shown with single supply operation (AVSS = DGND). In this example, the inner layer is dedicated to the ground plane and the outer layers are used for signal and power traces. If a four-layer PCB is used, dedicate the additional inner layer as the power plane. In this example, the ADC is oriented in such a way to minimize crossover of the analog and digital signal traces.

Product Folder Links: ADS1260 ADS1261



Layout Example (continued)

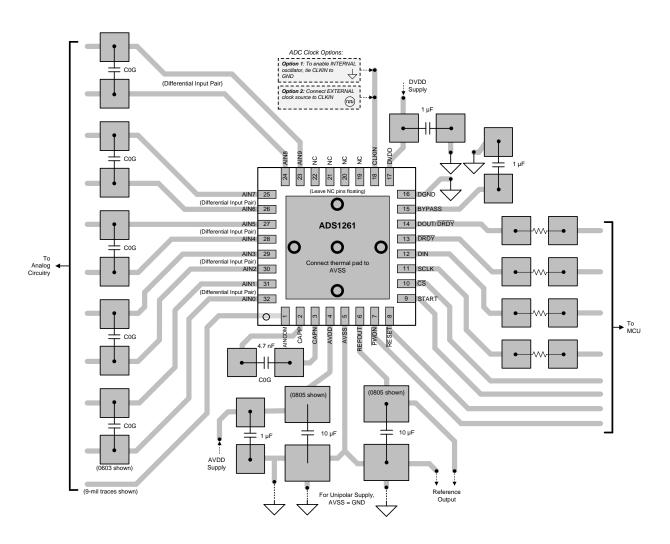


Figure 103. ADS1261 Layout Example



13 Device and Documentation Support

13.1 Documentation Support

13.1.1 Related Documentation

For related documentation see the following:

ADS1261 Evaluation Module User's Guide

13.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

Table 47. Related Links

PARTS	PRODUCT FOLDER	ORDER NOW	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
ADS1260	Click here	Click here	Click here	Click here	Click here
ADS1261	Click here	Click here	Click here	Click here	Click here

13.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

13.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

13.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

13.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

13.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Product Folder Links: ADS1260 ADS1261



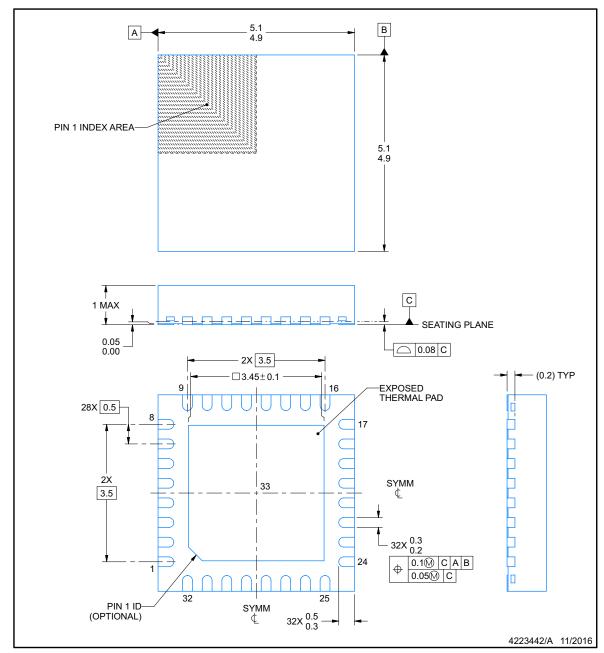
RHB0032E



PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



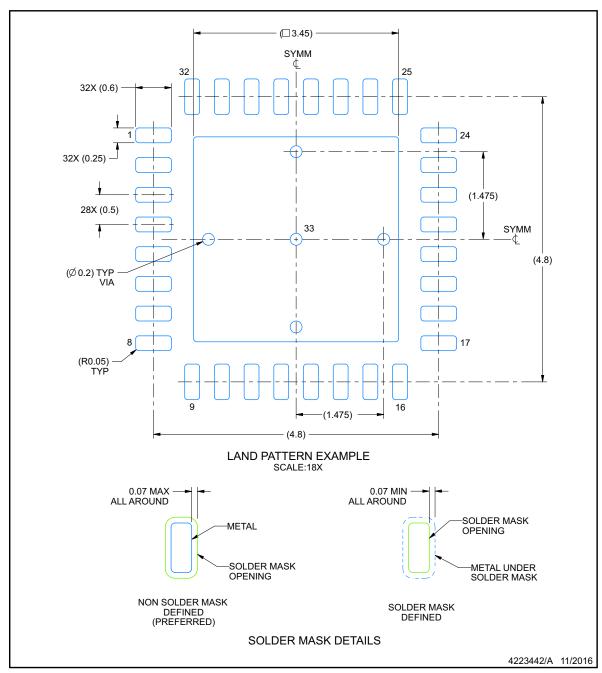


EXAMPLE BOARD LAYOUT

RHB0032E

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



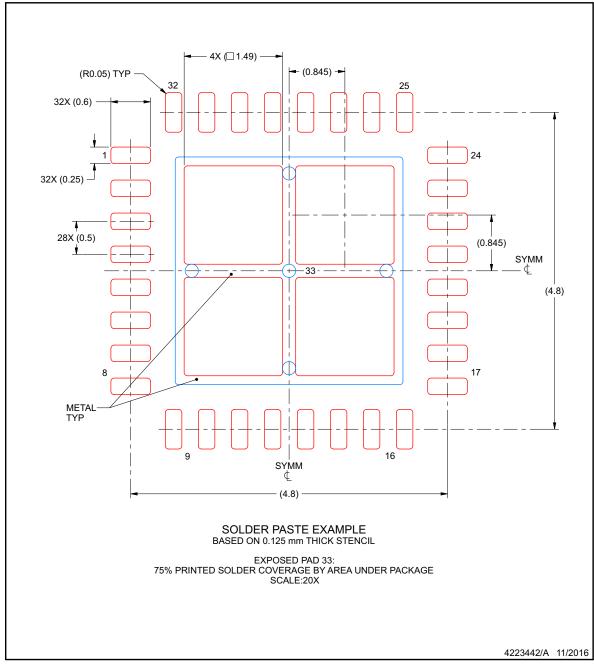


EXAMPLE STENCIL DESIGN

RHB0032E

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.







24-Oct-2018

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
ADS1260BIRHBR	PREVIEW	VQFN	RHB	32	3000	TBD	Call TI	Call TI	-40 to 125	ADS 1260B	
ADS1260BIRHBT	PREVIEW	VQFN	RHB	32	250	TBD	Call TI	Call TI	-40 to 125	ADS 1260B	
ADS1261BIRHBR	PREVIEW	VQFN	RHB	32	3000	TBD	Call TI	Call TI	-40 to 125	ADS 1261B	
ADS1261BIRHBT	PREVIEW	VQFN	RHB	32	250	TBD	Call TI	Call TI	-40 to 125	ADS 1261B	
ADS1261IRHBR	ACTIVE	VQFN	RHB	32	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 125	ADS 1261	Samples
ADS1261IRHBT	ACTIVE	VQFN	RHB	32	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	-40 to 125	ADS 1261	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



PACKAGE OPTION ADDENDUM

24-Oct-2018

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ADS1261IRHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2
ADS1261IRHBT	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ADS1261IRHBR	VQFN	RHB	32	3000	367.0	367.0	35.0
ADS1261IRHBT	VQFN	RHB	32	250	210.0	185.0	35.0

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